

RZ/T2, RZ/N2

Getting Started with Flexible Software Package

Introduction

This manual describes how to use the Renesas Flexible Software Package (FSP) for writing applications for the RZ/T2, RZ/N2 microprocessor series.

Target Device

RZ/T series: RZ/T2M, RZ/T2L, RZ/T2ME

RZ/N series: RZ/N2L

About the video contents

We provide videos about the development tools using the RZ/T and RZ/N FSP. Access the following links:

- How to install the development tools
[RZ/T RZ/N FSP Quick Start Guide - FSP Installation and Generating Your First Project for e2 studio](#)
([English](#), [Japanese](#), [Chinese](#))
[RZ/T RZ/N FSP Quick Start Guide - FSP Installation & Generating Your First Project for EWARM & FSP SC](#)
([English](#), [Japanese](#), [Chinese](#))
- Instructions and usage of each tab in FSP Configuration
[RZ/T RZ/N FSP Tutorial - Pin Configuration Function](#)
([English](#), [Japanese](#), [Chinese](#))
[RZ/T RZ/N FSP Tutorial for FSP Configuration \(1/2\) - Introduction of Tabs](#)
([English](#), [Japanese](#), [Chinese](#))
(Tutorial for FSP Configuration (2/2) will be released in the second half of 2024.)

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1. Introduction

1.1 Overview

This application note describes how to use the Renesas Flexible Software Package (FSP) running on the Cortex®-R52 (hereinafter referred to as CR52) incorporated on RZ/T2 and RZ/N2.

1.2 Introduction to FSP

1.2.1 Purpose

The Renesas Flexible Software Package (FSP) is an optimized software package designed to provide easy to use, scalable, high quality software for embedded system design. The primary goal is to provide lightweight, efficient the hardware abstraction layer (HAL) drivers and the board support package (BSP) that meet common use cases in embedded systems.

1.2.2 e² studio IDE

FSP provides a host of efficiency enhancing tools for developing projects targeting the Renesas RZ/T2, RZ/N2 series of MPU devices. The e² studio IDE provides a familiar development cockpit from which the key steps of project creation, module selection and configuration, code development, code generation, and debugging are all managed.

1.2.3 FSP Smart Configurator

The Renesas FSP Smart Configurator (FSP SC) is a desktop application designed to configure device hardware such as clock set up and pin assignment as well as initialization of FSP software components when using a 3rd-party IDE and toolchain.

For creating RZ/T2, RZ/N2 project, the FSP SC can currently be used with

- IAR Systems Embedded Workbench for Arm (IAR EWARM) with IAR toolchain for Arm

1.2.4 FSP Documentation

The related file “FSP Documentation” contains HTML documentations describing the features, APIs and usage notes regarding the BSP and HAL drivers implemented as FSP modules and interfaces. After clicking the “index.html” in “FSP Documentation” to open the introduction page on your html browser, the reference documents for utilizing each FSP module and interface can be read from “API Reference” menu.

1.3 Related Documentation Files

The related documentation files are shown in the following.

1.3.1 Renesas Starter Kit+ User's Manual

This Getting Started Guide refers to the following “Evaluation Board Kit User’s Manual”.

- RZ/T series
 - RZ/T2M Group Renesas Starter Kit+ for RZ/T2M User’s Manual (RZ/T2M and RZ/T2ME)
 - Document No. **R20UT4939**
 - RZ/T2L Group Renesas Starter Kit+ for RZ/T2L User’s Manual
 - Document No. **R20UT5164**
- RZ/N series
 - RZ/N2L Group Renesas Starter Kit+ for RZ/N2L User’s Manual
 - Document No. **R20UT4984**

These documents can be found on Renesas web site by inputting their **Document No.** into search box.

- URL: <https://www.renesas.com/>

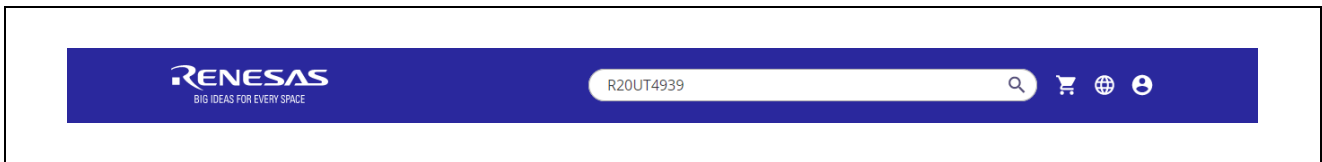


Figure 1: Search Box in Renesas Web Page

1.3.2 FSP Documentation

This Getting Started Guide refers to the following “FSP Documentation”. It contains notes on the use of the software modules packaged with FSP.

These documents are available in Renesas Git repository in GitHub.

- RZ/T series
 - RZ/T2 Flexible Software Package Documentation
 - URL: <https://github.com/renesas/rzt-fsp/releases>
 - File name: fsp_documentation_vx.x.x.zip
- RZ/N series
 - RZ/N2 Flexible Software Package Documentation
 - URL: <https://github.com/renesas/rzn-fsp/releases>
 - File name: fsp_documentation_vx.x.x.zip

Note:

The “vx.x.x” is the FSP version number such as “v1.0.0”.

Note for RZ/N2L:

The RZ/N2L FSP documentation can also be viewed in a web browser by accessing the following link, but it is RZ/N2L FSP v1.0.0 content.

- URL: <https://renesas.github.io/rzn-fsp/>

The latest version of the document should be obtained as a zip file as described above.

1.4 Starting Development Introduction

FSP application project can be created by e² studio or FSP SC (for IAR EWARM), and this Getting Started includes tutorial for both tools; the chapters you should read changes.

e² studio users should read the following chapters:

- Chapter 2 "Set up Renesas Starter kit+ for RZ/T2, RZ/N2 CPU Board"
- Chapter 3 "e² studio Setup"
- Chapter 4 "Tutorial: Your First RZ/T2, RZ/N2 MPU Project – Blinky"
- Chapter 6 "FSP Configuration Users Guide"

FSP SC users (for IAR EWARM users) should read the following chapters:

- Chapter 2 "Set up Renesas Starter kit+ for RZ/T2, RZ/N2 CPU Board"
- Chapter 5 "FSP Smart Configurator User Guide"
- Chapter 6 "FSP Configuration Users Guide"

The summary of each chapter is shown below.

- Chapter 2 "Set up Renesas Starter kit+ for RZ/T2, RZ/N2 CPU Board"
 - Explains how to setup Renesas Starter kit+ for RZ/T2, RZ/N2 CPU Board to proceed the tutorials in Chapter 4 and 5.
- Chapter 3 "e² studio Setup"
 - Explains the setup of e² studio for utilizing FSP.
- Chapter 4 "Tutorial: Your First RZ/T2, RZ/N2 MPU Project – Blinky"
 - Explains the tutorial with minimal steps to create, run, and debug a FSP project by using e² studio.
- Chapter 5 "FSP Smart Configurator User Guide"
 - Explains the tutorial with minimal steps to create an FSP project as IAR EWARM project by using the FSP Smart Configurator and to run and debug the created IAR EWARM project.
- Chapter 6 "FSP Configuration Users Guide"
 - Explains how to create and configure an FSP project in detail.
 - The explanation is described based on e² studio, but most of the explanations are applied to the FSP smart configurator.

2. Set up Renesas Starter kit+ for RZ/T2, RZ/N2 CPU Board

2.1 Obtaining an Renesas Starter Kit+

To develop applications with RZ/T2 FSP and RZ/N2 FSP, start with Renesas Starter Kit+ (RSK).

The Renesas Starter Kit+ for RZ/T2 and RZ/N2 CPU Board (RSK+RZT2M, RSK+RZ/T2L, RSK+RZT2ME, and RSK+RZN2L) are designed to seamlessly integrate with the e² studio.

Ordering information, User Manuals, and other related documents for RSK boards are available. Please contact Renesas to get them.

2.2 System Configuration

Below is an example of a typical system configuration of RSK board.

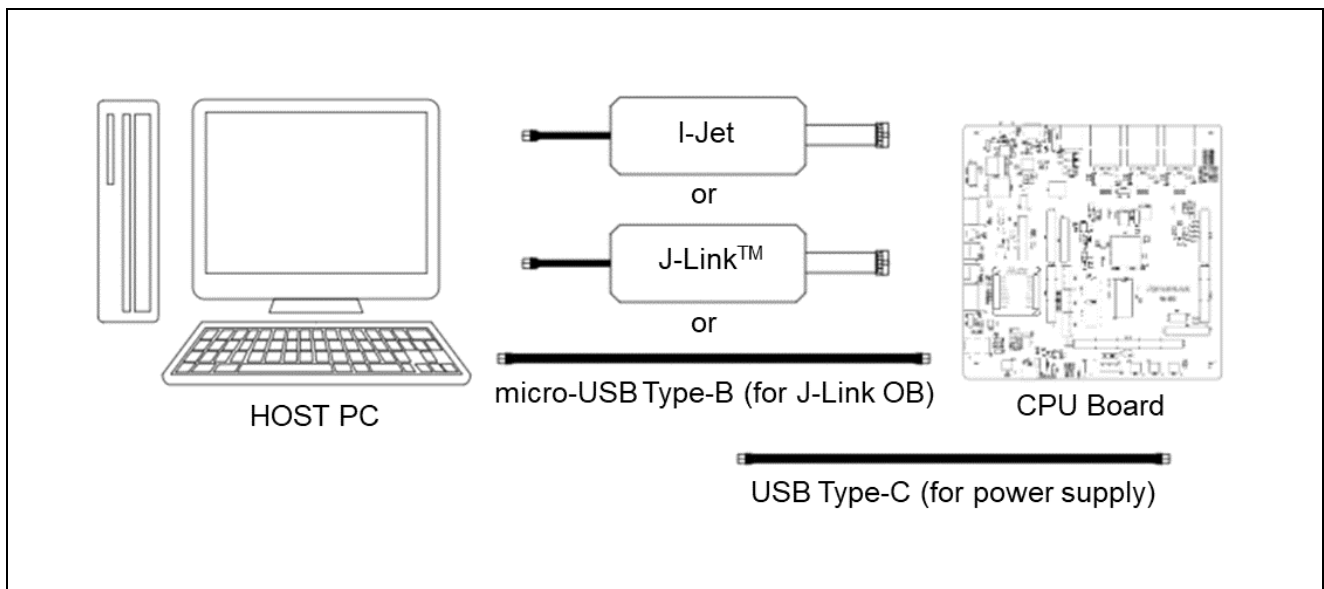


Figure 2: System Configuration Example – with RSK Board

For the details, please refer to the related document “Renesas Starter Kit+ User’s Manual”.

2.3 Supported Emulator

2.3.1 SEGGER J-Link

SEGGER J-Link can be used on Renesas e² studio only for debugging on RZ/T2 and RZ/N2 devices.

Renesas e² studio supports the following emulators.

- J-Link EDU V11 and later
- J-Link BASE V11 and later
- J-Link PLUS V11 and later
- J-Link WiFi V1 and later
- J-Link ULTRA+ V5 and later
- J-Link PRO V5 and later
- J-Link OB-S124 V1.00

Renesas has tested debugging RZ/T2 and RZ/N2 devices with J-Link BASE V11 and J-Link OB-S124.

For the details on SEGGER J-Link, please see SEGGER website.

Debugging FSP Project was verified with the following software environment.

Table 1 Verified Operating Environment

Series	Device	FSP version	e ² studio version	J-Link Software version
RZ/T	RZ/T2M, RZ/T2L, RZ/T2ME	RZ/T2 FSP v2.1.0	2024-04	V7.96j
RZ/N	RZ/N2L	RZ/N2L FSP v2.0.0	2024-01.1	V7.94h

2.3.2 IAR I-Jet

IAR I-jet can be used on IAR EWARM only for debugging on RZ/T2 and RZ/N2 devices.

For the details on IAR I-jet, please see IAR Systems website.

2.4 RZ/T Series Board Setup

2.4.1 RSK+RZT2M

2.4.1.1 Boot Mode

The operation mode settings for the RSK+RZT2M board are as follows.

Note:

This section shows the settings for running on RAM without external flash memory. For settings to run in other boot modes, please refer to the manual of the RSK boards listed in chapter 1.3.1. For [the sample codes available on Renesas web site](#), please refer to the documentation included with each code and implement the appropriate board settings respectively.

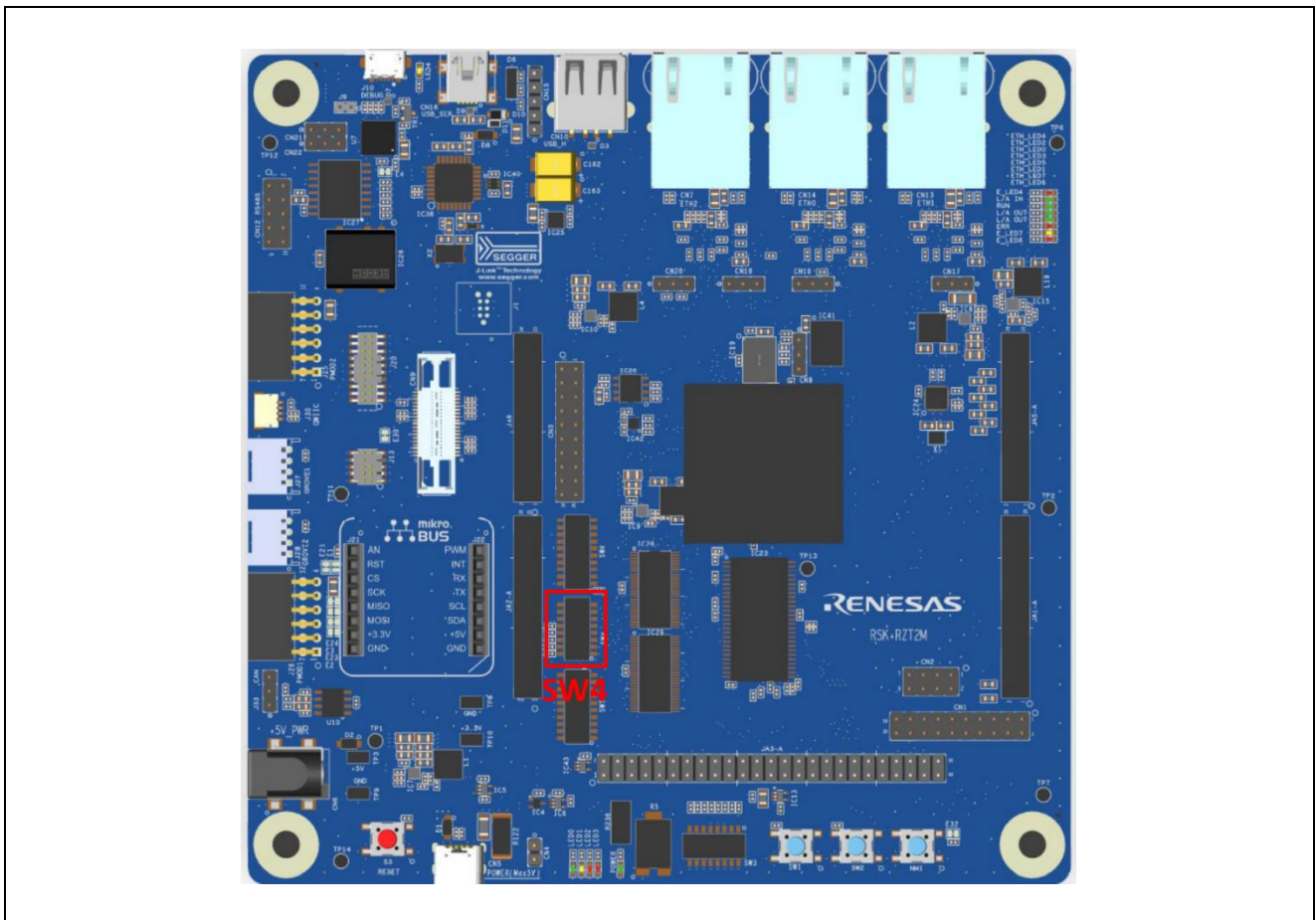


Figure 3: Switch Position of Operation Mode Settings for RSK+RZT2M

Table 2 Operation Mode Switch Settings for RSK+RZT2M

Switch	Setting	Description
SW4.1	ON	16-bit bus boot mode (NOR Flash)
SW4.2	OFF	
SW4.3	ON	
SW4.4	ON	JTAG Authentication by Hash is disabled.
SW4.5	ON	ATCM 0 wait Valid for CPU operating frequency equal to or less than 400MHz.

2.4.1.2 Debugger Connection

If you use JTAG connection with I-Jet or J-Link,

1. Short the jumper pin (J9) for switching the debug connection so that RSK+RZT2M board can use the emulator connected to JTAG connector (J20).
2. Connect the emulator (J-Link or I-jet) to a free USB port on your computer.
3. Connect the IAR I-Jet to the RSK+RZT2M board ensuring that it is plugged in to the header “J20”.

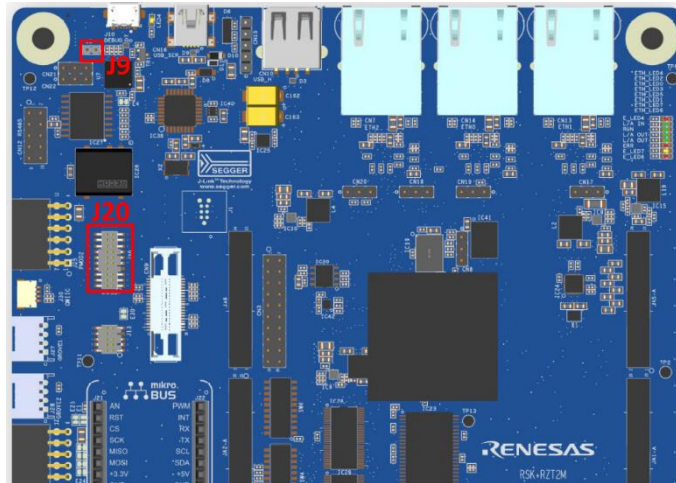


Figure 4: Jumper Position of JTAG connection for RSK+RZT2M

If you use J-Link OB on RSK+RZT2M board,

1. Open the jumper pin (J9) for switching the debug connection so that RSK+RZT2M can use J-Link OB on the board.
2. Connect the micro-USB type-B to J-Link OB USB connector (J10), and then the LED4 is lighted.

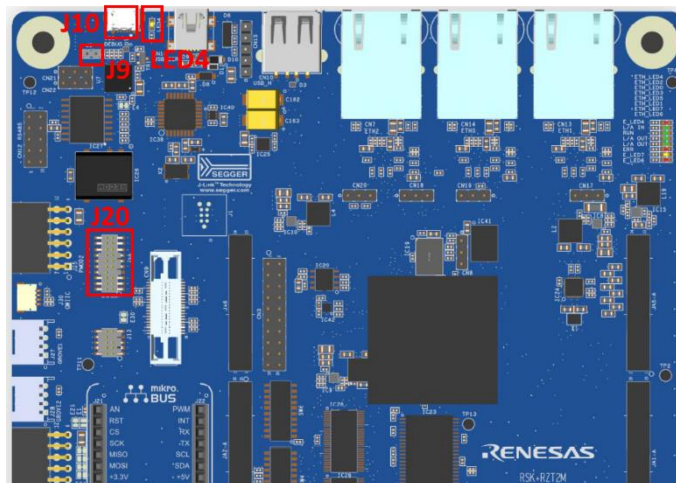


Figure 5: J-Link OB Connection Settings for RSK+RZT2M

2.4.1.3 Power Supply

Power is supplied using a USB cable (Type-C) or an AC / DC adapter.

- When using a USB cable (Type-C), connect it to the USB connector “CN5” of the RSK+RZT2M board.
- When connecting the AC / DC adapter, connect it to the USB connector “CN6” of the RSK+RZT2M board.

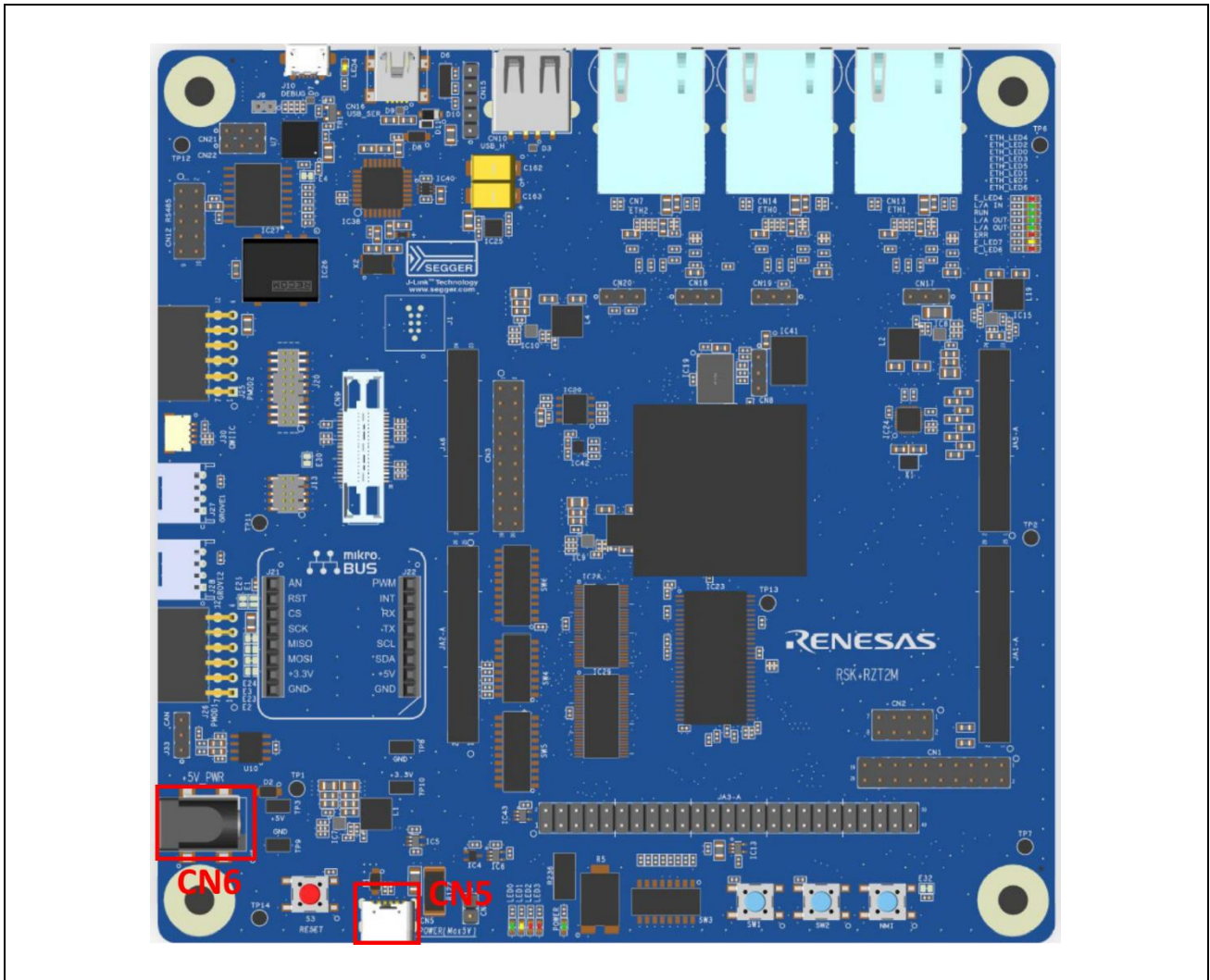


Figure 6: How to Power Supply for RSK+RZT2M

2.4.2 RSK+RZT2L

2.4.2.1 Boot Mode

The operation mode settings for the RSK+RZT2L board are as follows.

Note:

This section shows the settings for running on RAM without external flash memory. For settings to run in other boot modes, please refer to the manual of the RSK boards listed in chapter 1.3.1. For [the sample codes available on Renesas web site](#), please refer to the documentation included with each code and implement the appropriate board settings respectively.

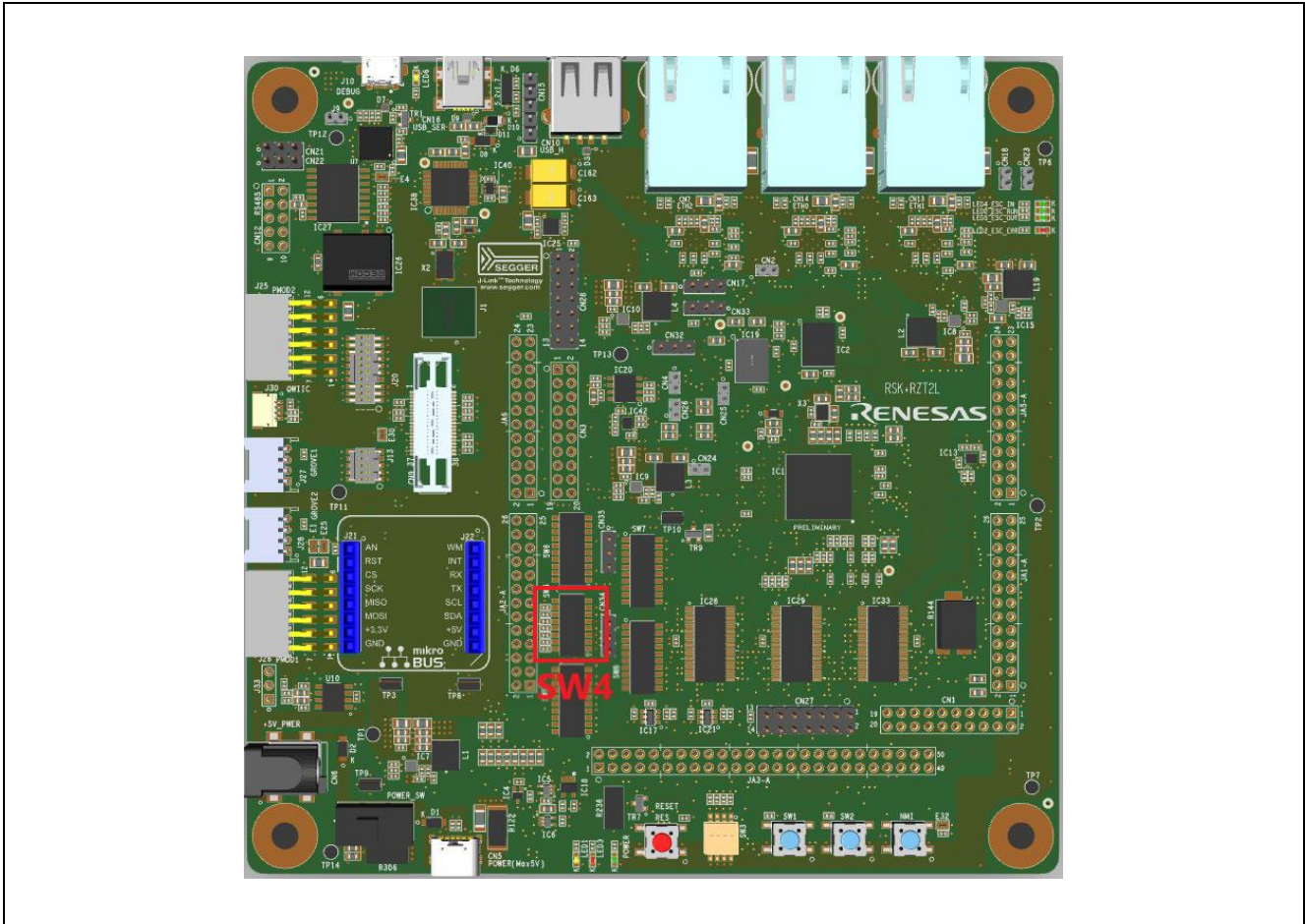


Figure 7: Switch Position of Operation Mode Settings for RSK+RZT2L

Table 3 Operation Mode Switch Settings for RSK+RZT2L

Switch	Setting	Description
SW4.1	ON	xSPI0 boot mode (x1 boot serial flash)
SW4.2	ON	
SW4.3	ON	
SW4.4	ON	ATCM wait cycle = 0 wait
SW4.5	ON	JTAG mode = Normal mode

2.4.2.2 Debugger Connection

If you use JTAG connection with I-Jet or J-Link,

1. Short the jumper pin (J9) for switching the debug connection so that RSK+RZT2L board can use the emulator connected to JTAG connector (J20).
2. Connect the emulator (J-Link or I-jet) to a free USB port on your computer.
3. Connect the IAR I-Jet to the RSK+RZT2L board ensuring that it is plugged in to the header “J20”.

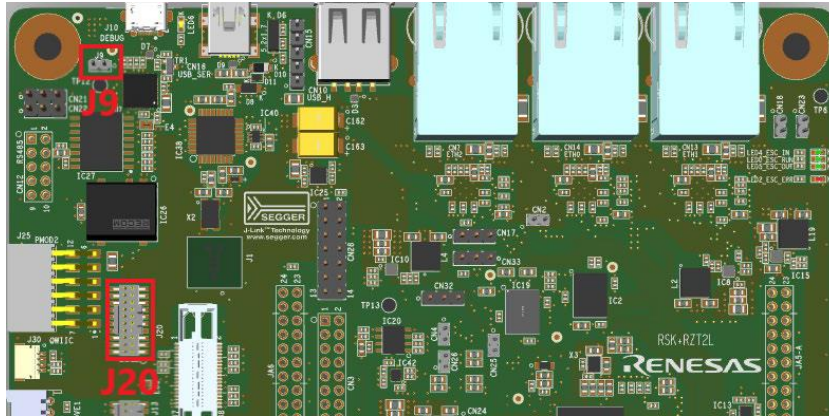


Figure 8: Jumper Position of JTAG connection for RSK+RZT2L

If you use J-Link OB on RSK+RZT2L board,

1. Open the jumper pin (J9) for switching the debug connection so that RSK+RZT2L can use J-Link OB on the board.
2. Connect the micro-USB type-B to J-Link OB USB connector (J10), and then the LED6 is lighted.

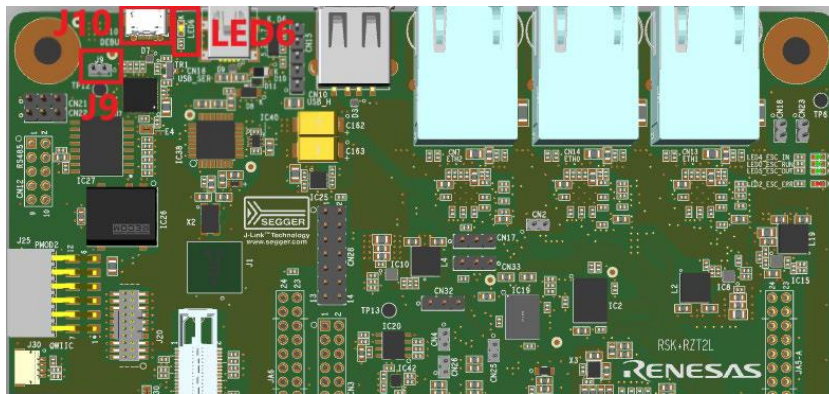


Figure 9: J-Link OB Connection Settings for RSK+RZT2L

2.4.2.3 Power Supply

Power is supplied using a USB cable (Type-C) or an AC / DC adapter.

- When using a USB cable (Type-C), connect it to the USB connector “CN5” of the RSK+RZT2L board.
- When connecting the AC / DC adapter, connect it to the USB connector “CN6” of the RSK+RZT2L board.
- After connecting to the power (CN5 or CN6), turn on the POWER_SW slide switch to start power supply.

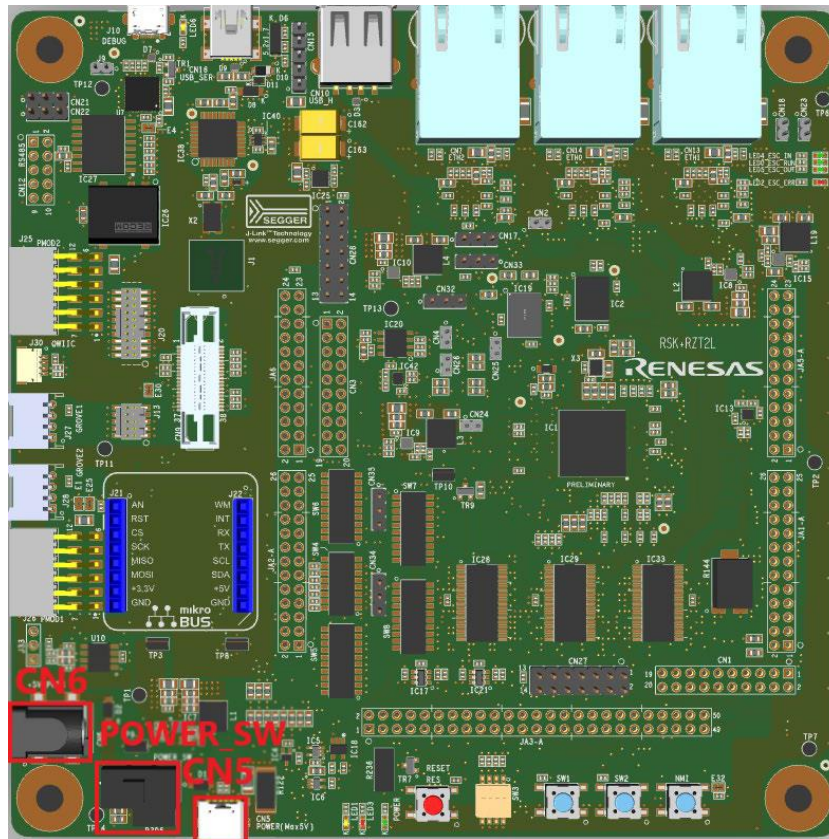


Figure 10: How to Power Supply for RSK+RZT2L

2.4.3 RSK+RZT2ME

For each setting, see 2.4.1 RSK+RZT2M.

2.5 RZ/N Series Board Setup

2.5.1 RSK+RZN2L

2.5.1.1 Boot Mode

The operation mode settings for the RSK+RZN2L board are as follows.

Note:

This section shows the settings for running on RAM without external flash memory. For settings to run in other boot modes, please refer to the manual of the RSK boards listed in chapter 1.3.1. For [the sample codes available on Renesas web site](#), please refer to the documentation included with each code and implement the appropriate board settings respectively.

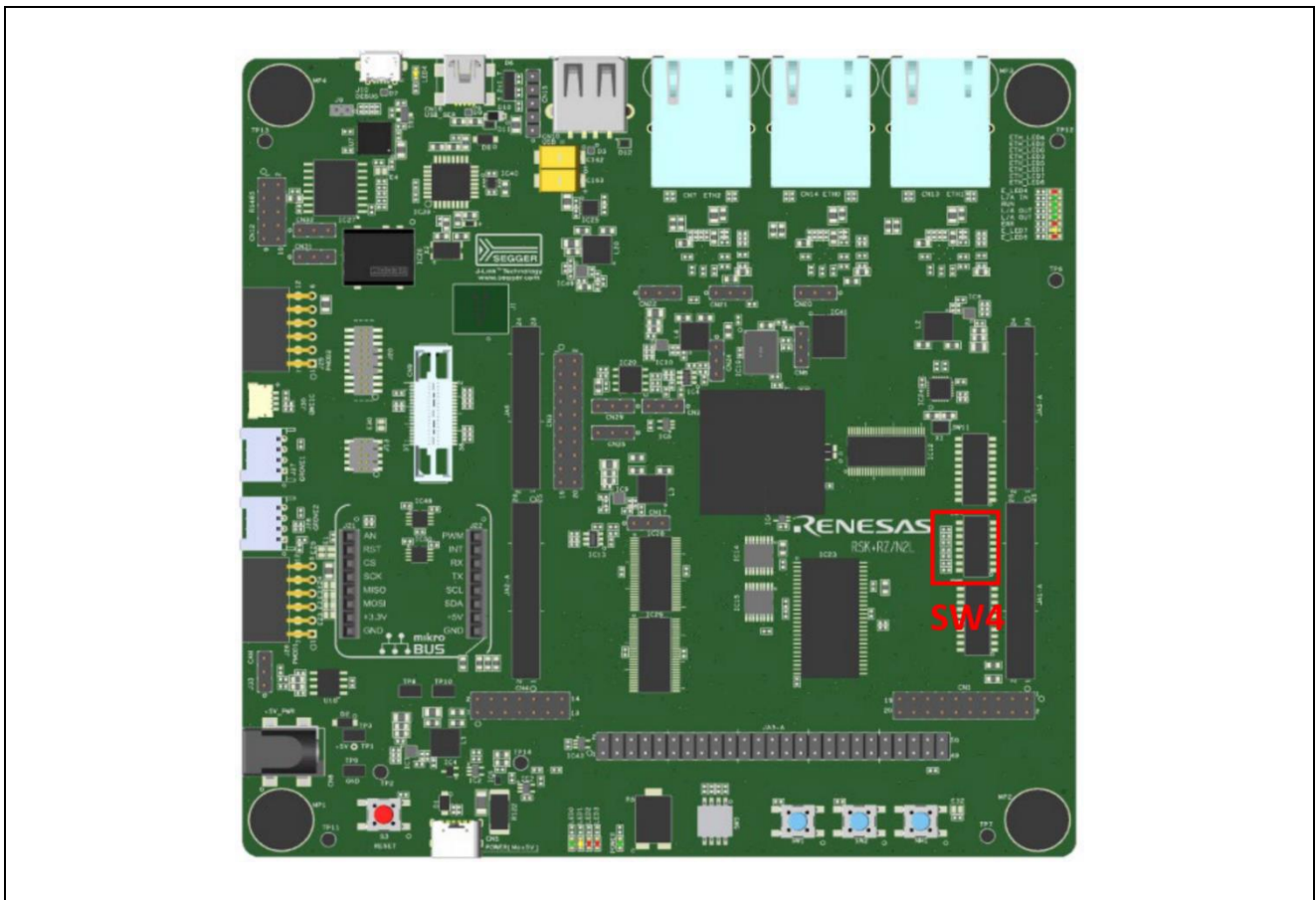


Figure 11: Switch Position of Operation Mode Settings for RSK+RZN2L

Table 4 Operation Mode Switch Settings for RSK+RZN2L

Switch	Setting	Description
SW4.1	ON	16-bit bus boot mode (NOR flash)
SW4.2	OFF	
SW4.3	ON	
SW4.4	ON	JTAG Authentication by Hash is disabled.

2.5.1.2 Debugger Connection

If you use JTAG connection with I-Jet or J-Link,

1. Short the jumper pin (J9) for switching the debug connection so that RSK+RZN2L board can use the emulator connected to JTAG connector (J20).
2. Connect the Emulator (J-Link or I-jet) to a free USB port on your computer.
3. Connect the IAR I-Jet to the RSK+RZN2L board ensuring that it is plugged in to the header “J20”.

The figure below is when a I-jet is used as Emulator.

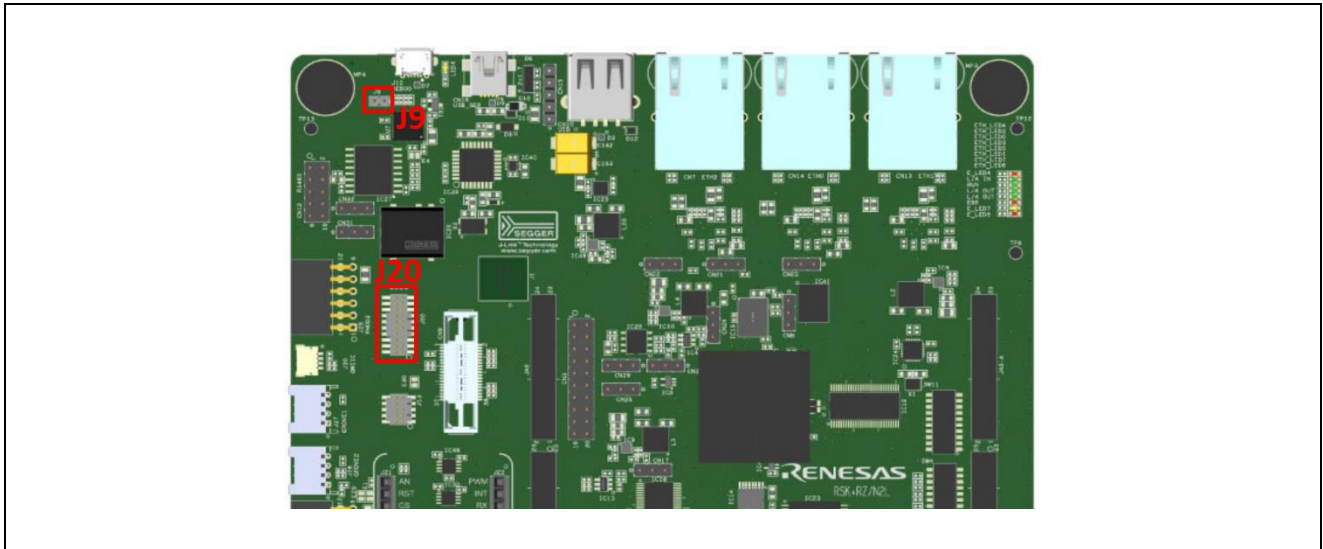


Figure 12: Jumper Position of JTAG Connection for RSK+RZN2L

If you use J-Link OB on RSK+RZN2L board,

1. Open the jumper pin (J9) for switching the debug connection so that RSK+RZN2L can use J-Link OB on the board.
2. Connect the micro-USB type-B to J-Link OB USB connector (J10), and then the LED4 is lighted.

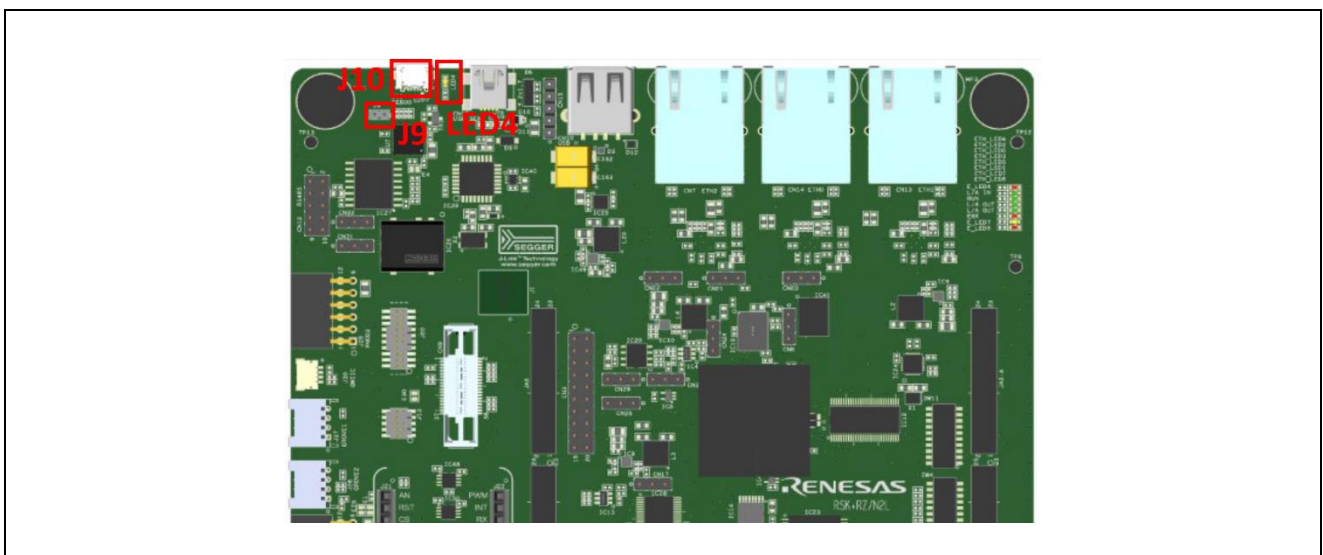


Figure 13: J-Link OB Connection Settings for RSK+RZN2L

2.5.1.3 Power Supply

Power is supplied using a USB cable (Type-C) or an AC / DC adapter.

- When using a USB cable (Type-C), connect it to the USB connector “CN5” of the RSK+RZN2L board.
- When connecting the AC / DC adapter, connect it to the USB connector “CN6” of the RSK+RZN2L board.

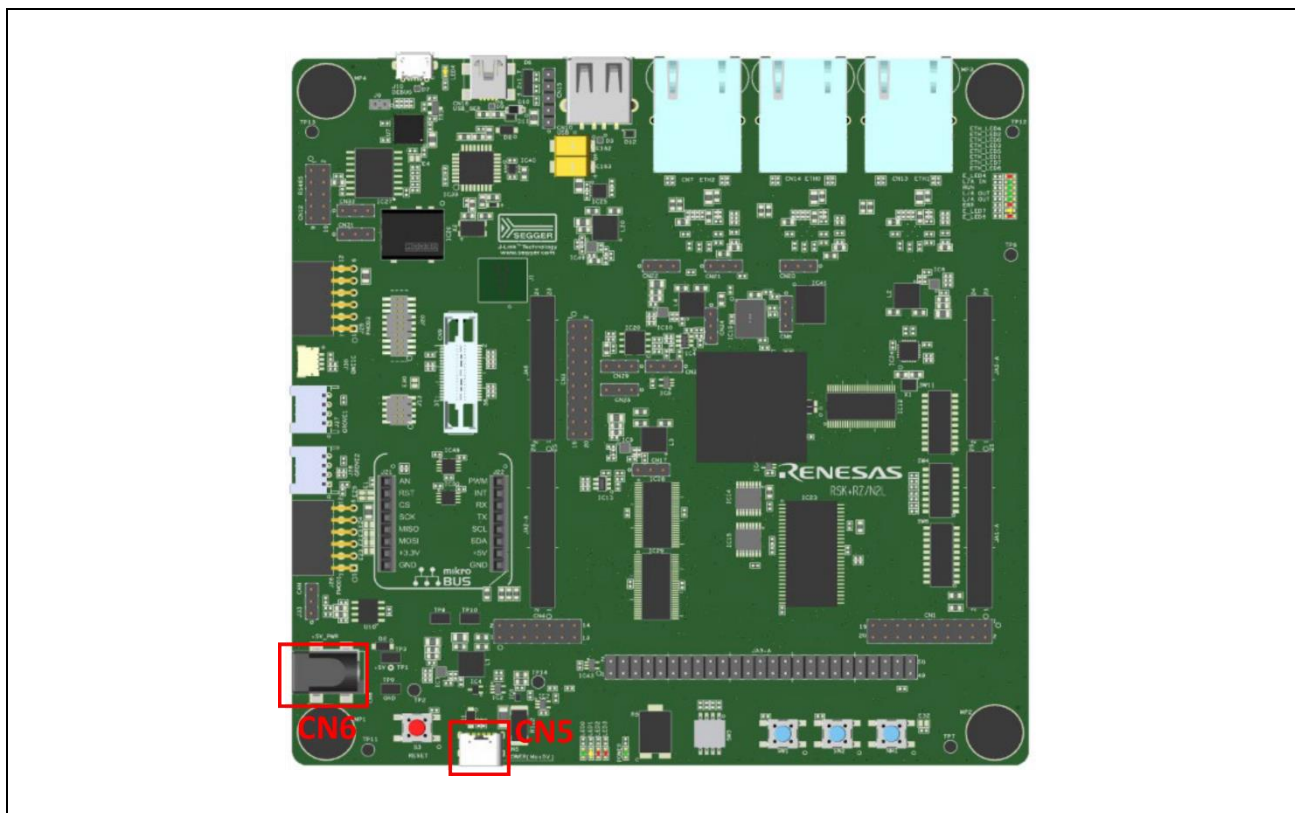


Figure 14: How to Power Supply for RSK+RZN2L

3. e² studio Setup

3.1 What is e² studio?

Renesas e² studio is a development tool encompassing code development, build, and debug. e² studio is based on the open-source Eclipse IDE and the associated C/C++ Development Tooling (CDT).

When developing for RZ/T2, RZ/N2 MPUs, e² studio hosts the Renesas Flexible Software Package (FSP). FSP provides a wide range of time saving tools to simplify the selection, configuration, and management of modules and threads, to easily implement complex applications.

3.2 e² studio Prerequisites

3.2.1 Windows PC Requirements

The following are the Windows PC requirements to use e² studio:

For Windows 64-bit version

- Windows® 11 (64-bit version)
- Windows® 10 (64-bit version)
- Windows® 8.1 (64-bit version)
- Memory capacity: We recommend 8 GB or more. At least 4 GB.
- Capacity of hard disk: At least 2 GB of free space.
- Display: Graphics resolution should be at least 1024 x 768, and the mode should display at least 65,536 colors.
- Interface: USB 2.0
- Microsoft Visual C++ 2010 SP1 runtime library *1
- Microsoft Visual C++ 2015-2019 runtime library *1

*1. This software will be installed at the same time as the e² studio.

3.2.2 Installing e² studio, Platform Installer and FSP Package

Detailed installation instructions for the e² studio and the FSP are available on the Renesas website. Review the release notes for e² studio to ensure that the e² studio version supports the selected FSP version. The starting version of the installer includes all features of the RZ/T2, RZ/N2 MPUs.

3.2.3 Choosing a Toolchain

The GNU ARM Embedded Toolchain (version 12.2.1.arm-12-24) is required.

If the version of the toolchain has not been installed, please download the toolchain from ARM Developer website, and install it.

3.2.4 Licensing

FSP licensing includes full source code, limited to Renesas hardware only.

4. Tutorial: Your First RZ/T2, RZ/N2 MPU Project – Blinky

4.1 Tutorial Blinky

The goal of this tutorial is to quickly get acquainted with the Flexible Platform by moving through the steps of creating a simple application using e² studio and running that application on an RZ/T2, RZ/N2 MPU board. This chapter guides you through creating projects for a single-core processing and a multiprocessing. Here, the multiprocessing refers to a process in which CR52 CPU0 core is activated first and CR52 CPU1 core operates after CR52 CPU0 core sets up for CR52 CPU1 core.

4.2 What Does Blinky Do?

The application used in this tutorial is Blinky, traditionally the first program run in a new embedded development environment.

Blinky is the “Hello World” of microprocessors. If the LED blinks you know that:

- The toolchain is setup correctly and builds a working executable image for your chip.
- The debugger has installed with working drivers and is properly connected to the board.
- The board is powered up and its jumper and switch settings are probably correct.
- The microprocessor is alive, the clocks are running, and the memory is initialized.

4.3 Create a New Project for Blinky

The creation and configuration of an RZ/T and RZ/N C/C++ FSP Project is the first step in the creation of an application. The base RZ/T2 pack and RZ/N2 packs include a pre-written Blinky example application. In the case of multiprocessing, two projects with different settings must be created. The CR52 CPU0 core project that starts first is called the primary project and the CR52 CPU1 core project is called the secondary project.

Note for multiprocessing projects:

The primary project and the secondary project should be created in a same workspace.

The secondary project should be created after the primary project is created in 4.3 section and built the primary project in 4.4 section.

Follow these steps to create an RZ/T2, RZ/N2 MPU project:

1. In e² studio, click **File > New > C/C++ Project**.

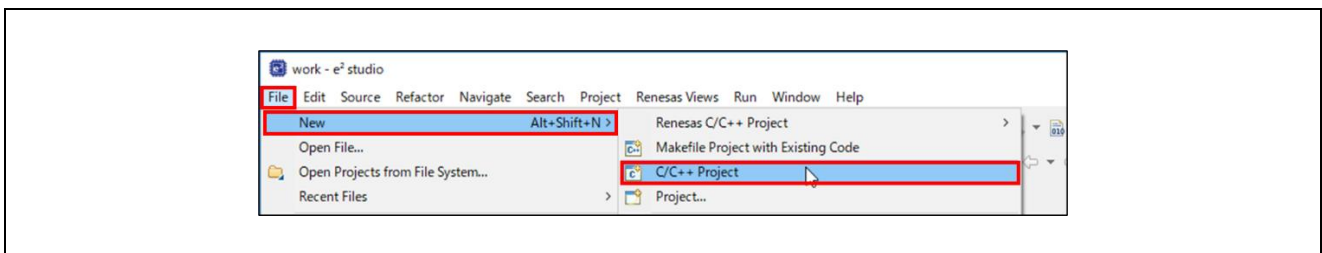


Figure 15: New C/C++ Project

2. Select either one depending on your RZ/T2, RZ/N2 MPU and RSK board.
 - **Renesas RZ > Renesas RZ/T C/C++ FSP Project**
 - **Renesas RZ > Renesas RZ/N C/C++ FSP Project**
3. Click **Next**.

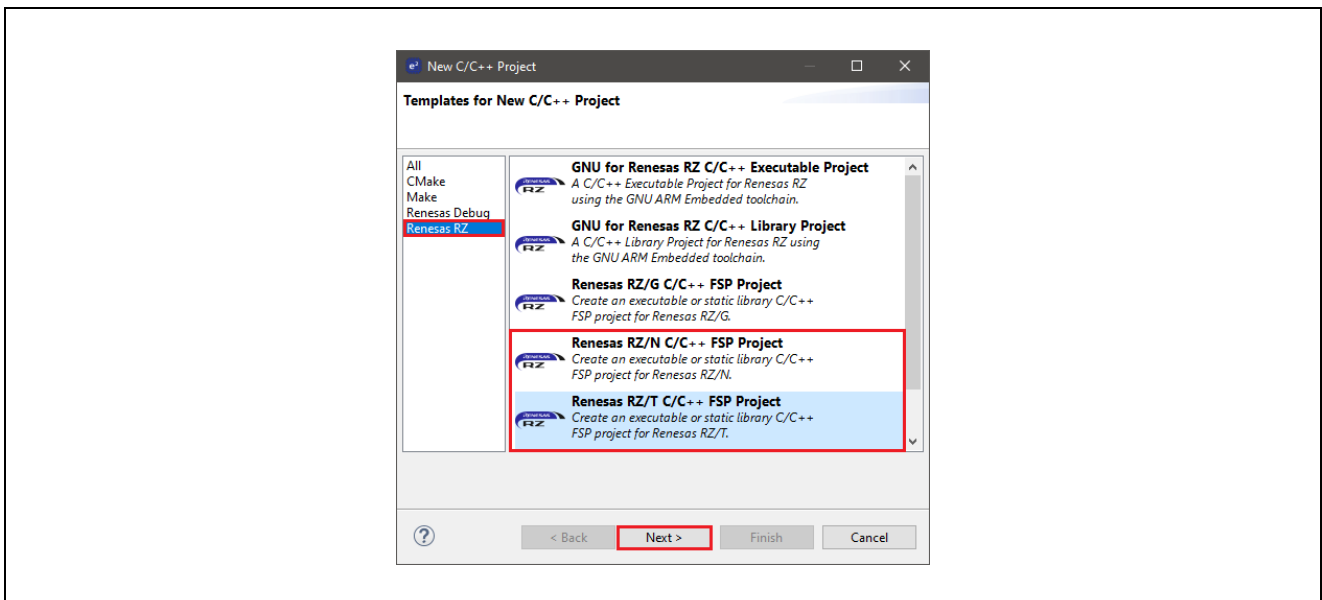


Figure 16: Renesas RZ C/C++ FSP Project

(Continued on next page)

4. Assign a name to this new project. An example of naming is shown below.
 - Single-core processing
 - Blinky
 - Multiprocessing
 - The primary project: Blinky_cpu0_primary
 - The secondary project: Blinky_cpu1_secondary
5. Click **Next**. The Project Configuration window shows your selection.

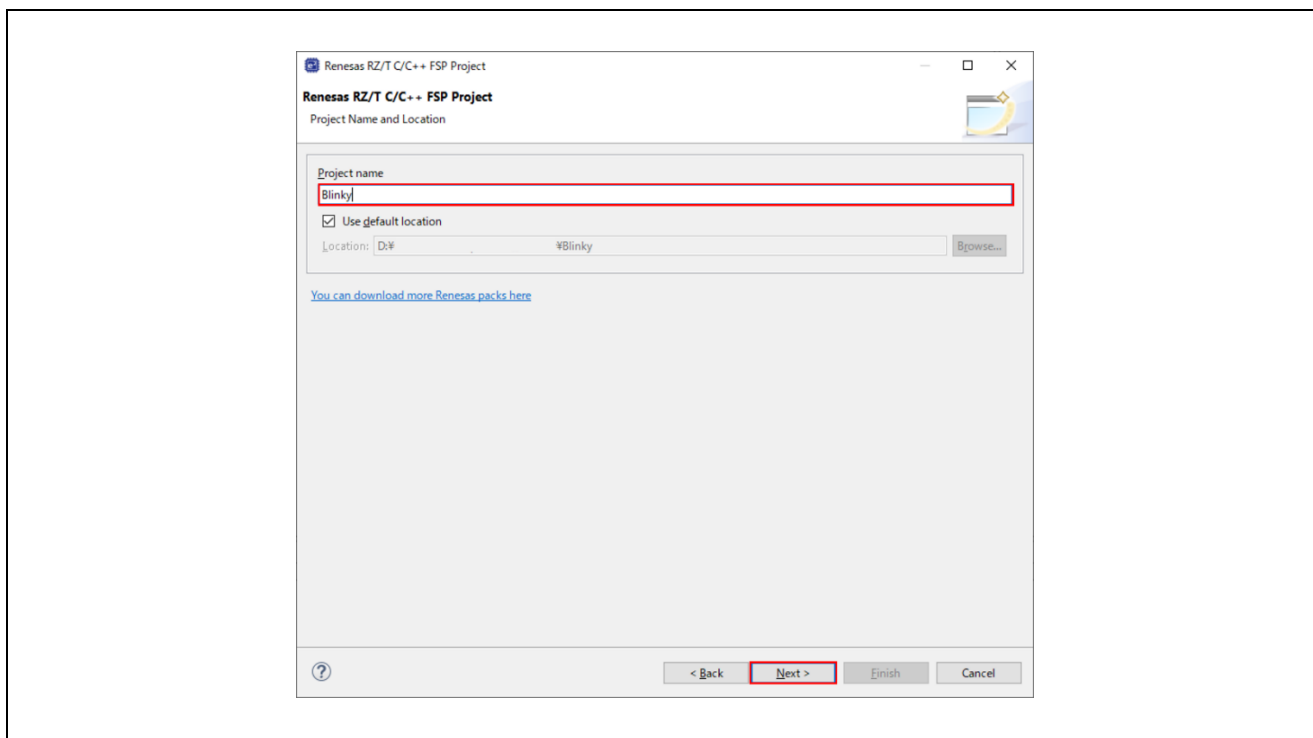


Figure 17 : e² studio Project Configuration Window (Part 1)

(Continued on next page)

6. Select the board support package by selecting the name of your board from the drop-down list. In this tutorial, please select either one depending on your device and RSK board.
 - RZ/T series
 - **RSK+RZT2M (RAM execution without flash memory)**
 - **RSK+RZT2L (RAM execution without flash memory)**
 - **RSK+RZT2ME (RAM execution without flash memory)**
 - RZ/N series
 - **RSK+RZN2L (RAM execution without flash memory)**
7. (RZ/T2M, RZ/T2ME ONLY) Select the Core from the drop-down list.
 - Single-core processing
 - CR52_0
 - Multiprocessing
 - The primary project: CR52_0
 - The secondary project: CR52_1
8. Select **GNU ARM Embedded** in Toolchains and version is **12.2.1.arm-12-24** as its toolchain version, and click **Next**.
 - If there is NOT the 12.2.1.arm-12-24 version of GNU ARM Embedded Toolchain, please download the version of the toolchain from ARM Developer website and install it.

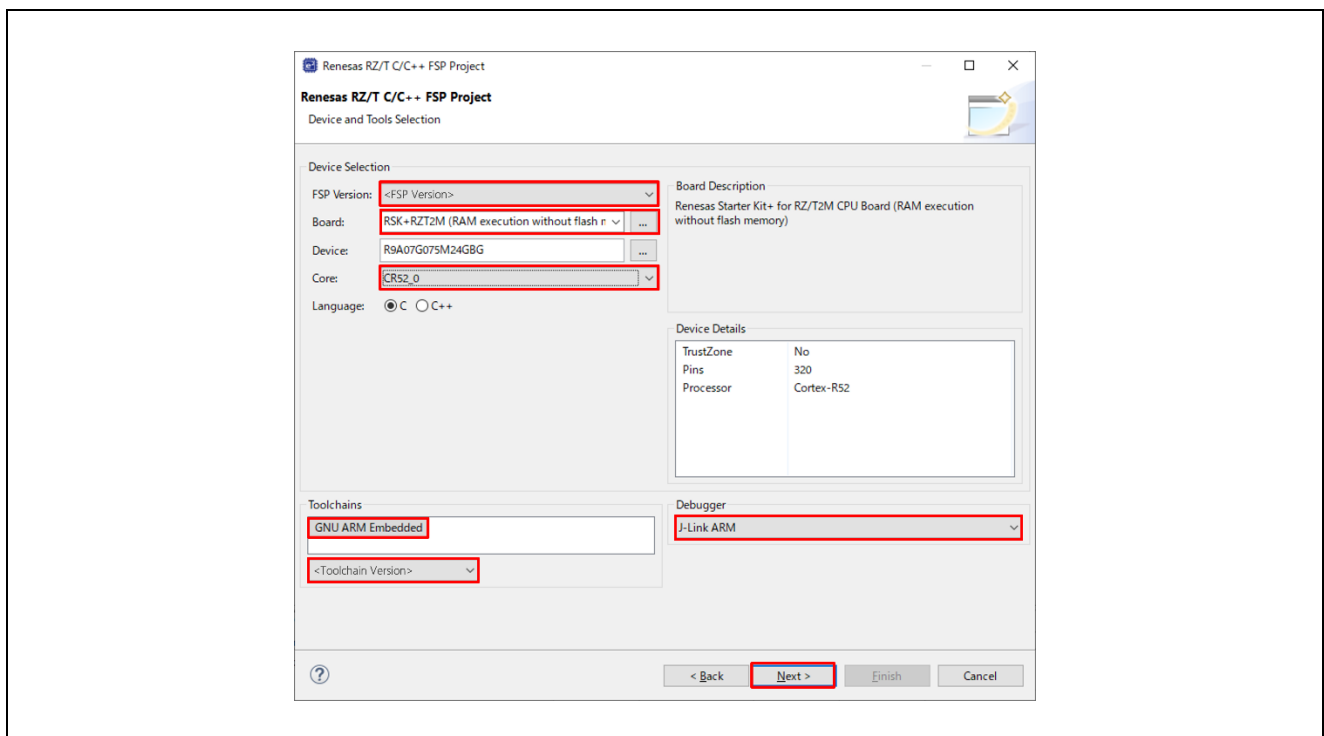


Figure 18 : e² studio Project Configuration Window (Part 2)

9. (The secondary project of multiprocessing ONLY) Select a bundle file of the primary project. Built CPU0 project names in the same workspace appear as an option in the drop-down list.

Note:

Warnings occur if the FSP version or Board (boot mode) used is different between the primary project and the secondary project. Use the same FSP version and Board (boot mode).

(Continued on next page)

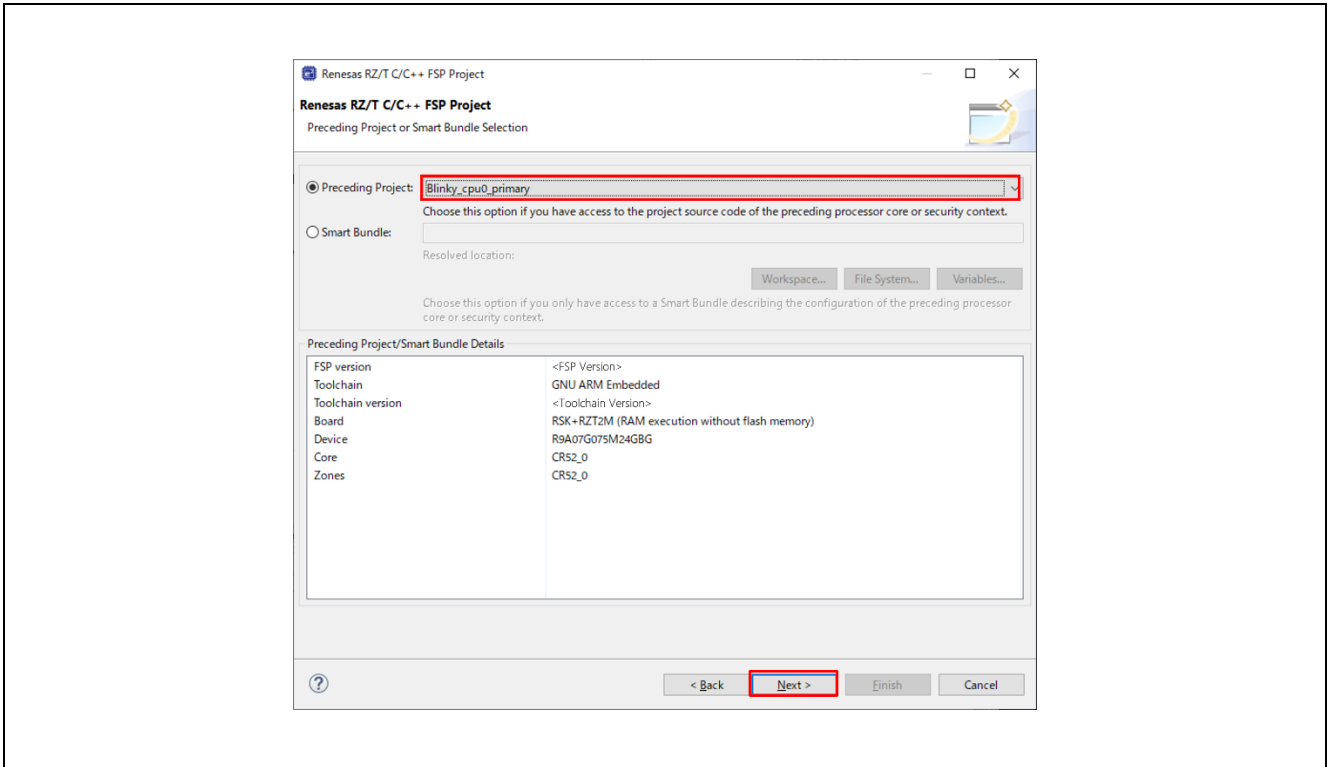


Figure 19 e² studio Project Configuration Window (Part 3)

10. Select the **build artifact** and RTOS.

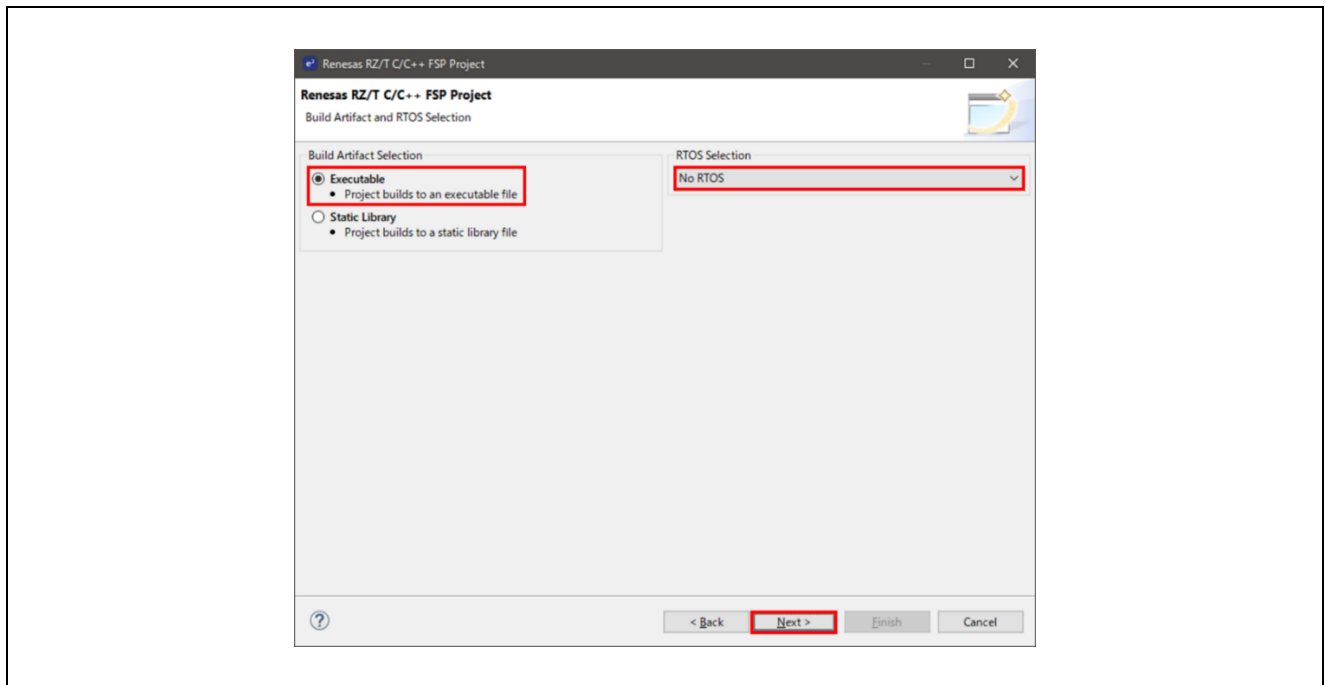


Figure 20 : e² studio Project Configuration Window (Part 4)

(Continued on next page)

11. Select the **Blinky** template for your board and click **Finish**.

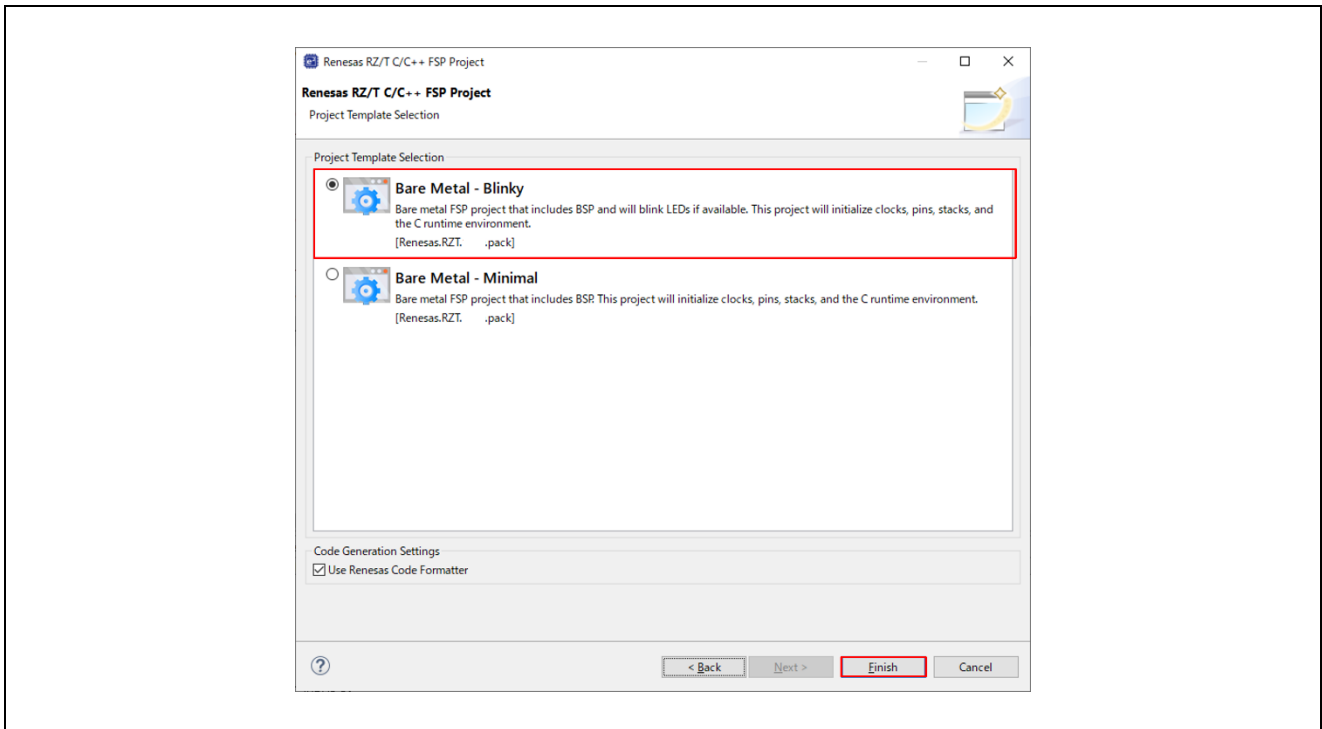


Figure 21 : e² studio Project Configuration Window (Part 5)

Once the project has been created, the name of the project will show up in the **Project Explorer** window of e² studio. Now click the **Generate Project Content** button in the top right corner of the **Project Configuration** window to generate your board specific files.

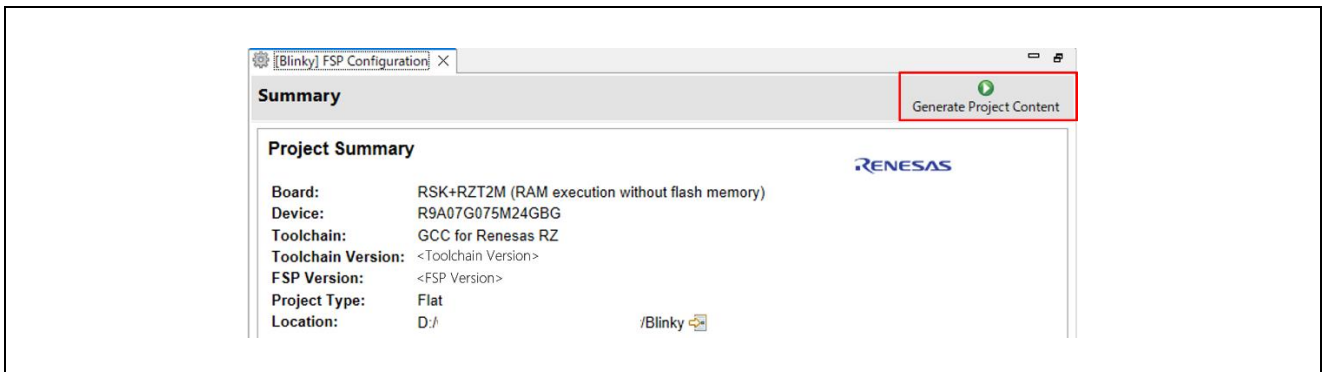


Figure 22 : e² studio Project Configuration Tab

Your new project is now created, configured, and ready to build.

4.3.1 Details about the Blinky Configuration

The Generate Project Content button creates configuration header files, copies source files from templates, and generally configures the project based on the state of the Project Configuration screen.

For example, if you check a box next to a module in the Components tab and click the Generate Project Content button, all the files necessary for the inclusion of that module into the project will be copied or created. If that same check box is then unchecked those files will be deleted.

4.3.2 Configuring the Blinky Clocks

By selecting the Blinky template, the clocks are configured by e² studio for the Blinky application.

The clock configuration tab (see 6.3.3 Configuring Clocks) shows the Blinky clock configuration. The Blinky clock configuration is stored in the BSP clock configuration file.

4.3.3 Configuring the Blinky Pins

By selecting the Blinky template, the GPIO pins used to toggle some of LEDs are configured by e² studio for the Blinky application.

The pin configuration tab shows the pin configuration for the Blinky application (see 6.3.4 Configuring Pins). The Blinky pin configuration is stored in the BSP configuration file.

4.3.4 Configuring the Parameters for Blinky Components

The Blinky project automatically selects the following HAL components in the Components tab:

- `r_ioport`

To see the configuration parameters for any of the components, check the Properties tab in the HAL window for the respective drivers (see 6.5 Adding and Configuring HAL Drivers).

4.3.5 Where is main()?

The main function is located in:

- `<RZT2 FSP project >/rzt_gen/main.c`
- `<RZN2 FSP project >/rzn_gen/main.c`

It is one of the files that are generated during the project creation stage and only contains a call to `hal_entry()`. For more information on generated files, see 6.5 Adding and Configuring HAL Drivers.

4.3.6 Blinky Example Code

The blinky application is stored in the `hal_entry.c` file. This file is generated by e² studio when you select the Blinky Project template and is located in the project's folder `<project >/src/` folder.

The application performs the following steps:

1. Get the LED information for the selected board by `bsp_leds_t` structure.
2. Initialize output level for LED pin to LOW using `R_BSP_PinClear((bsp_io_region_t) leds.p_leds[i][1], (bsp_io_port_pin_t) leds.p_leds[i][0])`.
3. Use `R_BSP_PinToggle ((bsp_io_region_t) leds.p_leds[i][1], (bsp_io_port_pin_t) leds.p_leds[i][0])` to set the output level to the LED pin.
4. `R_BSP_SoftwareDelay(delay, bsp_delay_units)` waits for a certain period of time. Then run #3 again.

4.4 Build the Blinky Project

Highlight the new project in the Project Explorer window by clicking on it and build it.

When multiprocessing, build both the primary and secondary projects.

4.4.1 Build

There are three ways to build a project:

1. Click on **Project** in the menu bar and select **Build Project**.
2. Click on the hammer icon.
3. Right-click on the project and select **Build Project**.

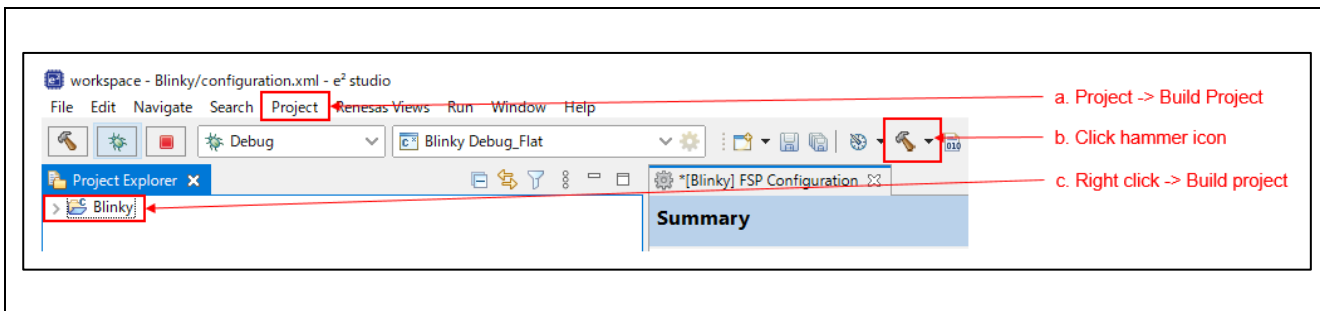


Figure 23 : e² studio Project Explorer Window

Once the build is complete a message is displayed in the build Console window that displays the final image file name and section sizes in that image.

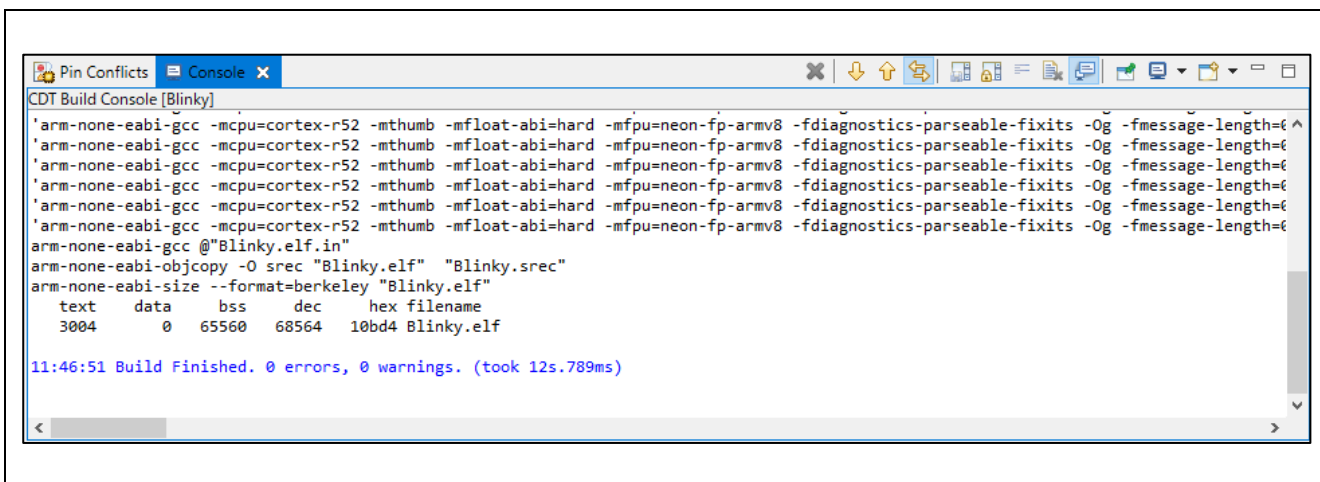


Figure 24 : e² studio Project Build Console

4.5 Debug the Blinky Project

4.5.1 Debug Prerequisites

To debug the project on a board, you need the followings:

- The board to be connected to e² studio.
- The debugger to be configured to talk to the board.
- The application to be programmed to the microprocessor.

Applications run from the internal ram of your microprocessor. To run or debug the application, the application must first be programmed to ram by JTAG debugger.

RSK board has a JTAG header and requires an external JTAG debugger to the header.

4.5.2 Debug Steps

When multiprocessing, please refer to Section 4.7 Debug and Run for Multiprocessing.

To debug the Blinky application, follow these steps:

1. Configure the debugger for your project by clicking **Run > Debugger Configurations ...** or by selecting the drop-down menu next to the bug icon and selecting **Debugger Configurations ...**

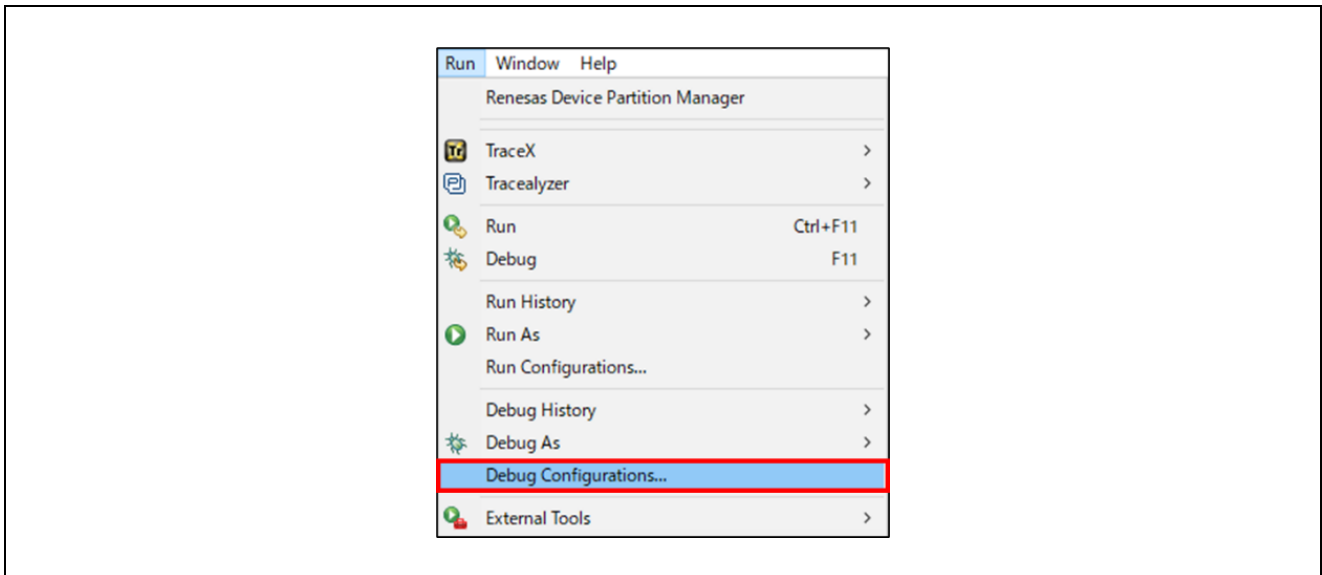


Figure 25 : e² studio Debug Icon

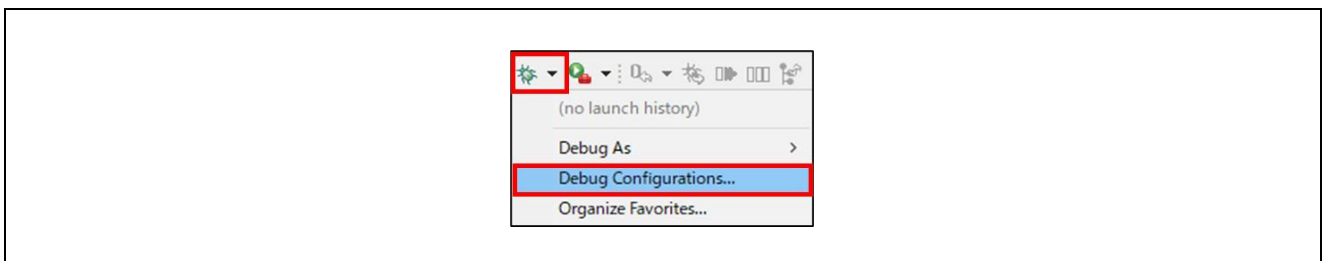


Figure 26 : e² studio Debugger Configurations Selection Option

(Continued on next page)

2. Select your debugger configuration in the window. If it is not visible, then it must be created by clicking the New icon in the top left corner of the window. Once selected, the **Debug Configuration** window displays the **Debug configuration** for your **Blinky** project.

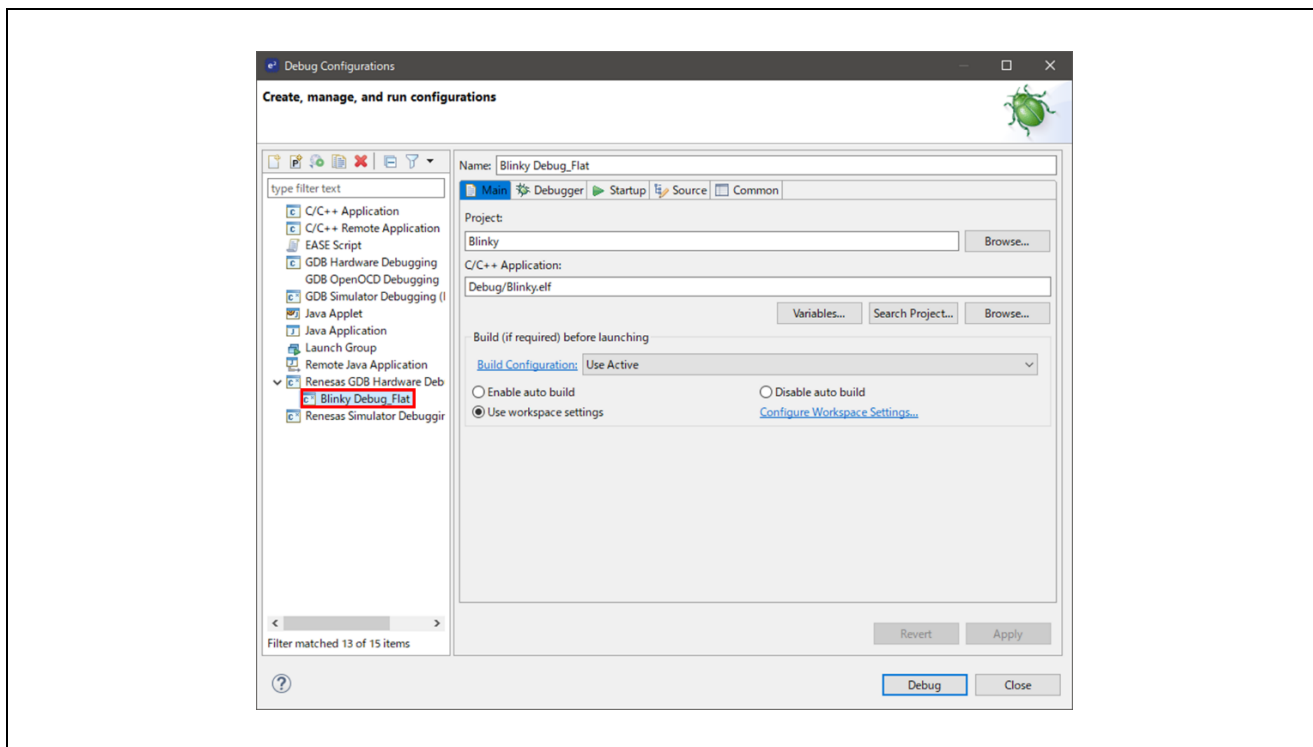


Figure 27 : e² studio Debugger Configurations Window with Blinky Project

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3. If you use RAM execution without flash memory boot mode, it needs following configuration.
 - **Debugger > Connection Settings > Connection**
 - Set **No** to **Reset after download** (Available in e² studio 2023-07 and later versions) to avoid resetting MPU after program download
 - (CPU0(CR52_0) ONLY) Set **Yes** to **Set CPSR(5bit) after download** (Available in e² studio 2023-04 and later versions) to set the CPSR register value of CR52 general register before running the application.

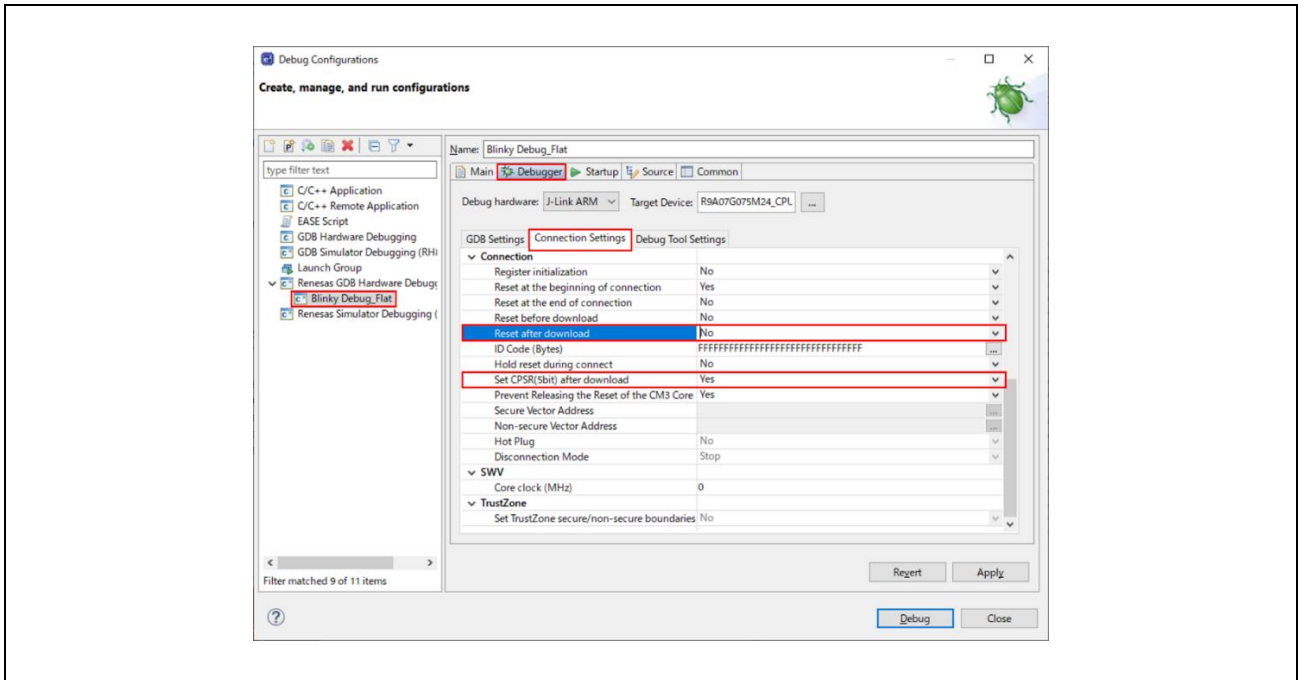


Figure 28 : e² studio Debugger Configurations Window with Blinky Project

4. Click **Debug** to begin debugging the application.

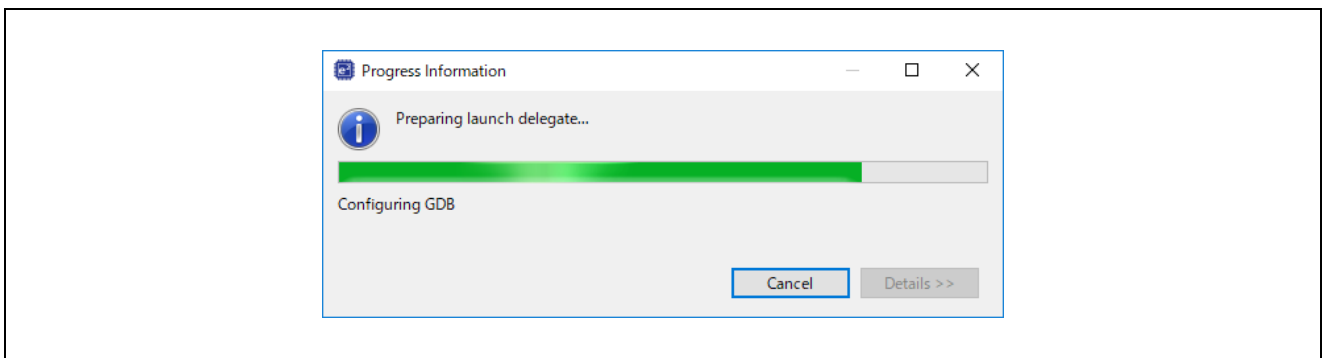


Figure 29: Start Debugging

4.5.3 Details about the Debug Process

In debug mode, e² studio executes the following tasks:

1. Downloading the application image to the microprocessor and programming the image to the internal memory.
2. Setting a breakpoint at **main()**.
3. Setting the stack pointer register to the stack.
4. Loading the program counter register with the address of the **system_init()**.
5. Displaying the startup code where the program counter points to.

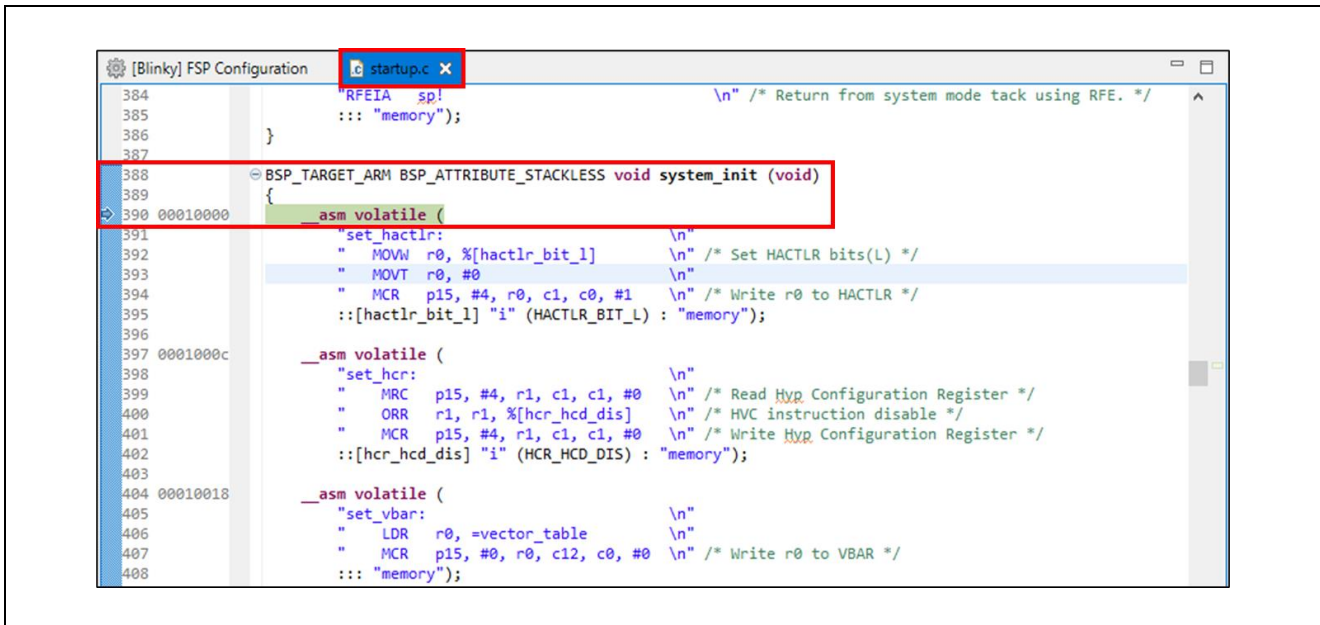


Figure 30 : e² studio Debugger Memory Window

4.6 Run the Blinky Project

While in Debug mode, click **Run > Resume** or click on the **Play** icon twice.



Figure 31 : e² studio Debugger Play Icon

The following LEDs on the board should now be blinking.

- RZ/T series
 - RSK+RZ/T2M: LED0-1 (CPU0), LED2-3 (CPU1)
 - RSK+RZ/T2L: LED0-6 (including LED_x_ESC_XXX)
 - RSK+RZ/T2ME: LED0-1 (CPU0), LED2-3 (CPU1)
- RZ/N series
 - RSK+RZ/N2L: LED0-3

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To suspend program execution, click **Run > Suspend** or click on the **Pause** icon.

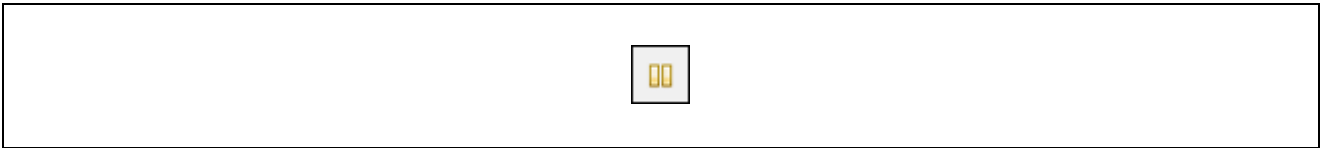


Figure 32 : e² studio Debugger Pause Icon

To exit Debug mode and disconnect from the debugger, click **Run > Terminate** or click on the **Stop** icon.

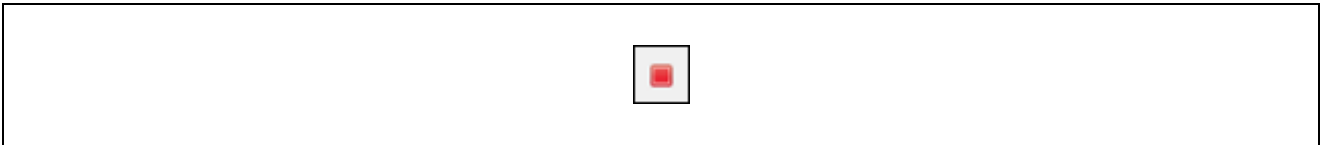


Figure 33 : e² studio Debugger Stop Icon

4.7 Debug and Run for Multiprocessing

To debug the Blinky application, follow these steps:

1. Connect the debugger with the primary project using the procedure in 4.5.2 Debug Steps.
2. The primary project in operation, connect the debugger with the secondary project using the procedure in 4.5.2 Debug Steps.
3. When the following dialog box is shown, please click **No** to start debugging.

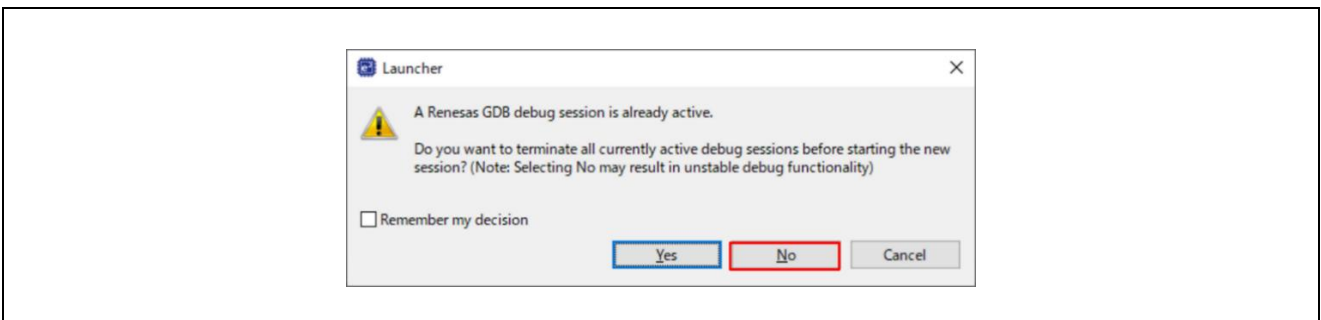


Figure 34 Warning Window of Starting Debug Session

4. When Figure 35 is shown, please click **Yes** to proceed the launch.

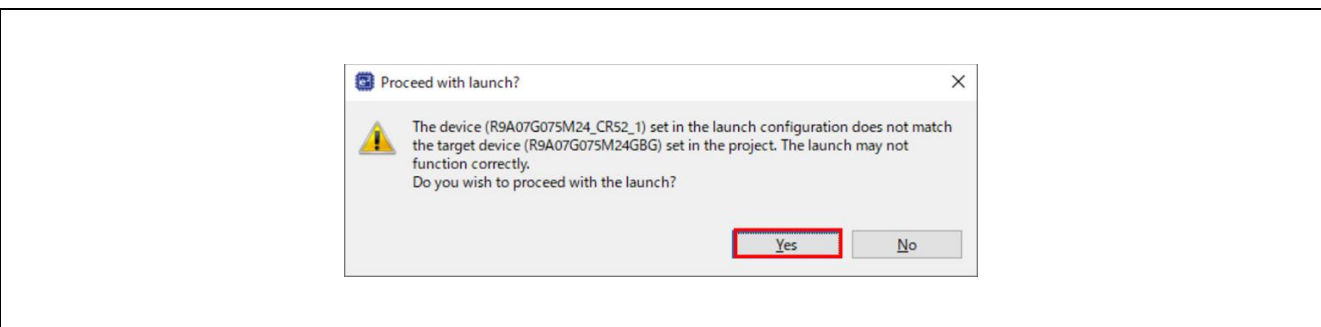


Figure 35 Warning Window of Device Name

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5. Run the primary project with procedure 4.6 Run the Blinky Project. If the LED0 and LED1 are blinking, proceed to the next step.
6. Run the secondary project with procedure 4.6 Run the Blinky Project.
7. When exiting Debug mode and disconnect from the debugger, terminate both projects, the primary and the secondary.

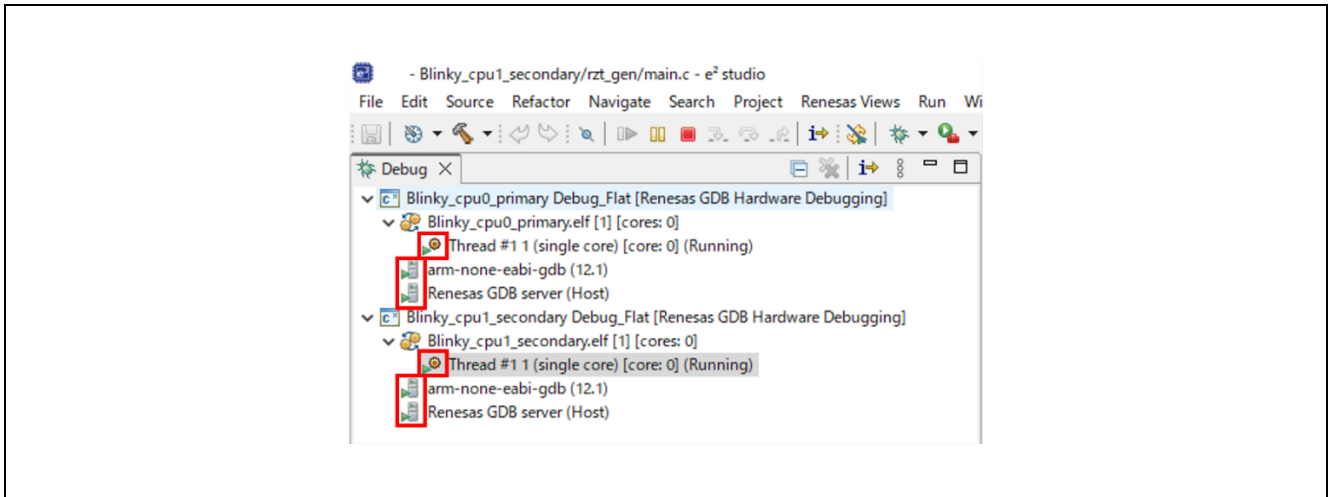


Figure 36 During Program Execution

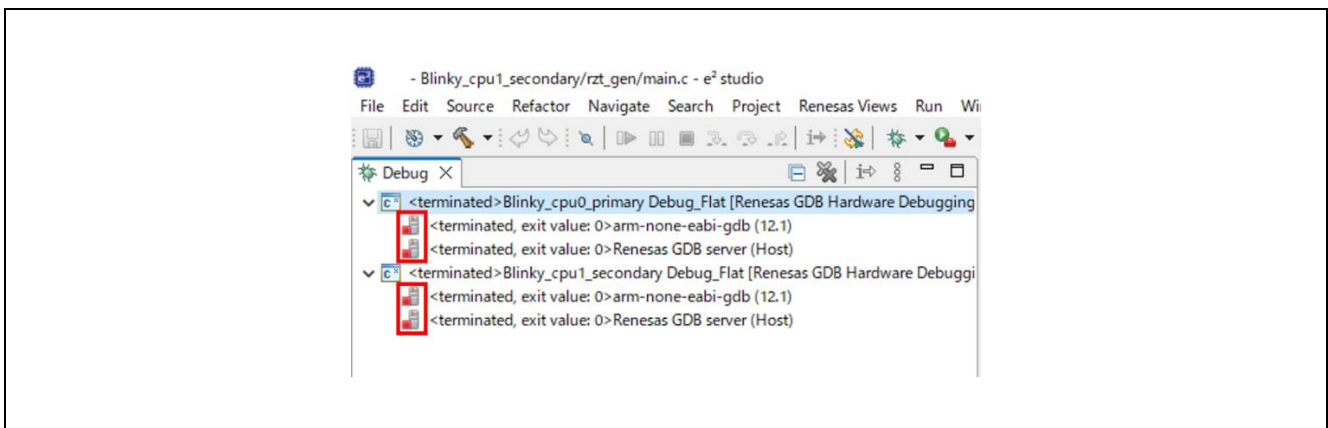


Figure 37 Terminated Program

4.8 Import the Project

The project created, built, and debugged in chapters 4.3 through 4.7 can be imported and run in other workspaces.

Note:

Apply the same version of FSP package used for the project to the other workspace.

(Continued on next page)

To import the projects, follow these steps:

1. Click **File > Import**.

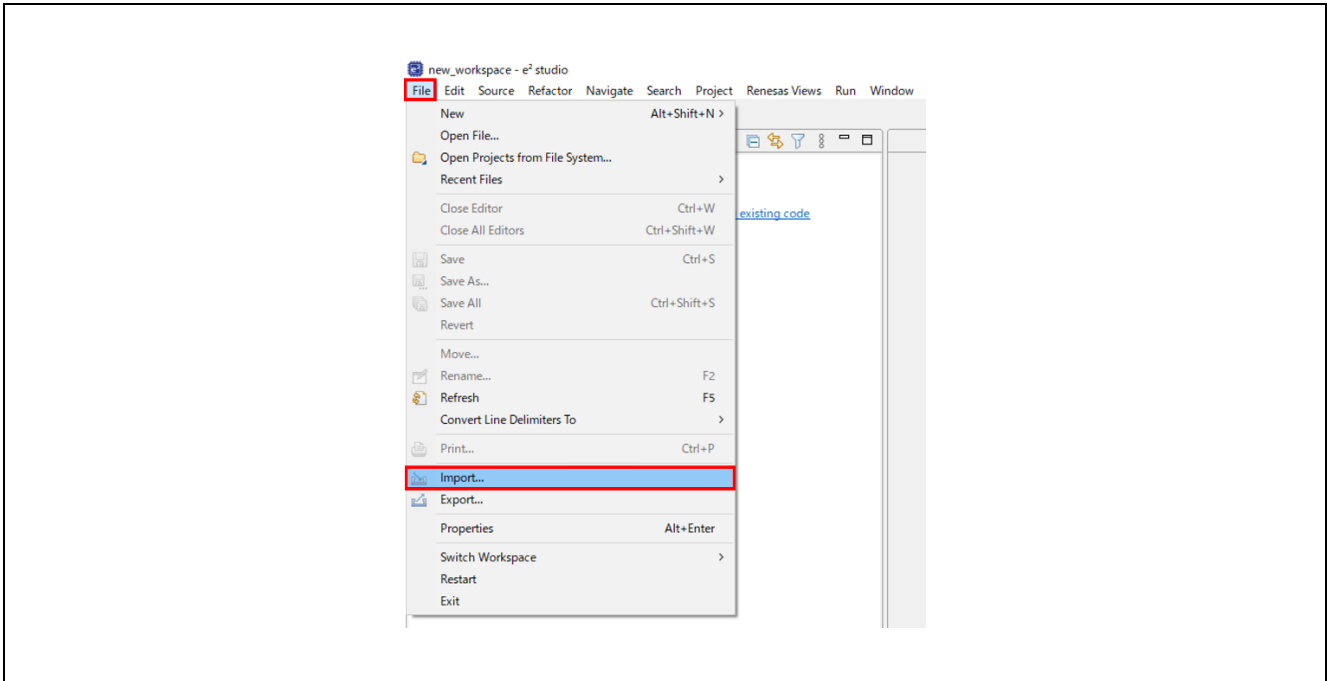


Figure 38 e² studio Import

2. Click **General > Existing Projects into Workspace**.

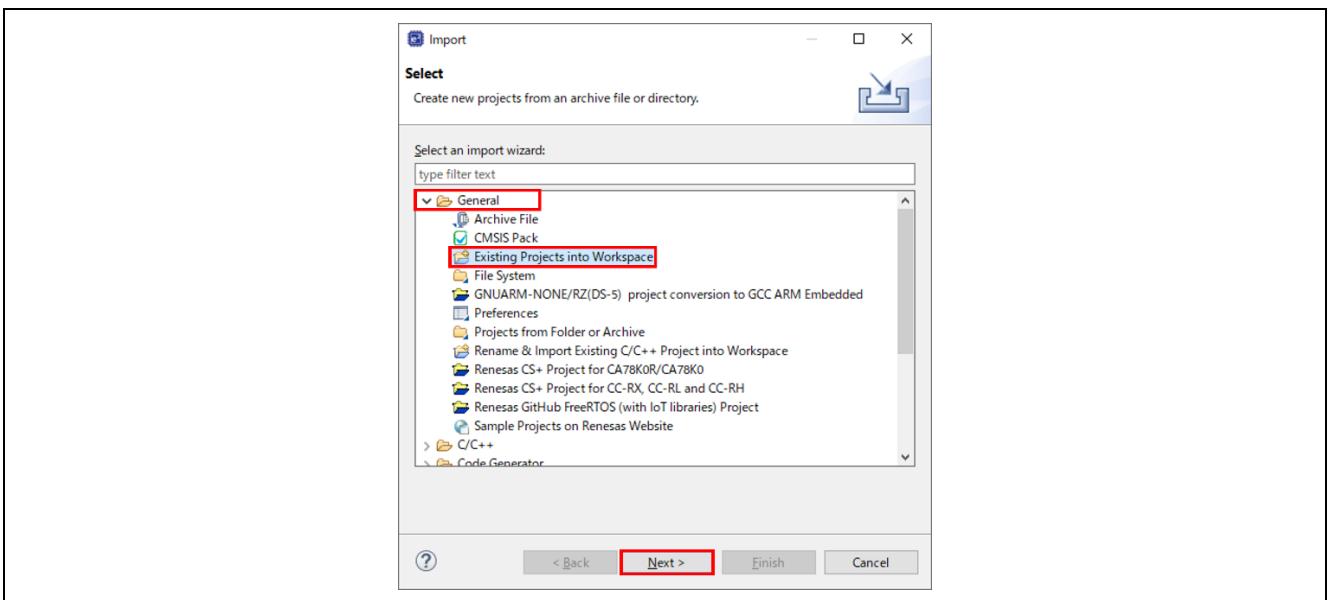


Figure 39 e² studio Select Import Type

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3. **Select root directory** or **Select archive file** where the project you would like to import into the other workspace resides.
4. Select projects to import in **Projects**. When using **Select root directory**, it is recommended to set **Copy projects into workspace** in **Options** to avoid updating the same project from multiple workspaces.

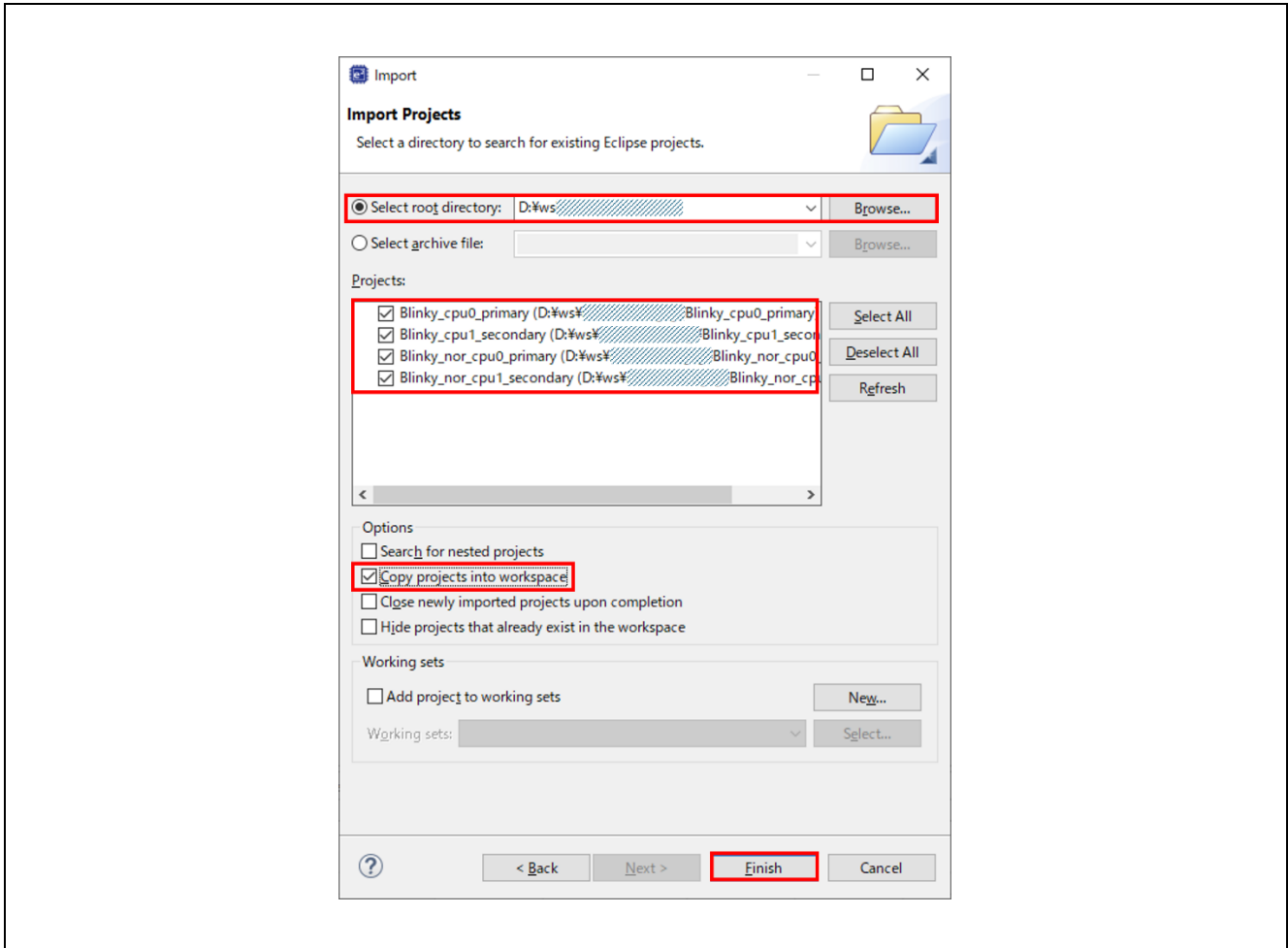


Figure 40 e² studio Select Root Directory to Import Project

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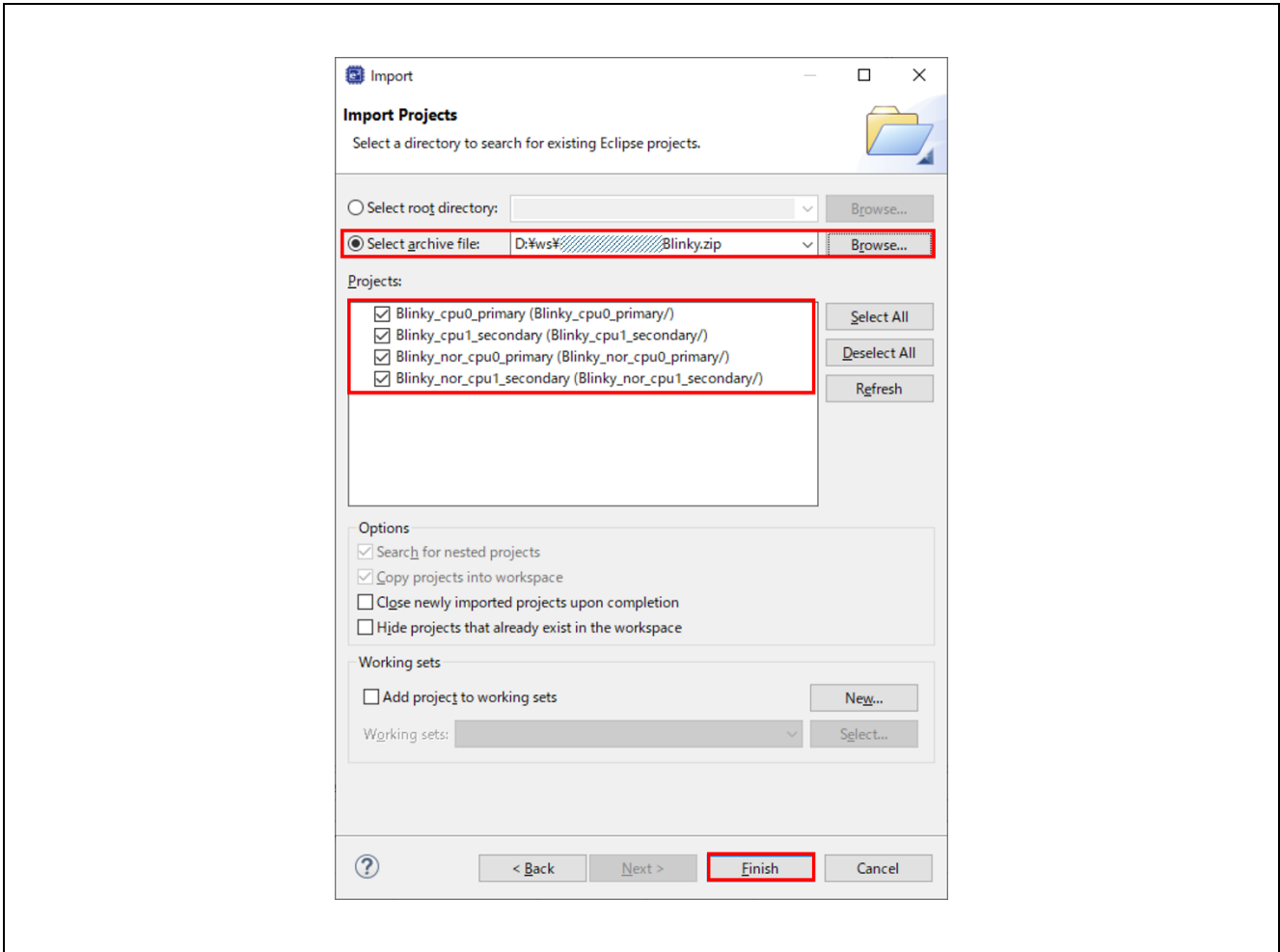


Figure 41 e² studio Select Archive File to Import Project

- The projects have been imported into the other workspace.

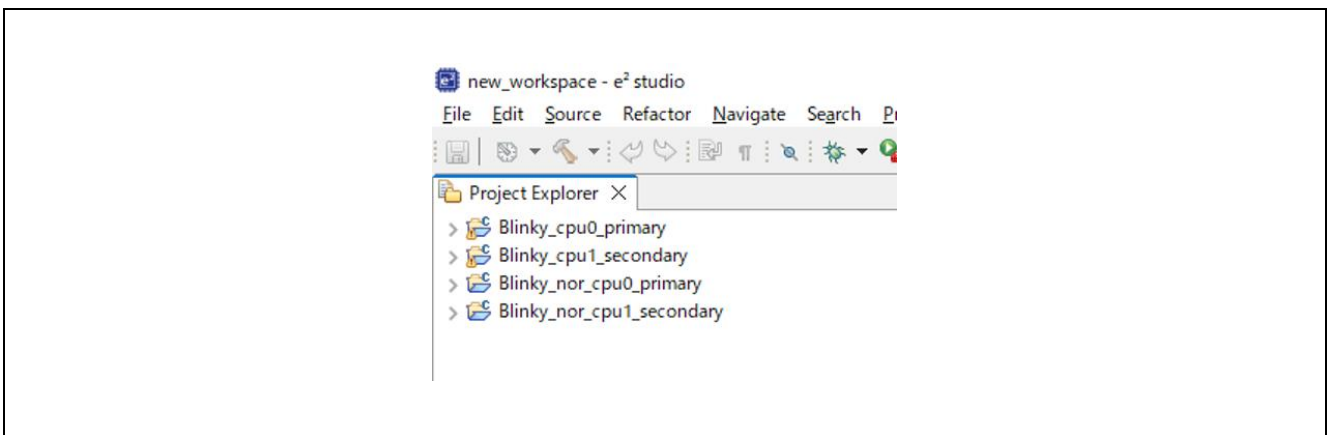


Figure 42 e² studio new workspace

Note:

The imported project must be clicked the **Generate Project Content** button and built before debugging.

5. FSP Smart Configurator User Guide

5.1 What is FSP Smart Configurator?

The Renesas FSP Smart Configurator (FSP SC) is a desktop application designed to configure device hardware such as clock set up and pin assignment as well as initialization of FSP software components when using a 3rd-party IDE and toolchain.

For creating RZ/T2 and RZ/N2 project, the FSP SC can currently be used with

- IAR EWARM with IAR toolchain for Arm

Projects can be configured, and the project content generated in the same way as in e² studio. Please refer to 5.2 Configuring a Project section for more details.

5.2 Tutorial Blinky

The goal of this tutorial is to quickly get acquainted with the Flexible Platform by moving through the steps of creating a simple application using FSP SC and 3rd-party IDE and running that application on an RZ/T2, RZ/N2 MPU board. This chapter guides you through creating projects for a single-core processing and a multiprocessing. Here, the multiprocessing refers to a process in which CR52 CPU0 core is activated first and CR52 CPU1 core operates after CR52 CPU0 core sets up for CR52 CPU1 core.

The application used in this tutorial is Blinky, traditionally the first program run in a new embedded development environment.

Blinky is the “Hello World” of microprocessors. If the LED blinks you know that:

- The toolchain is setup correctly and builds a working executable image for your chip.
- The debugger has installed with working drivers and is properly connected to the board.
- The board is powered up and its jumper and switch settings are probably correct.
- The microprocessor is alive, the clocks are running, and the memory is initialized.

5.3 Using Smart Configurator with IAR EWARM

IAR EWARM includes support for Renesas RZ/T2, RZ/N2 devices. These can be set up as bare metal designs within IAR EWARM. However, most RZ/T2, RZ/N2 developers will want to integrate RZ/T2, RZ/N2 FSP drivers and middleware into their designs. SC will facilitate this.

FSP SC generates a “Project Connection” file that can be loaded directly into IAR EWARM to update project files.

5.3.1 Prerequisites

- IAR EWARM installed and licensed.
 - Please refer to IAR systems website regarding IAR EWARM.
- FSP SC and FSP Pack installed.
 - Please refer to Renesas website regarding to FSP SC and FSP Pack.

Note for RZ/T2ME:

If you use the IAR EWARM 9.60.1 to debug RZ/T2ME FSP project, please apply the following patch file.

- EWARM_Patch_for_RZT2ME_rev1.0.zip

Regarding how to apply the patch, please read the readme file in patch file.

5.3.2 Create a New Project

The following steps are required to create a project using IAR EWARM, FSP SC and FSP. In the case of multiprocessing, two projects with different settings must be created. The CR52 CPU0 core project that starts first is called the primary project and the CR52 CPU1 core project is called the secondary project.

Note for multiprocessing projects:

The primary project and the secondary project should be created in a same workspace.

The secondary project should be created after the primary project is created in 5.3.2 section and done 1st build of the primary project in 5.3.3 section.

1. Start the FSP Smart Configurator.
 - FSP Smart Configurator is installed in the following path as default.
 - For RZ/T series, it is installed in C:\Renesas\rzt\sc_vYYYY-MM_fsp_vX.X.X\eclipse\rasc.exe
 - For RZ/N series, it is installed in C:\Renesas\rzn\sc_vYYYY-MM_fsp_vX.X.X\eclipse\rasc.exe
2. Select the **File > New > FSP Project...**
 - This step may be unnecessary depending on old FSP SC version.

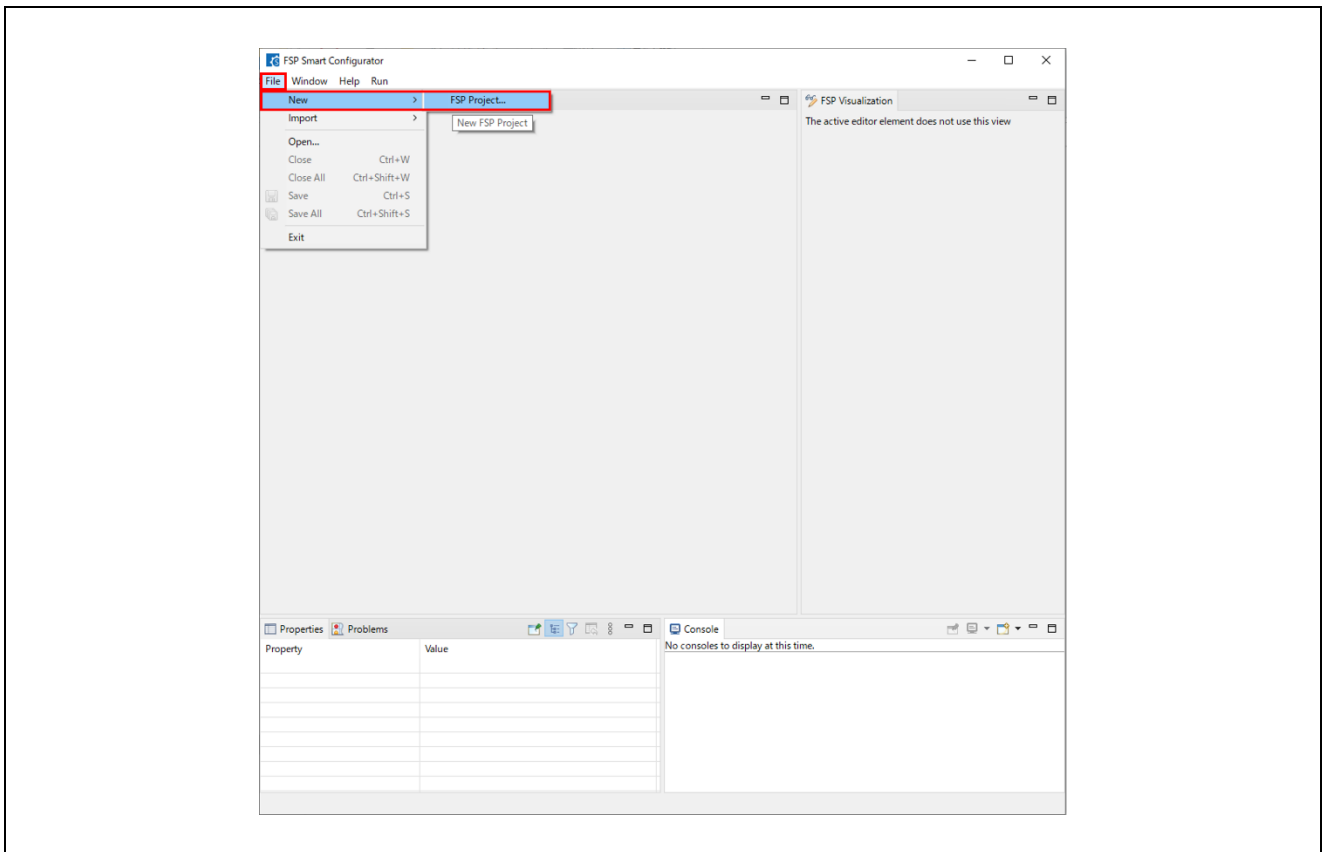


Figure 43 : FSP SC New Project

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3. Enter a project folder and project name. An example of naming is shown below.
 - Single-core processing
 - Blinky
 - Multiprocessing
 - The primary project: Blinky_cpu0_primary
 - The secondary project: Blinky_cpu1_secondary

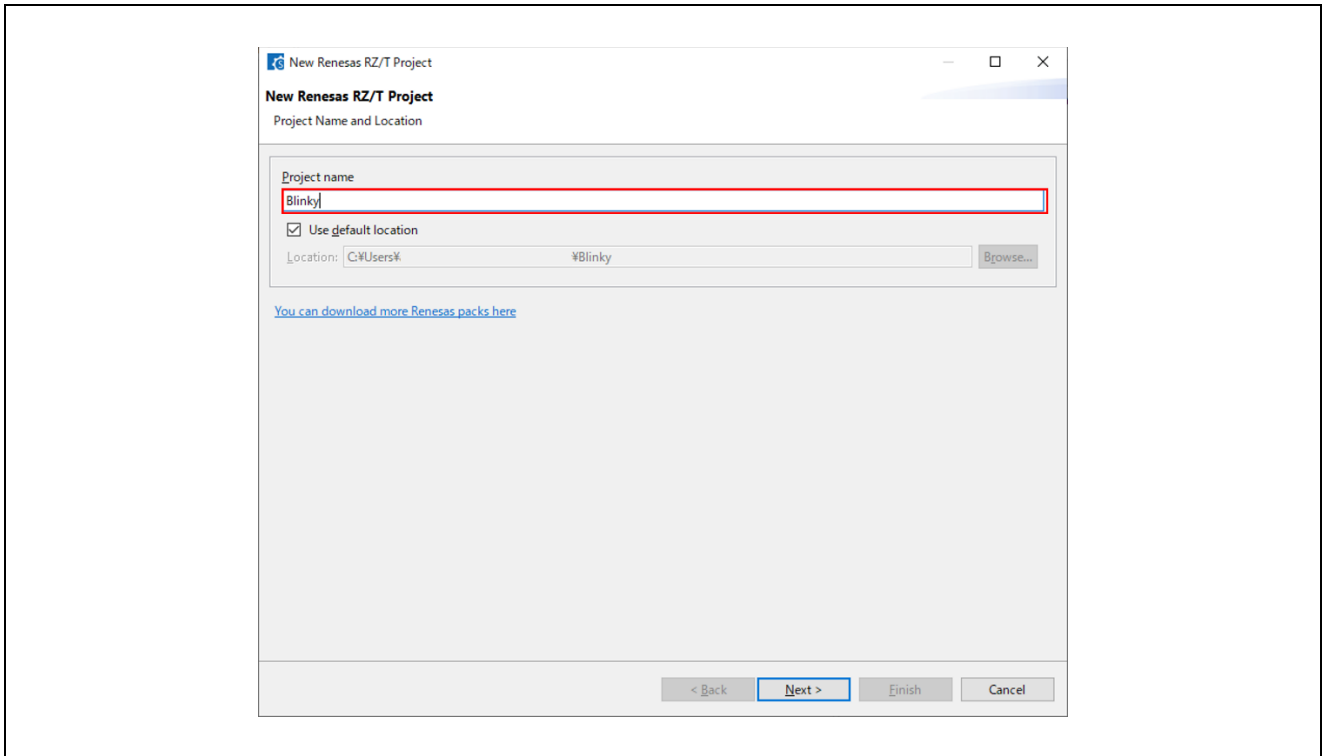


Figure 44 : FSP SC Project Settings

4. Select the **FSP** version.
5. Select the **Board** for your application.
 - You can select an existing RZ/T2, RZ/N2 MPU Evaluation Kit or select Custom User Board for any of the RZ/T2, RZ/N2 MPU devices with your own BSP definition.
 - Here, select either of following boards to create a FSP project for RSK board.
 - RZ/T series
 - **RSK+RZT2M (RAM execution without flash memory)**
 - **RSK+RZT2L (RAM execution without flash memory)**
 - **RSK+RZT2ME (RAM execution without flash memory)**
 - RZ/N series
 - **RSK+RZN2L (RAM execution without flash memory)**
6. (RZ/T2M, RZ/T2ME ONLY) Select the Core from the drop-down list.
 - Single-core processing
 - CR52_0
 - Multiprocessing
 - The primary project: CR52_0
 - The secondary project: CR52_1

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7. Select **IDE Project Type**.

- Here, select **IAR EWARM** (FSP SC is older than 2024-04 version) or **IAR EWARM [v9.40+]** (FSP SC is equal to or newer than 2024-04 version).
 - As the Toolchain, IAR Toolchain for ARM is preselected.

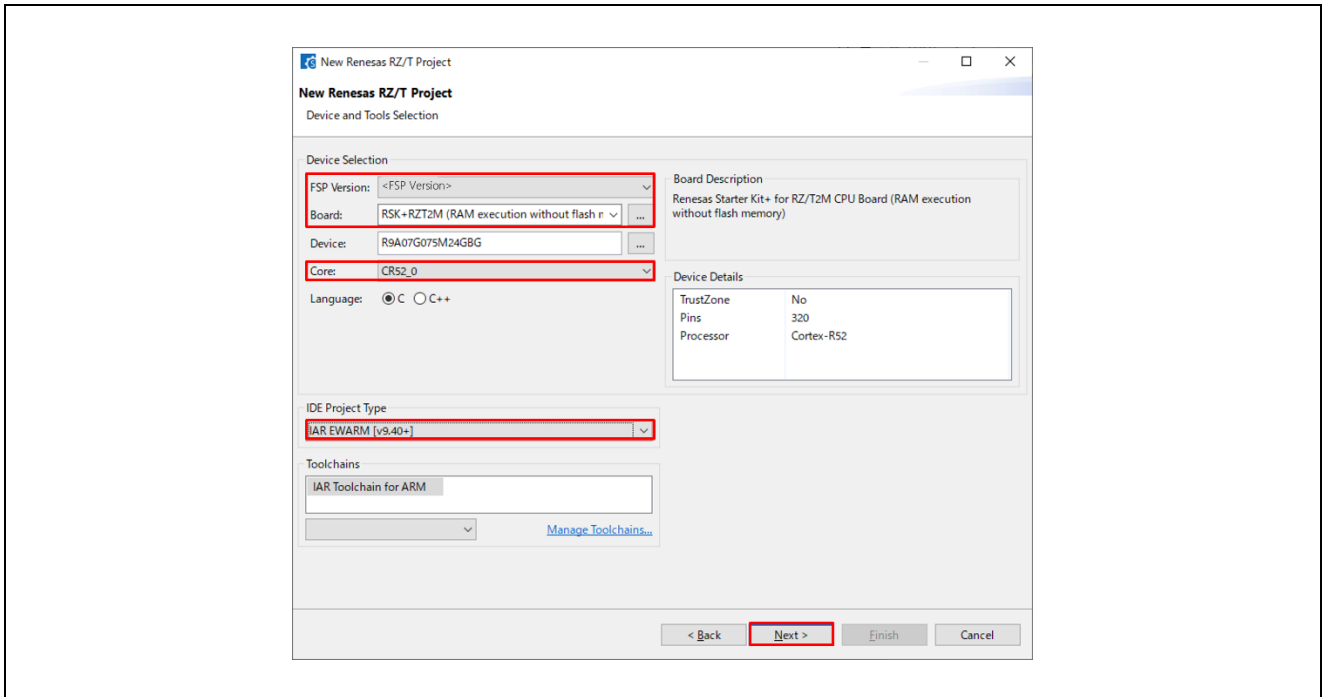
8. Click **Next**.

Figure 45 : Target Device and IDE Selections

9. (The secondary project of multiprocessing **ONLY**) Select a bundle file of the primary project. Built CPU0 project names in the same workspace appear as an option in the drop-down list.

Note:

Warnings occur if the FSP version used is different between the primary project and the secondary project. Use the FSP same version.

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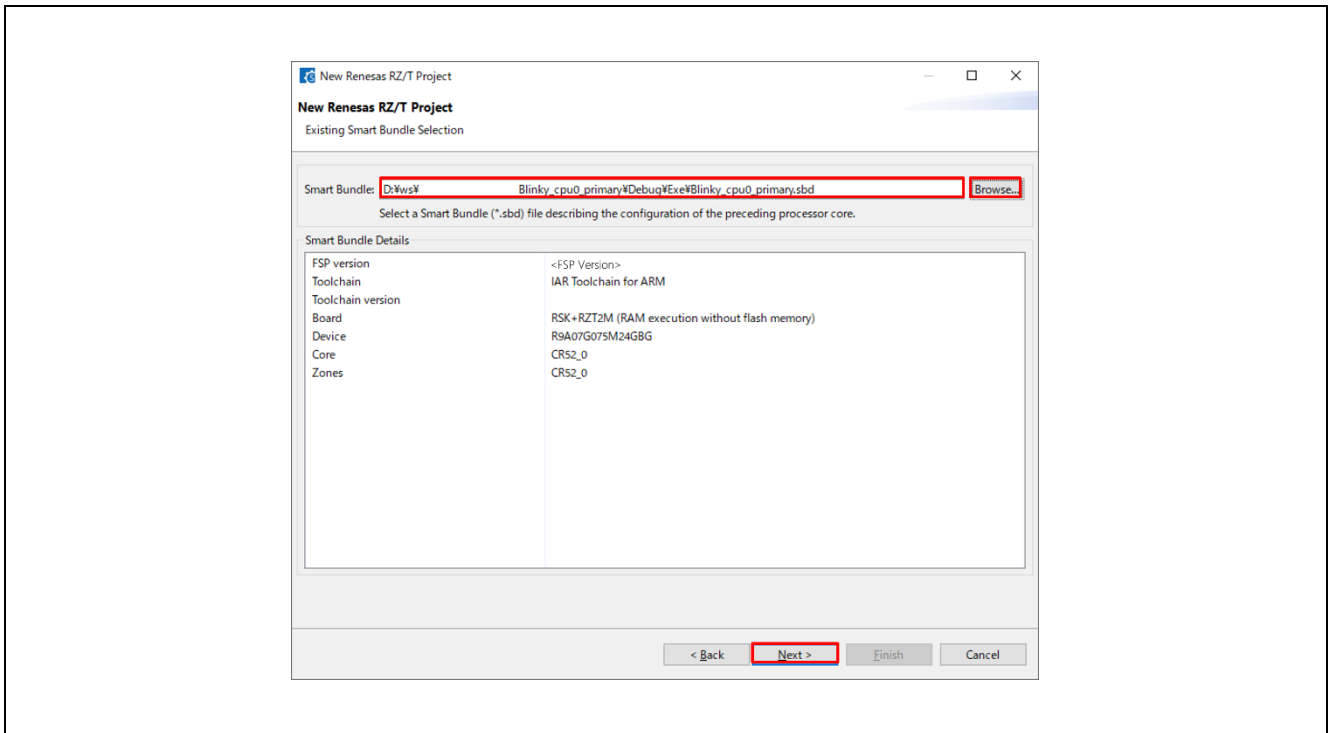


Figure 46 e² studio Project Configuration Window (Part 3)

10. Select **RTOS**.
 - Here, select **No RTOS** for proceeding the following tutorial.
11. Click **Next**.

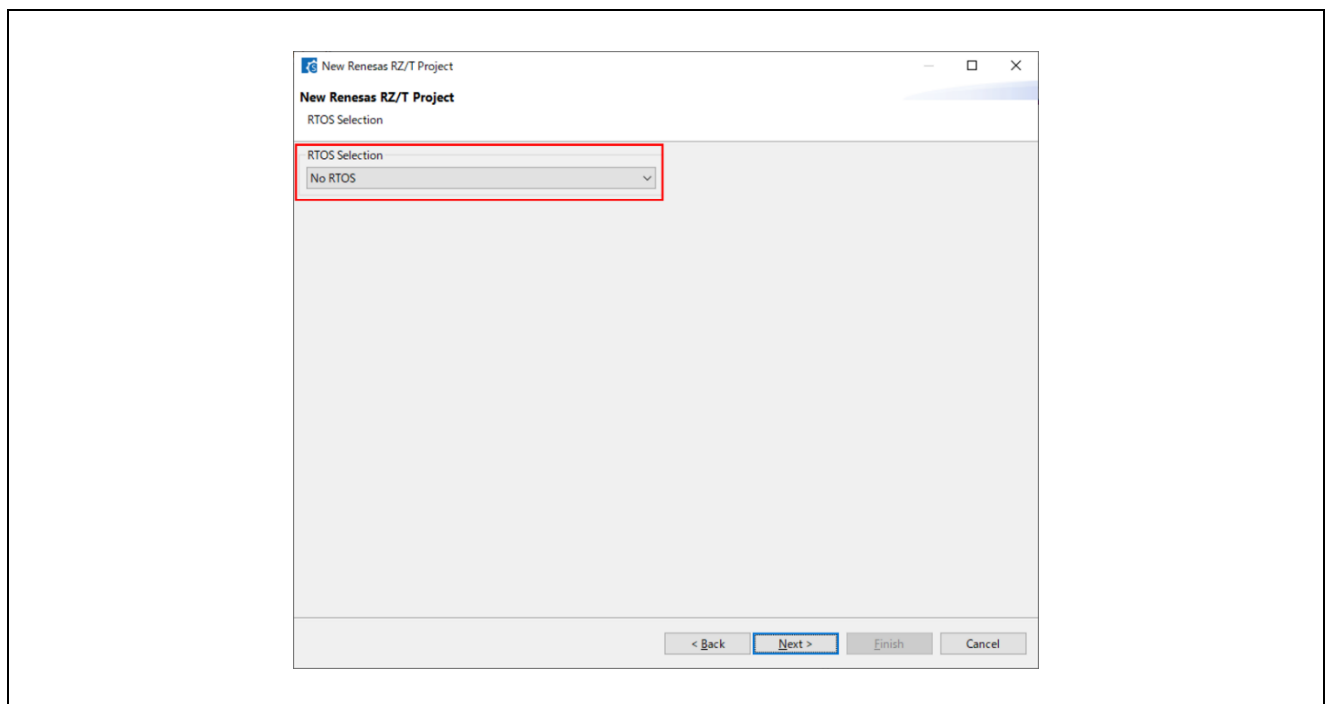


Figure 47 : RTOS Selection

(Continued on next page)

12. Select a **project template** from the list of available templates.
 - By default, this screen shows the templates that are included in your current RZ/T MPU Pack.
 - Here, select Bare Metal – Blinky for proceeding the following tutorial.
 - If you want to develop your own application, select the basic template for your board, **Bare Metal – Minimal**.
13. Click **Finish**.

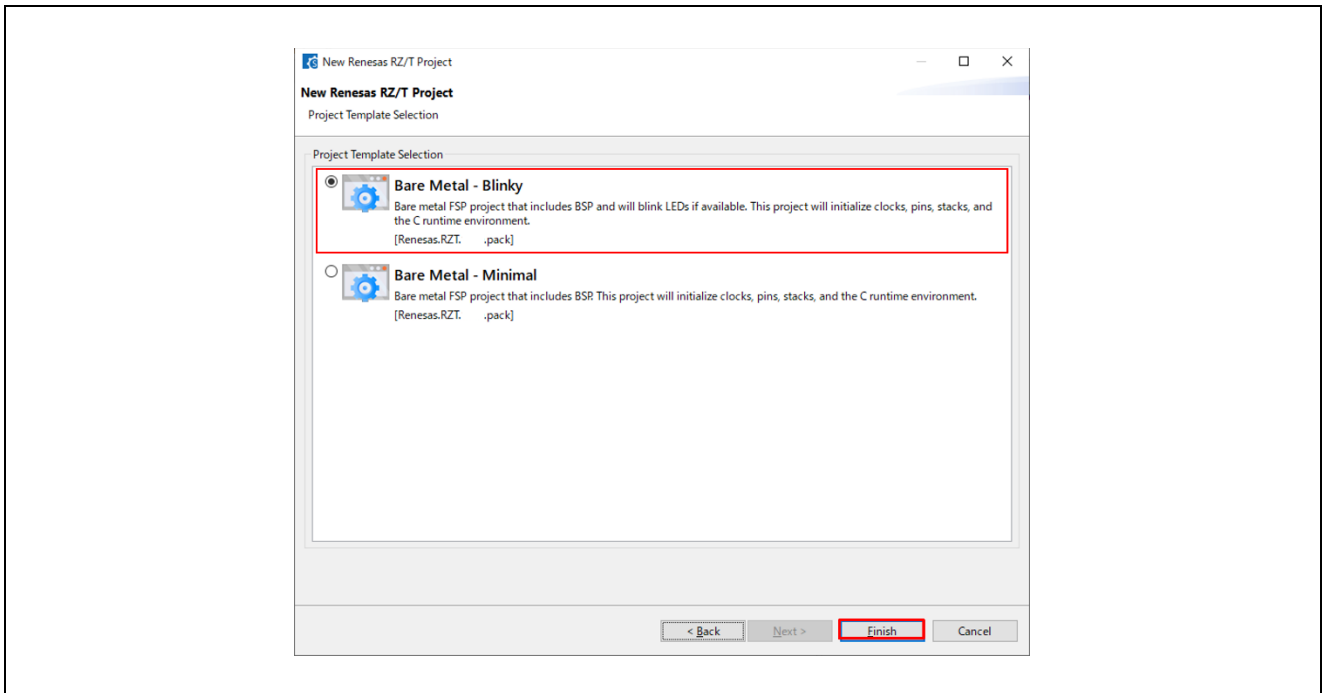


Figure 48 : Template Selection

14. **Configure** the FSP configuration by referring to Chapter 6.3 “Configuring a Project”.
 - Here, skips this configuration step for proceeding the following tutorial.
15. On completion of the FSP configuration, click **Generate Project Content**.

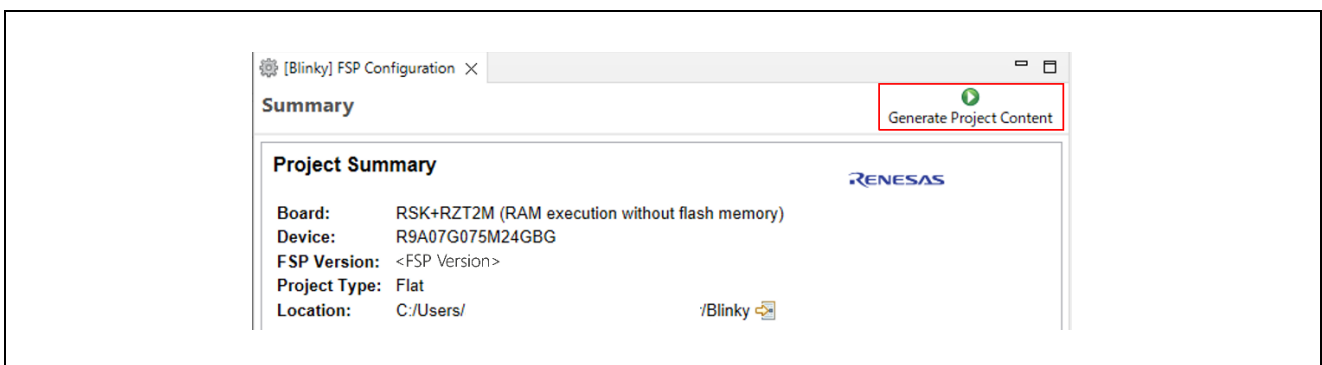


Figure 49 : FSP Project Configuration and Generation

A new IAR EWARM project file will be generated in the project path.

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16. Double click IAR EWARM Workspace file (.eww) to open IAR EWARM with workspace.

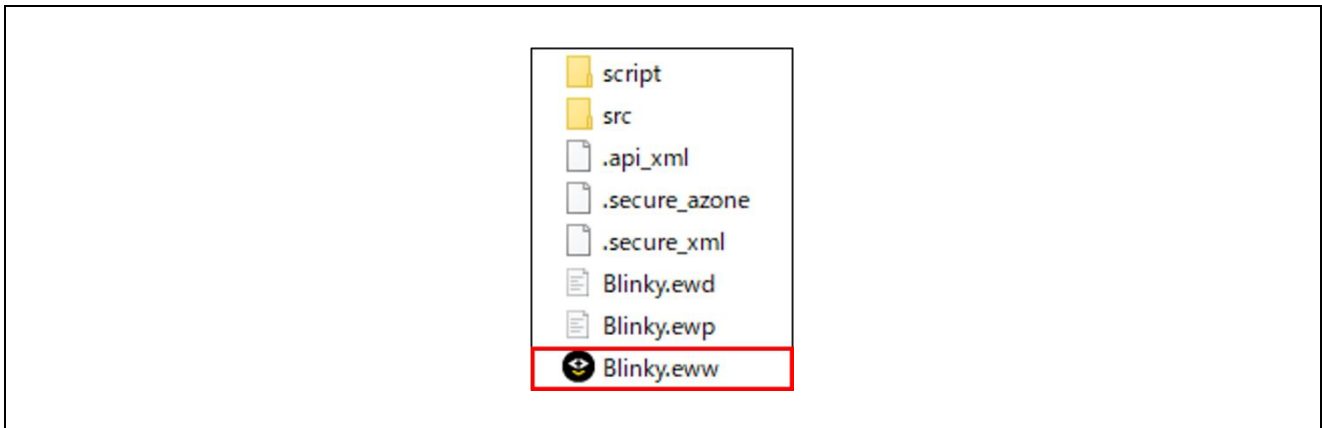


Figure 50 : FSP Project Workspace

5.3.3 Build the Project

5.3.3.1 NOTE: Build settings [Only Multiprocessing]

For multiprocessing, note the build order and build settings.

1. Create and build the primary project. (1st build of the primary project)
No setting is required, proceed to 5.3.3.2 Build.
2. Create the secondary project. Change the project options setting and build it.
Set the following before building:
 - i) Click **Project > Options...**

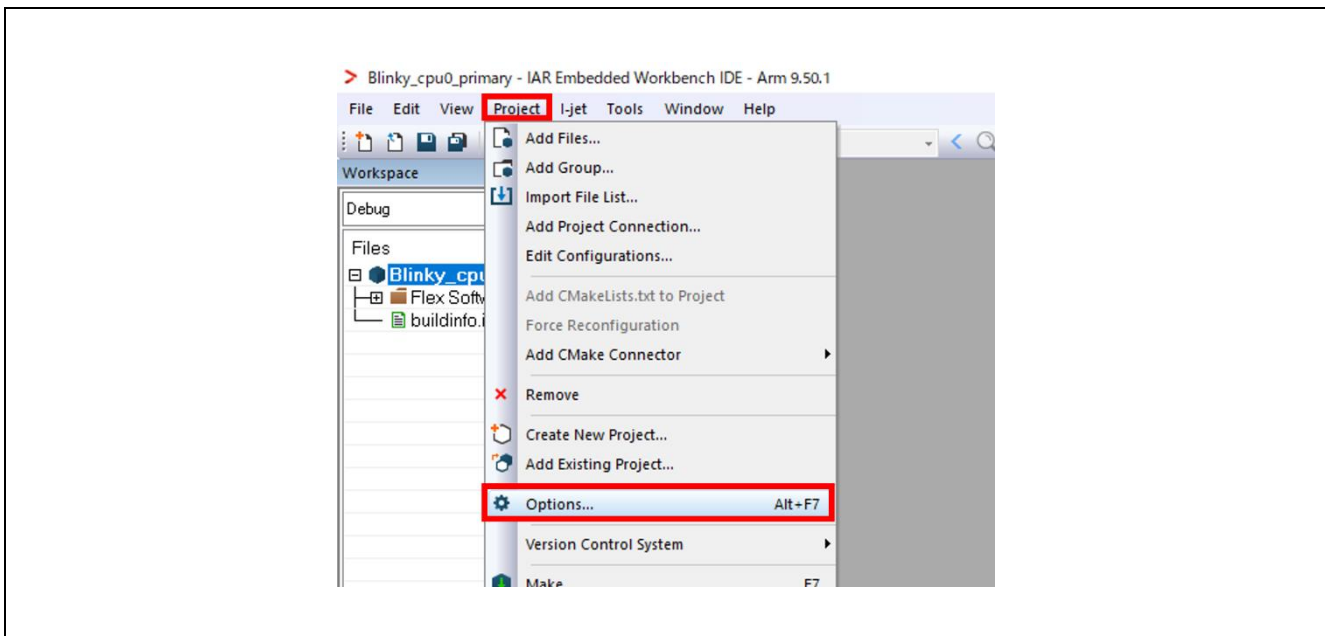


Figure 51 IAR EWARM project options

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- ii) Click **Debugger > Setup**.
- iii) Uncheck "Run to".

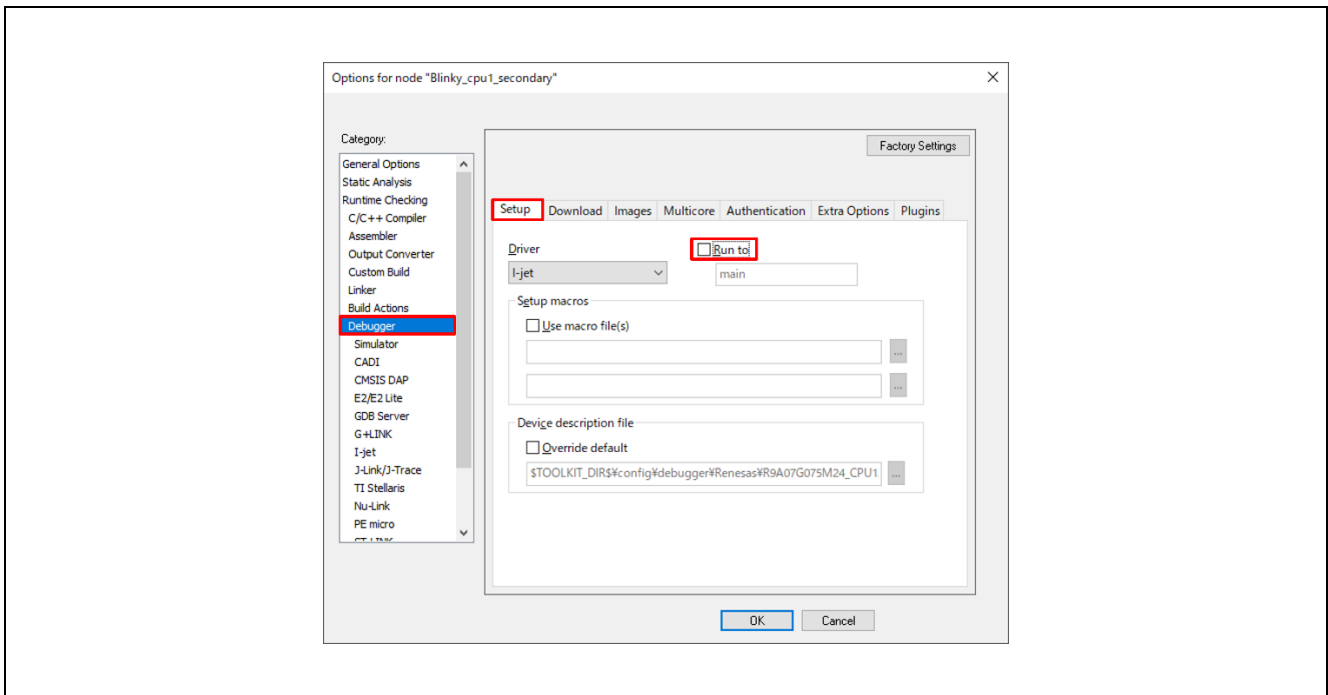


Figure 52 IAR EWARM project options for the secondary project (Run to)

- iv) Click **I-jet > Setup**.
- v) Select **Software** as **Reset** and click **OK**.

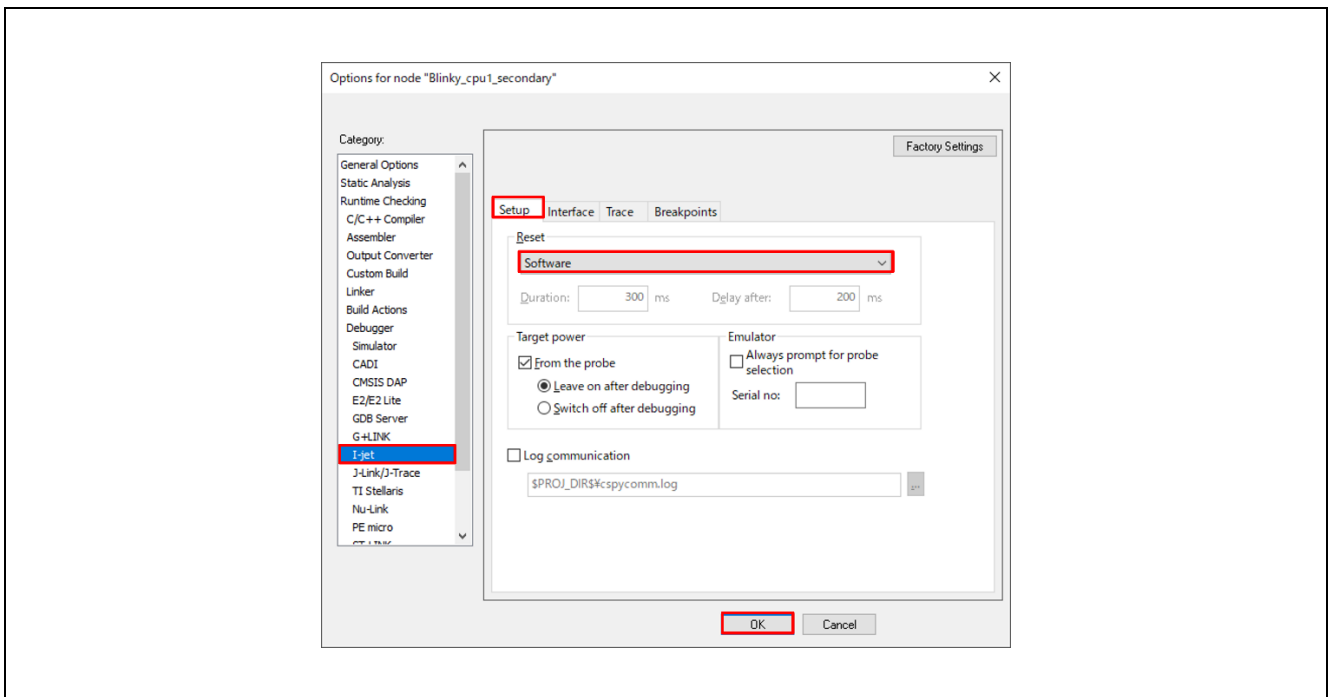


Figure 53 IAR EWARM project options for the secondary project (Reset)

- vi) Proceed to 5.3.3.2 Build.
 - vii) Close the secondary project.
3. Change the project options setting of the primary project and build it. (2nd build of the primary project)
- Set the following before building:
- i) Click **Project > Options....**
 - ii) Click **Debugger > Setup.**
 - iii) Uncheck "Run to".
 - iv) Click **Debugger > Multicore.**
 - v) Set the following contents in **Asymmetric multicore.**
 - Simple
 - Partner workspace: the path of Blinky_cpu1_secondary.eww
 - Partner project: Blinky_cpu1_secondary
 - Partner configuration: Debug

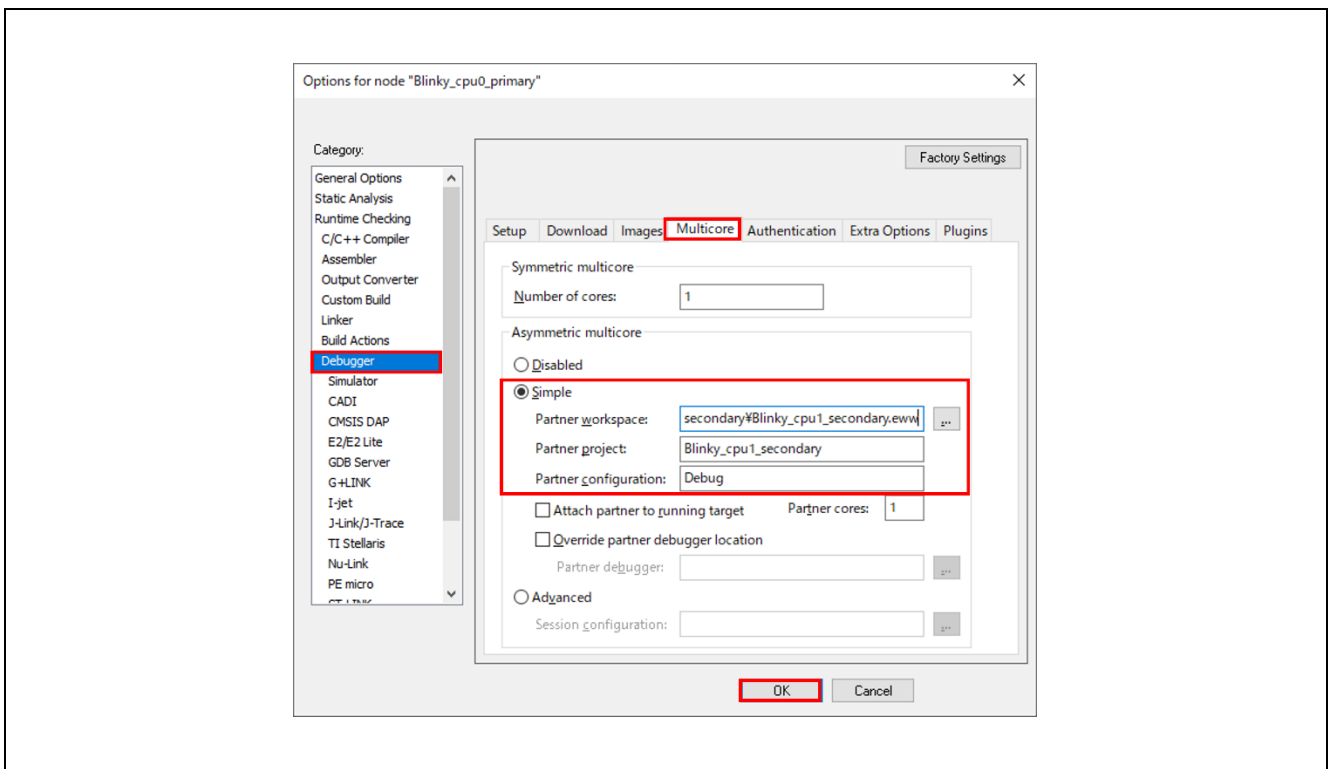


Figure 54 IAR EWARM project options for the primary project (Multicore)

- vi) Click **OK** and close Options window.

(Continued on next page)

vii) Click **Tools > Options....**

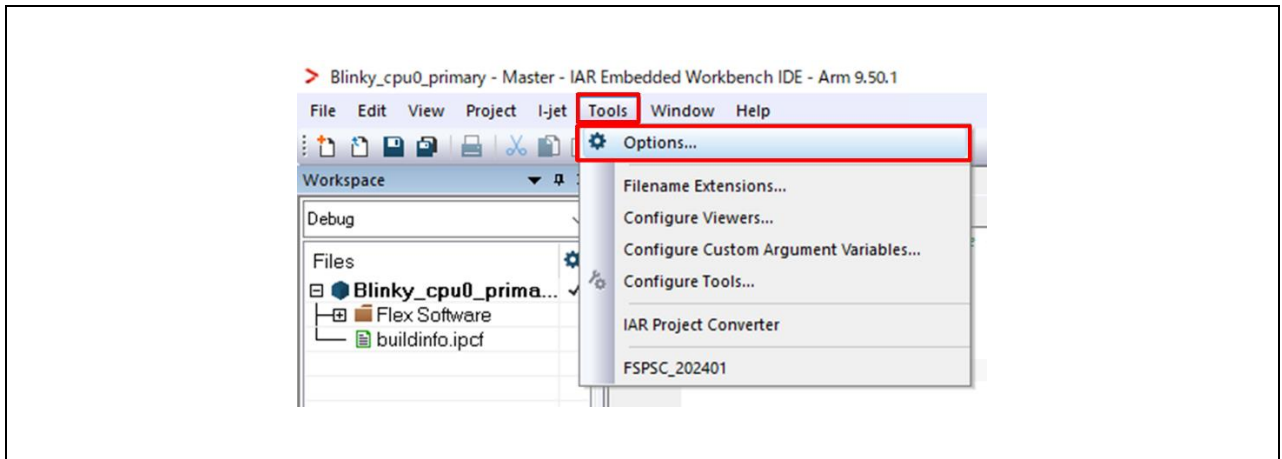


Figure 55 IAR EWARM project options for the primary project (Tool menu)

viii) Click **Project.**

ix) Select **Never** as **Make before debugging** and click **OK.**

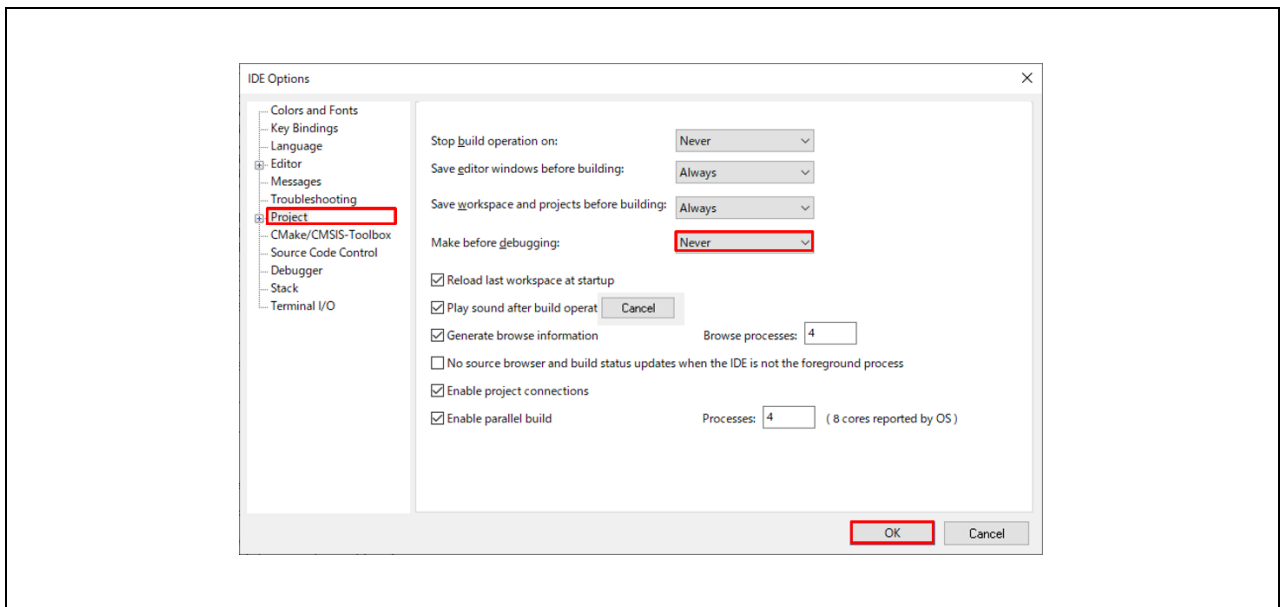


Figure 56 IAR EWARM project options for the primary project (debug)

x) Proceed to 4.4.1 Build.

5.3.3.2 Build

Click on **Project** -> **Make** from menu bar or **Make** button on tool bar to build.

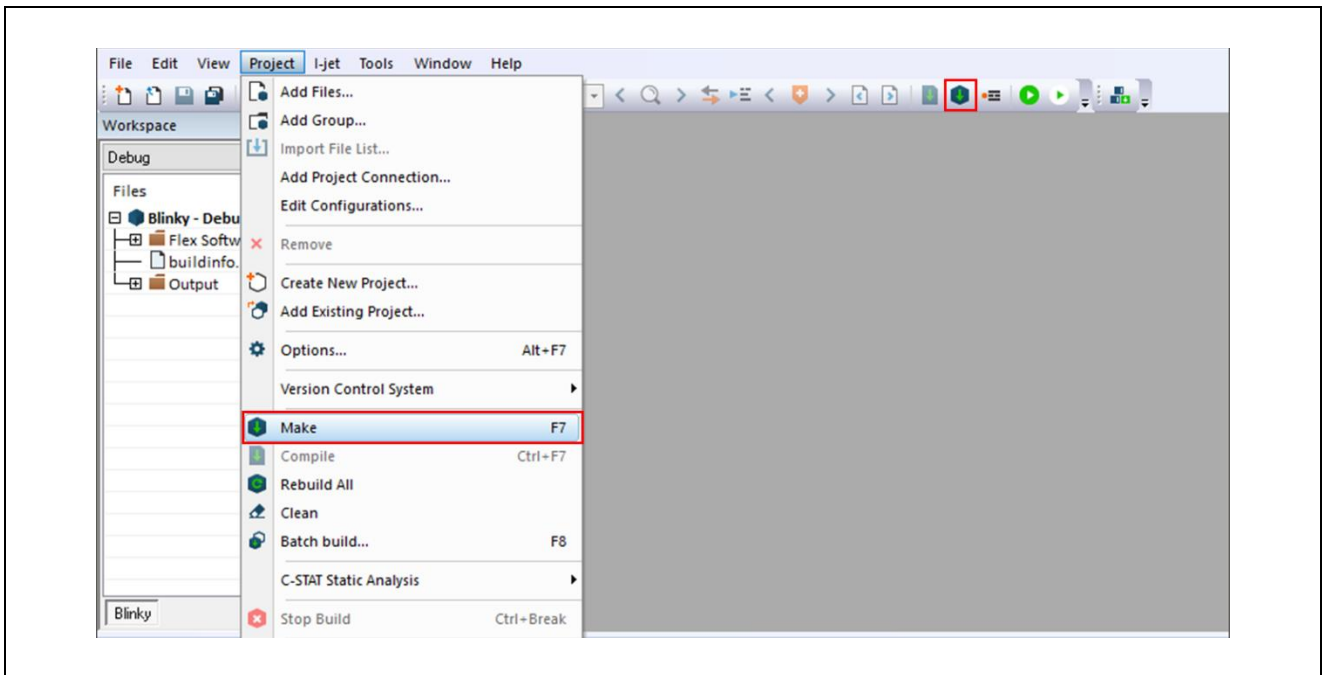


Figure 57 : Make Button

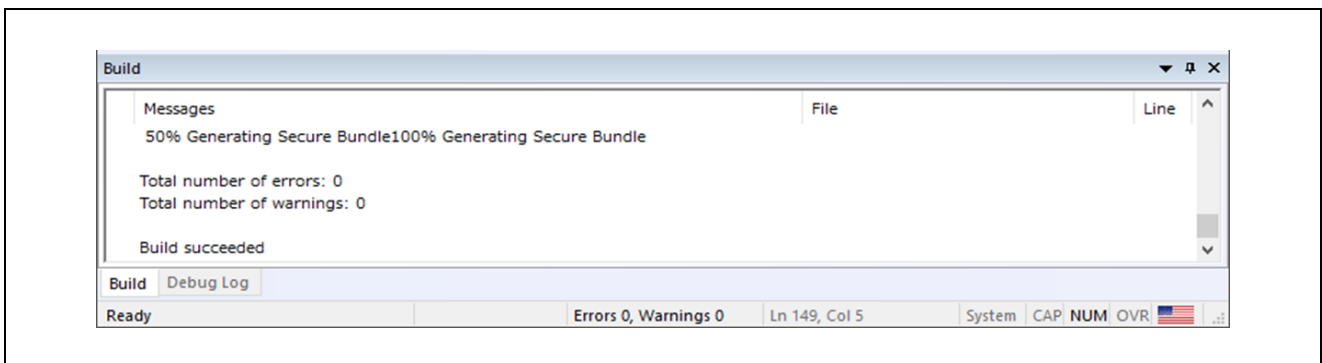


Figure 58 : Build Message Console

Once the build is completed, the build message is displayed in the Build Console window that displays compilation target files and the number of error/warnings.

5.3.4 Download & Debug the Project

When multiprocessing, please refer to Section.5.3.5 Debug for Multiprocessing

Click on **Project** -> **Download and debug** from menu bar or **Download and Debug** button on tool bar to download and debug.

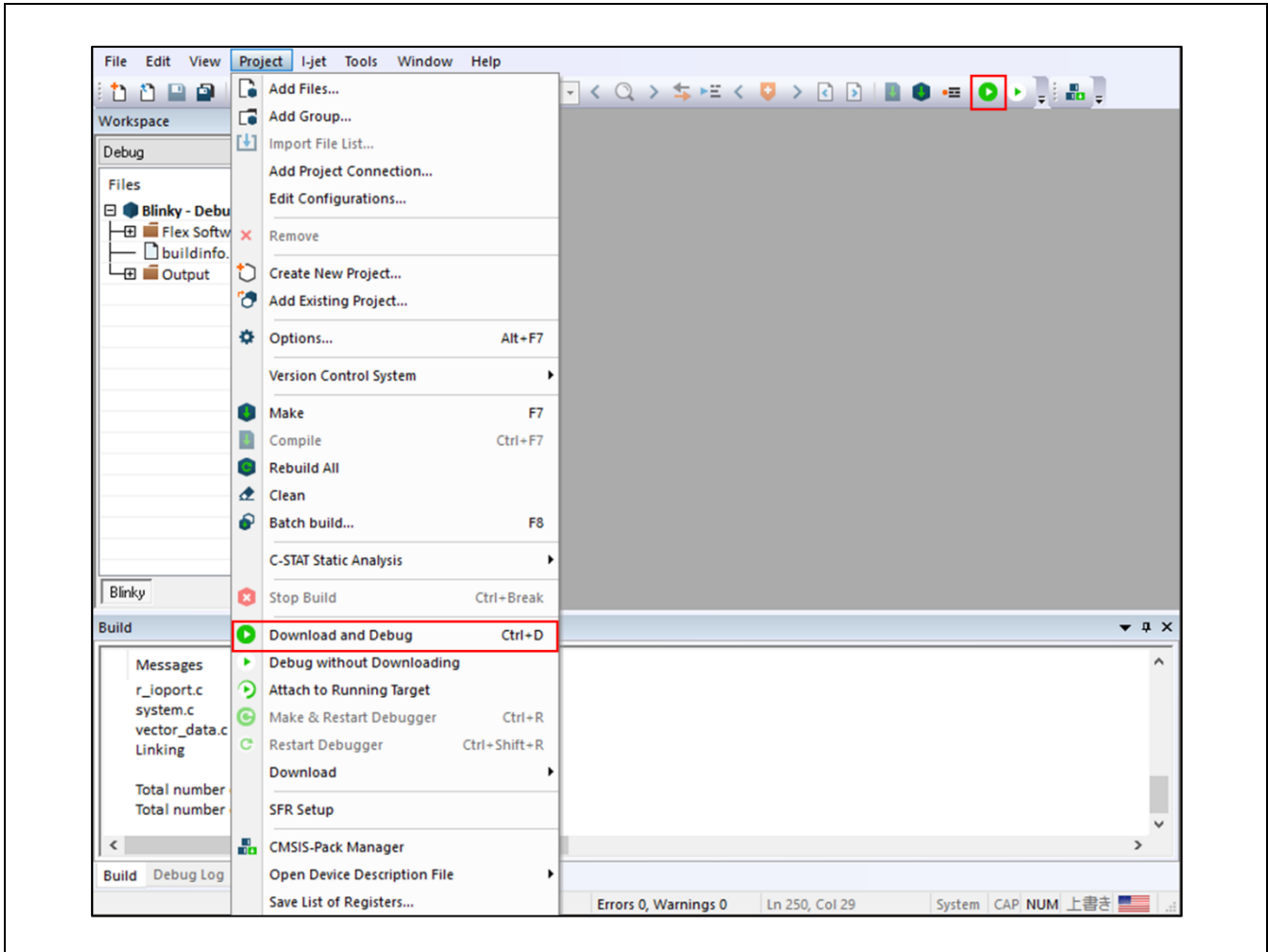


Figure 59 : Download and Debug Button

(Continued on next page)

Once the download is completed and the debug is started, the program breaks at the beginning of **main** in **main.c**.

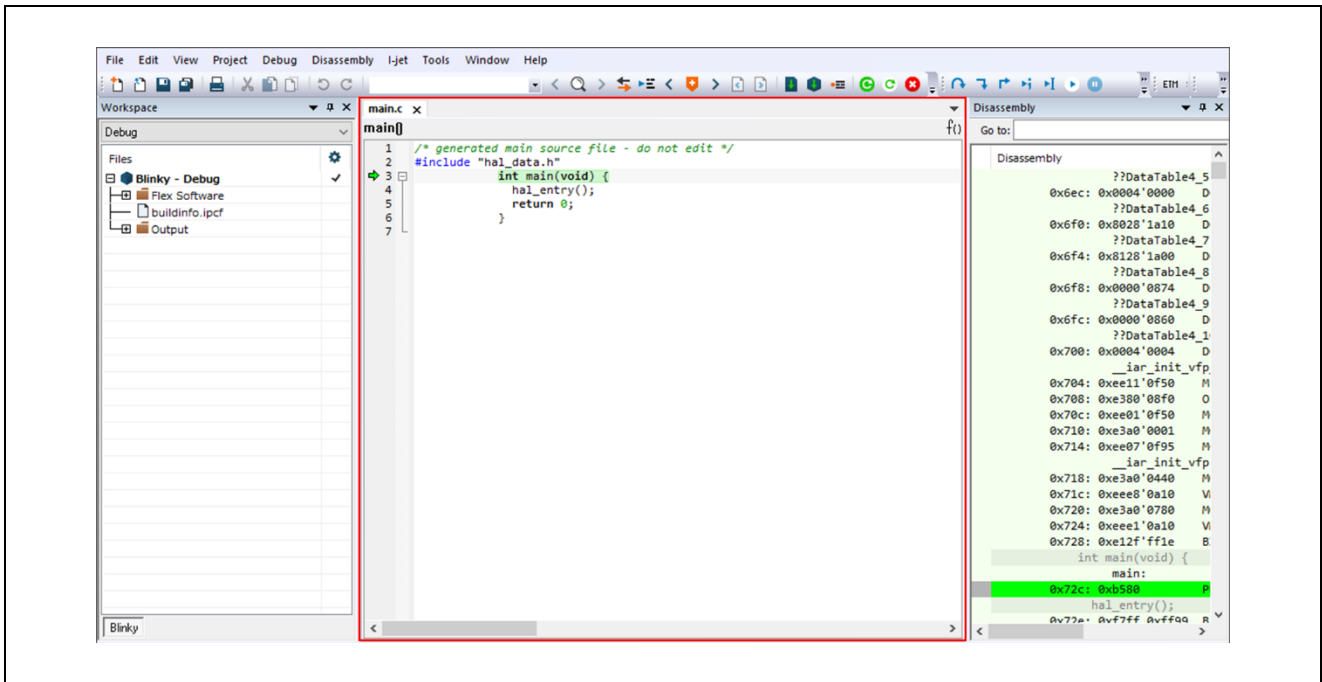


Figure 60 : Starting Debug

Click on **Debug->Go** from menu bar or **Go** button on tool bar to run this program.

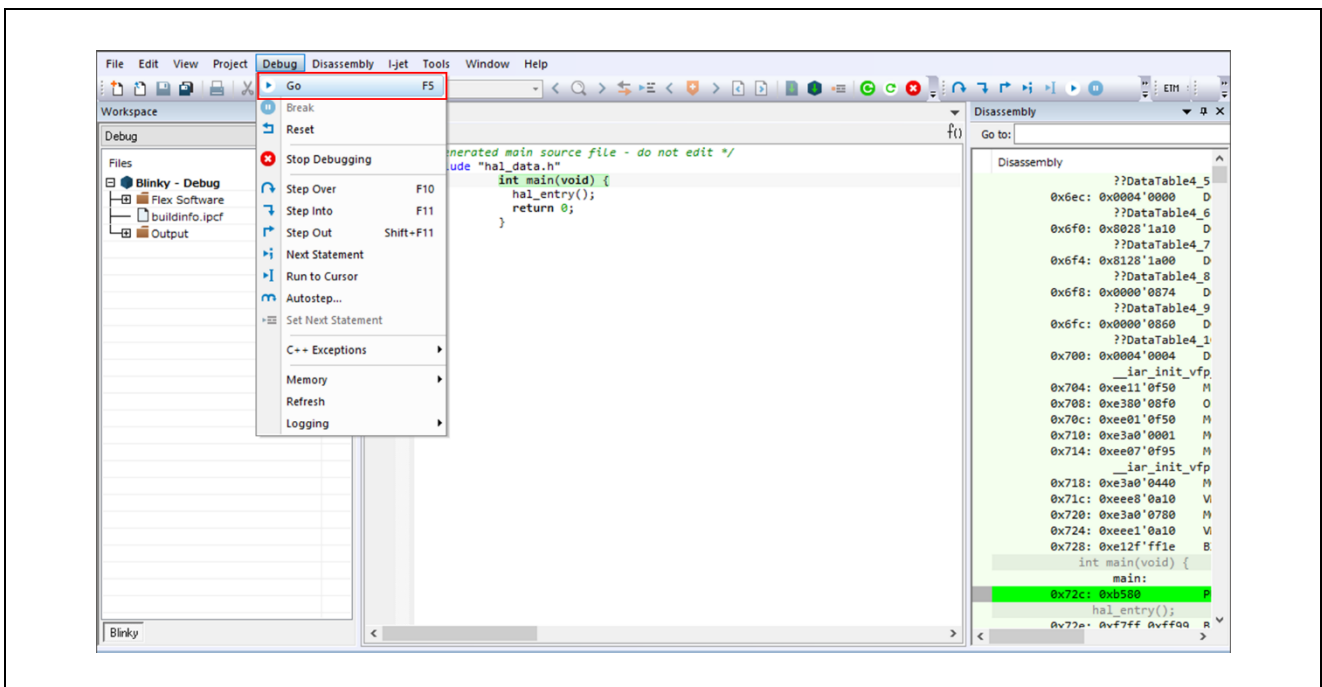


Figure 61 : Go Button

(Continued on next page)

The blinky application is stored in the **hal_entry.c** file. This file is generated by FSP SC when you select the Blinky Project template and is located in the project's src/ folder. In IAR EWARM workspace view, the **hal_entry.c** is registered **Flex Software > Program Entry**.

The application performs the following steps:

1. Get the LED information for the selected board by **bsp_leds_t** structure.
2. Initialize output level for LED pin to LOW using **R_BSP_PinClear((bsp_io_region_t) leds.p_leds[i][1], (bsp_io_port_pin_t) leds.p_leds[i][0])**.
3. Use **R_BSP_PinToggle((bsp_io_region_t) leds.p_leds[i][1], (bsp_io_port_pin_t) leds.p_leds[i][0])** to set the output level to the LED pin.
4. **R_BSP_SoftwareDelay(delay, bsp_delay_units)** waits for a certain period of time. Then run #3 again.

On debugging on IAR EWARM, the break point can be set by click the left space next to line number.

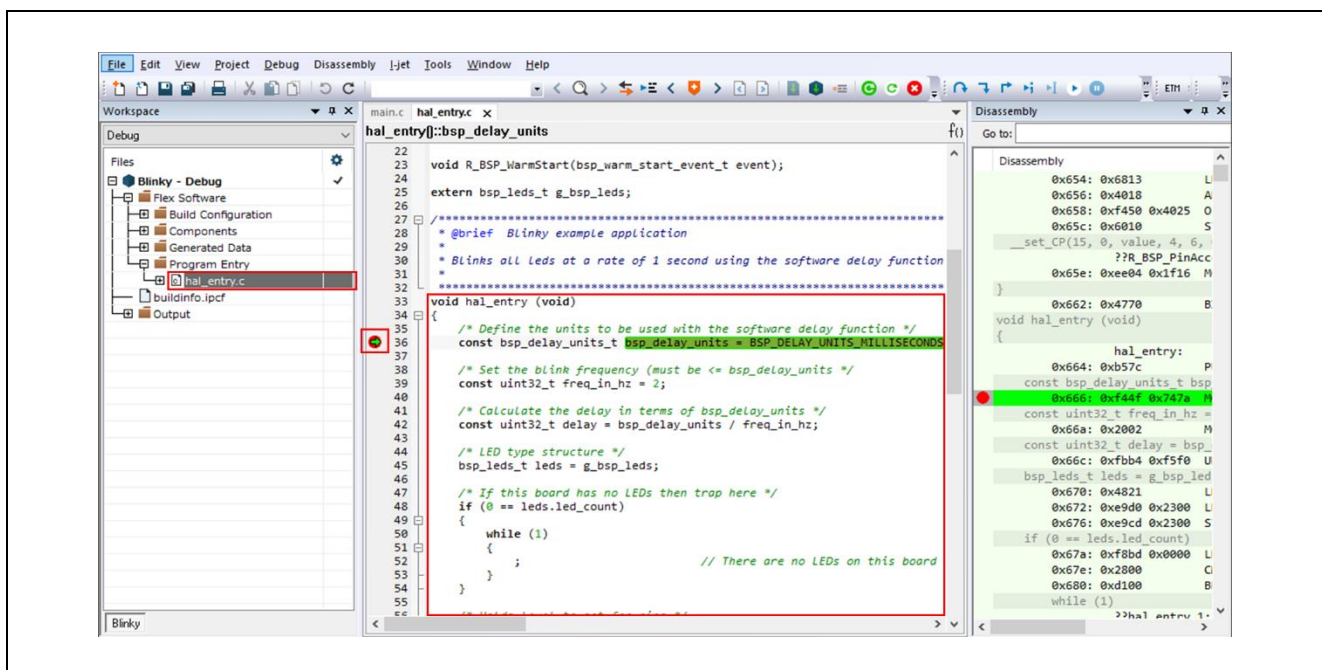


Figure 62 : hal_entry.c and Setting Breakpoint

(Continued on next page)

By using the break point and the **Debug** menu or **Debug** tool bar, you can check the behavior of the Blinky application step by step.

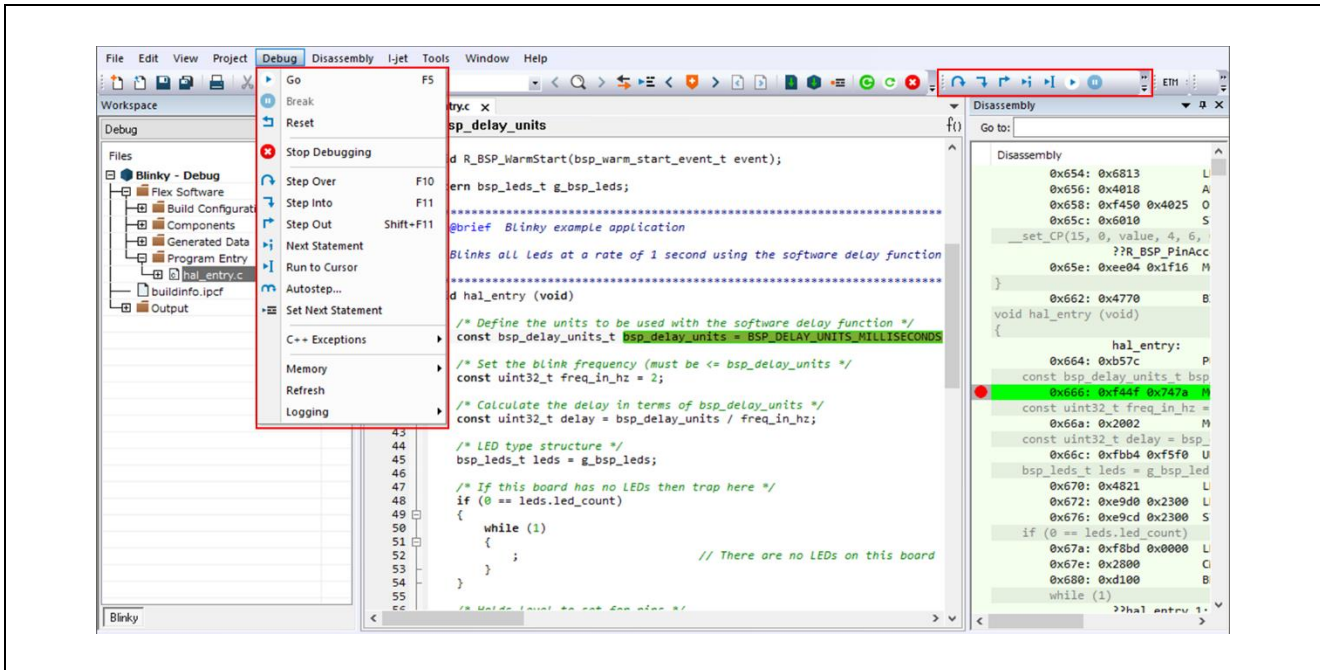


Figure 63 : Debug Menu

When clicking **Go** button, the following LEDs on the board should now be blinking.

- RZ/T series
 - RSK+RZ/T2M: LED0-1 (CPU0), LED2-3 (CPU1)
 - RSK+RZ/T2L: LED0-6 (including LED_x_ESC_xxx)
 - RSK+RZ/T2ME: LED0-1 (CPU0), LED2-3 (CPU1)
- RZ/N series
 - RSK+RZ/N2L: LED0-3

To suspend program execution, click **Debug** > **Break** or click on the **Pause** icon.



Figure 64 IAR EWARM Debugger Pause Icon

(Continued on next page)

To exit Debug and disconnect from the debugger, click **Debug > Stop Debugging** or click on the **Stop** icon.



Figure 65 IAR EWARM Debugger Stop Icon

5.3.5 Debug for Multiprocessing

To debug the Blinky application of multiprocessing, follow these steps:

1. Open the primary project and close the secondary project on IAR EWARM.
2. Download of the primary project with procedure 5.3.4 Download & Debug the Project as shown in Figure 59.
3. The secondary project is automatically launched.
4. Run the program of primary project as shown in Figure 61. If the LED0 and LED1 are blinking, proceed to the next step.
5. The primary project in operation, run the program of secondary project.
6. When exiting Debug and disconnect from the debugger, if debugging is stopped in one of the projects, either the primary or the secondary, the other will automatically stop as well.

5.4 Re-configuring Project with FSP SC

For proceeding the tutorial with Blinky project, the FSP configuration steps of the Blinky project was skipped in this chapter. The FSP SC can be launched from IAR EWARM or command prompt, and the FSP project configuration can be re-configured by FSP SC.

There are two ways to launch FSP Smart Configurator with an existing project.

5.4.1 Launch FSP Smart Configurator from IAR EWARM

1. Select “Tools -> Configure Tools...”
2. Select “New” and fill in the fields as follows:
 - Menu Text FSP Smart Configurator
 - Command \$RASC_EXE_PATH\$
 - Argument --compiler IAR configuration.xml
 - Initial Directory \$PROJ_DIR\$

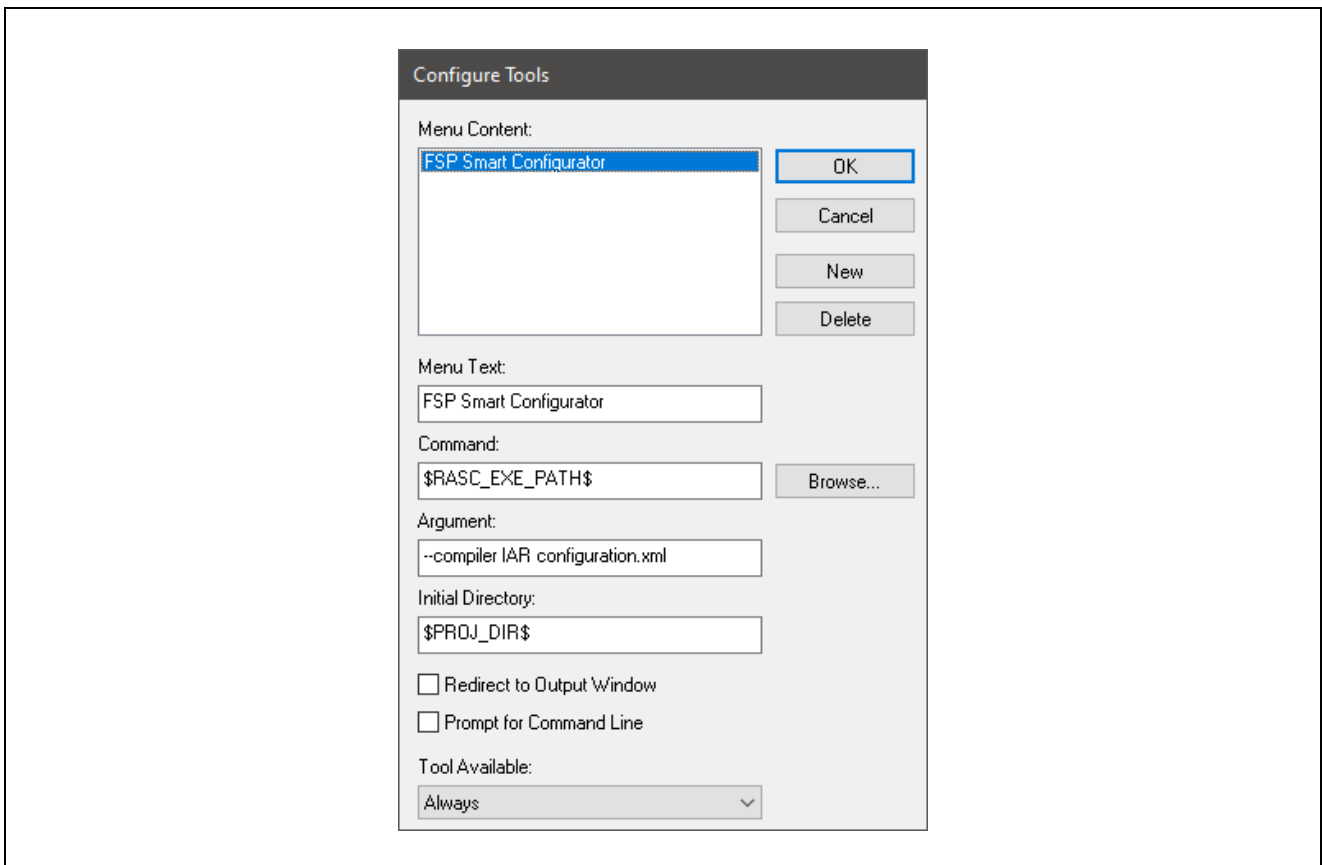


Figure 66 : Settings to Launch FSP SC from IAR EWARM

5.4.2 Launch from the Command Prompt.

1. Open command prompt window.
2. Move to the folder where the created project is located.
3. Execute the following command.
 - {FSP Smart Configurator installation folder} \ eclipse \ rasc.exe --compiler IAR configuration.xml

5.5 Note when debugging in different workspaces

The project created, built, and debugged in chapters 5.3.2 through 5.3.5 can be run in other workspaces. When debugging in the other workspace, please note the following two points:

- Apply the same version of FSP package used for the project to the FSP SC.
- The project must be clicked the **Generate Project Content** button and built before debugging.

6. FSP Configuration Users Guide

6.1 What is a Project?

In e² studio, all FSP applications are organized in RZ/T2, RZ/N2 MPU projects. Setting up an RZ/T2, RZ/N2 MPU project involves:

1. **Create a Project**
2. **Configuring a Project**

These steps are described in detail in the next two sections. When you have existing projects already, after you launch e² studio and select a workspace, all projects previously saved in the selected workspace are loaded and displayed in the **Project Explorer** window. Each project has an associated configuration file named configuration.xml, which is located in the project's root directory.

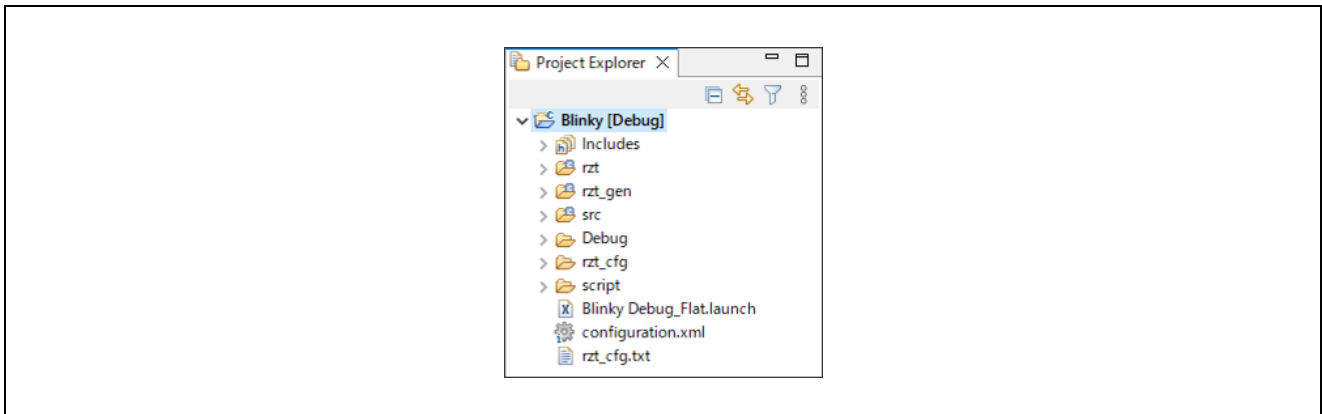


Figure 67 : e² studio Project Configuration File

Double-click on the configuration.xml file to open the RZ/T2, RZ/N2 MPU Project Editor. To edit the project configuration, make sure that the **FSP Configuration** perspective is selected in the upper right-hand corner of the e² studio window. Once selected, you can use the editor to view or modify the configuration settings associated with this project.

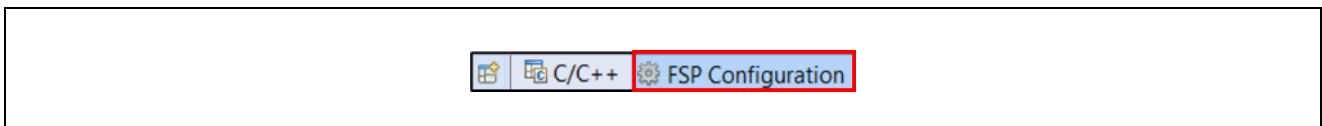


Figure 68 : e² studio FSP Configuration Perspective

(Continued on next page)

Note:

Whenever the RZ/T2, RZ/N2 project configuration (that is, the configuration.xml file) is saved after configuring the project, a verbose RZ/T2, RZ/N2 Project Report file (rzt_cfg.txt, or rzn_cfg.txt) with all the project settings is generated. The format allows differences to be easily viewed using a text comparison tool. The generated file is located in the project root directory.

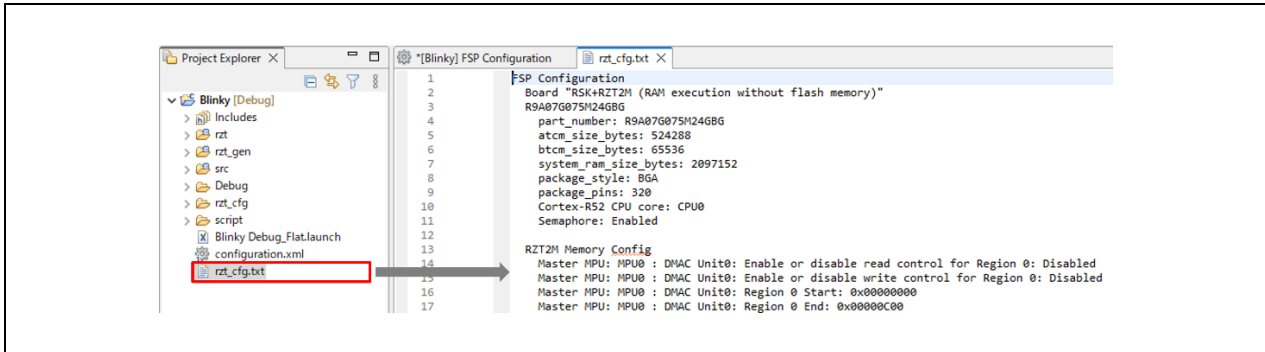


Figure 69 : RZ/T2, RZ/N2 Project Report

The RZ/T2, RZ/N2 Project Editor has several tabs. The configuration steps and options for individual tabs are discussed in the following sections.

Note:

The tabs available in the RZ/T2, RZ/N2 Project Editor depend on the e² studio version and the layout may vary slightly, however the functionality should be easy to follow.

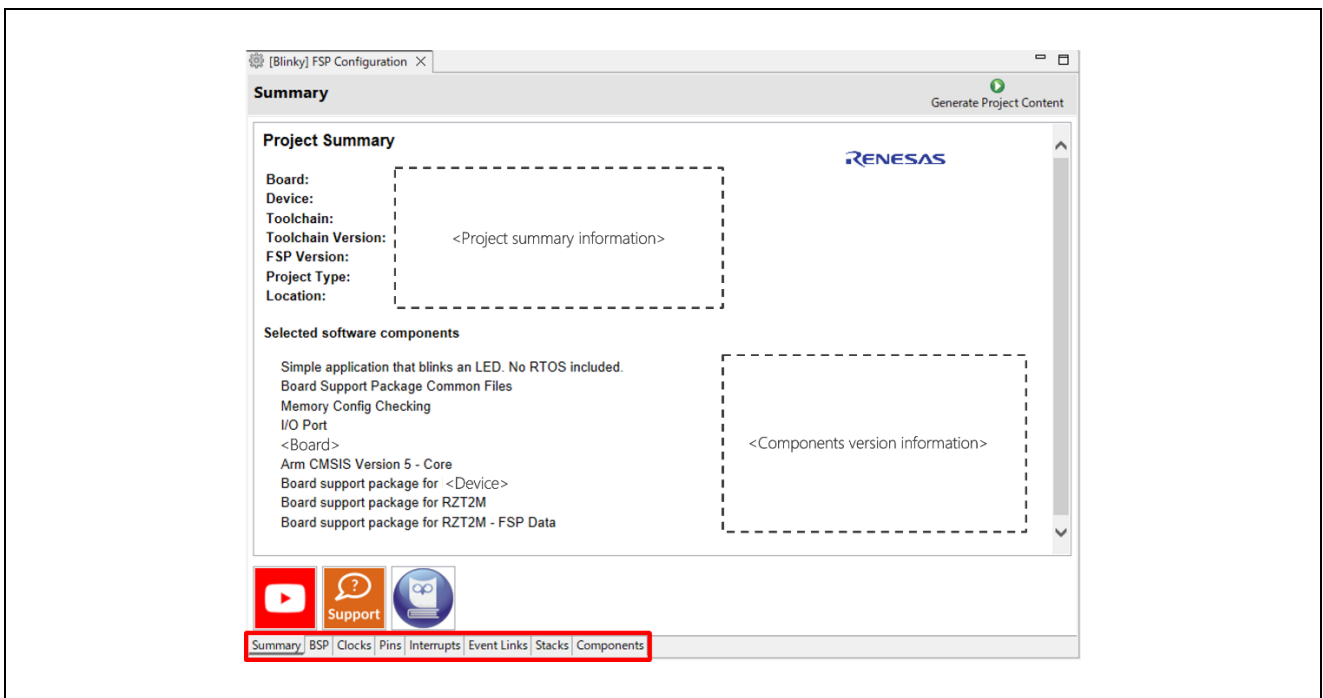


Figure 70 : RZ/T2, RZ/N2 Project Editor Tabs

6.2 Create a Project

6.2.1 Creating a New Project

For RZ/T2, RZ/N2 MPU applications, generate a new project using the following steps:

1. Click on File > New > C/C++ Project.

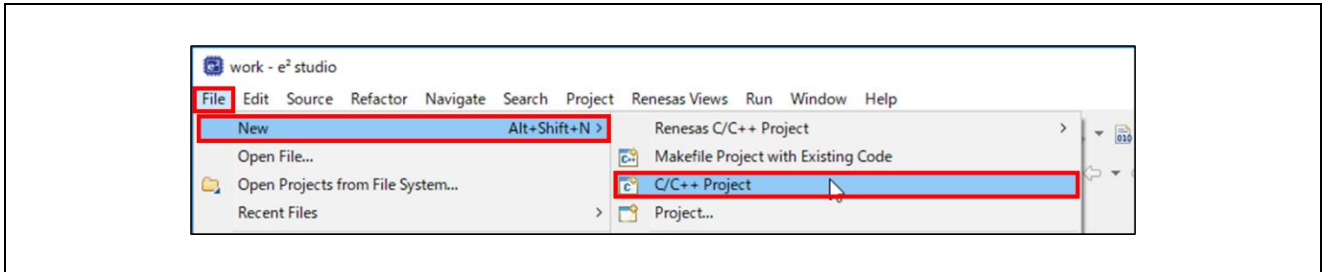


Figure 71 : New RZ/T2, RZ/N2 MPU Project

2. Then click on the **Renesas RZ/T C/C++ FSP Project** template for the type of project you are creating.

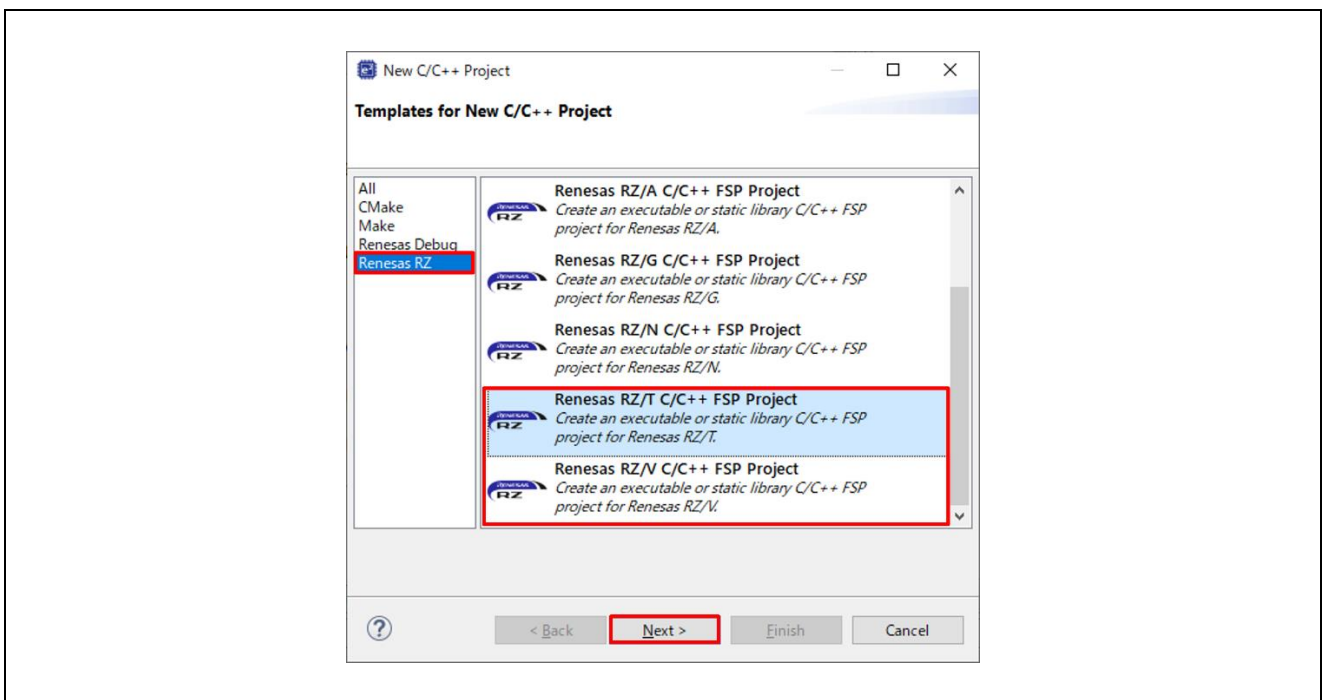


Figure 72 : New Project Templates

(Continued on next page)

- 3. Select a project name and location.
- 4. Click Next.

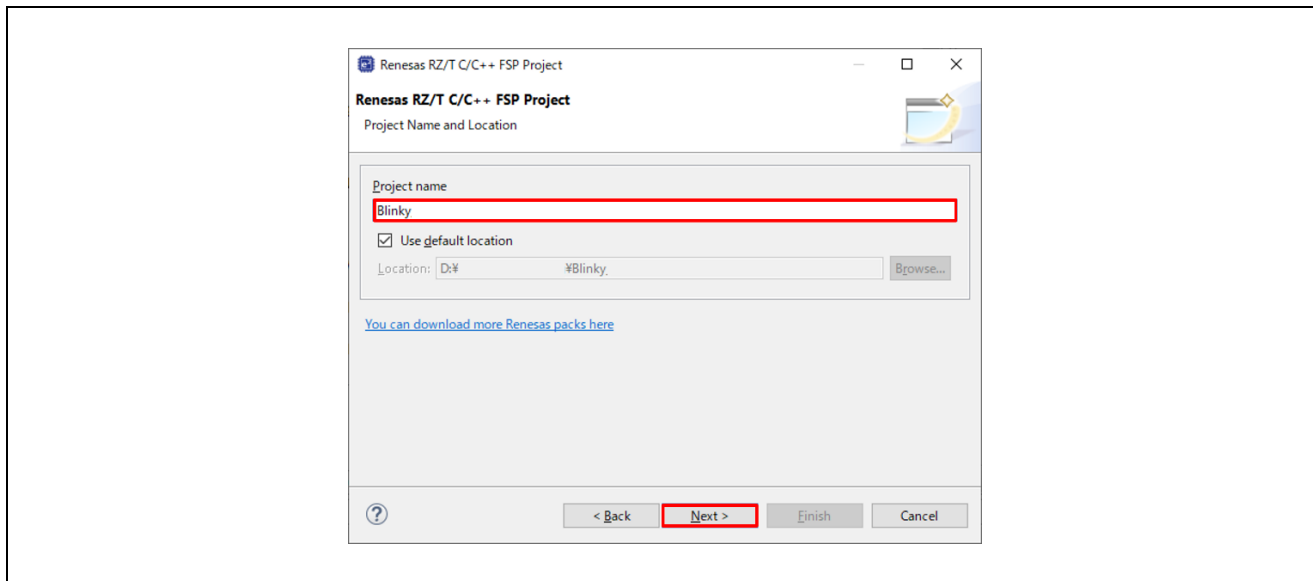


Figure 73 : RZ/T2, RZ/N2 MPU Project Generator (Part 1)

6.2.2 Selecting a Board and Toolchain

In the Project Configuration window select the hardware and software environment:

1. Select the **FSP version**.
2. Select the **Board** and **Device** for your application.

Note:

You can select an existing RZ/T2, RZ/N2 MPU Evaluation Kit (Such as RSK) or can select **Custom User Board** for any of the RZ/T2, RZ/N2 MPU devices with your own BSP definition.

When you use the RZ/T2, RZ/N2 MPU Evaluation Kit,

- First, please set the **Board** to the Evaluation Kit and the boot mode which you use.
- In this case, please don't change the **Device** which is automatically set to the device which RSK board uses.

When you use **Custom User Board**,

- First, please set the **Device** to your device on your board.
- Second, please set the Board to **Custom User Board** with the boot mode which you use.

3. The **Toolchain** selection defaults to **GNU Arm Embedded**.
 - Select the **Toolchain version**.
4. This should default to the installed toolchain version.
 - Select the **Debugger**.
5. The J-Link Arm Debugger is preselected.
6. Click **Next**.

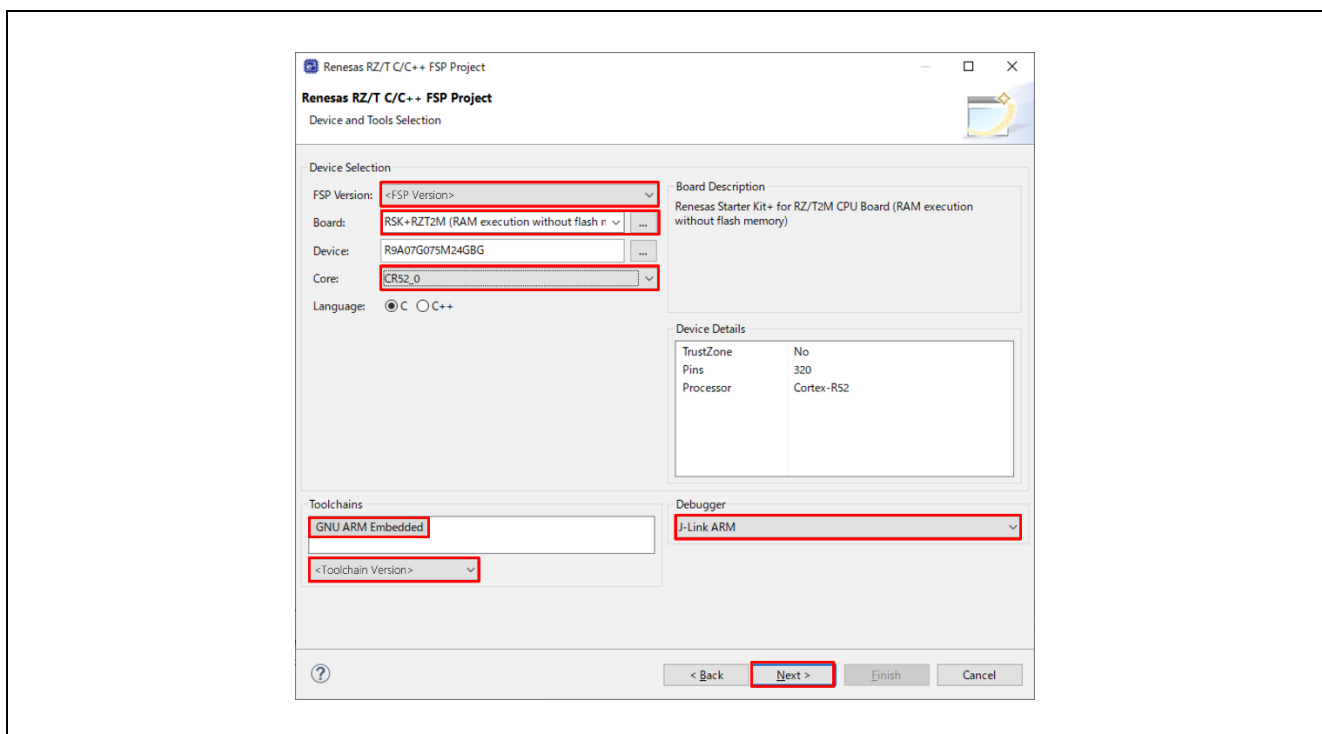


Figure 74 : RZ/T2, RZ/N2 MPU Project Generator (Part 2)

6.2.3 Selecting a Project Template

In the next window, select the build artifact and RTOS.

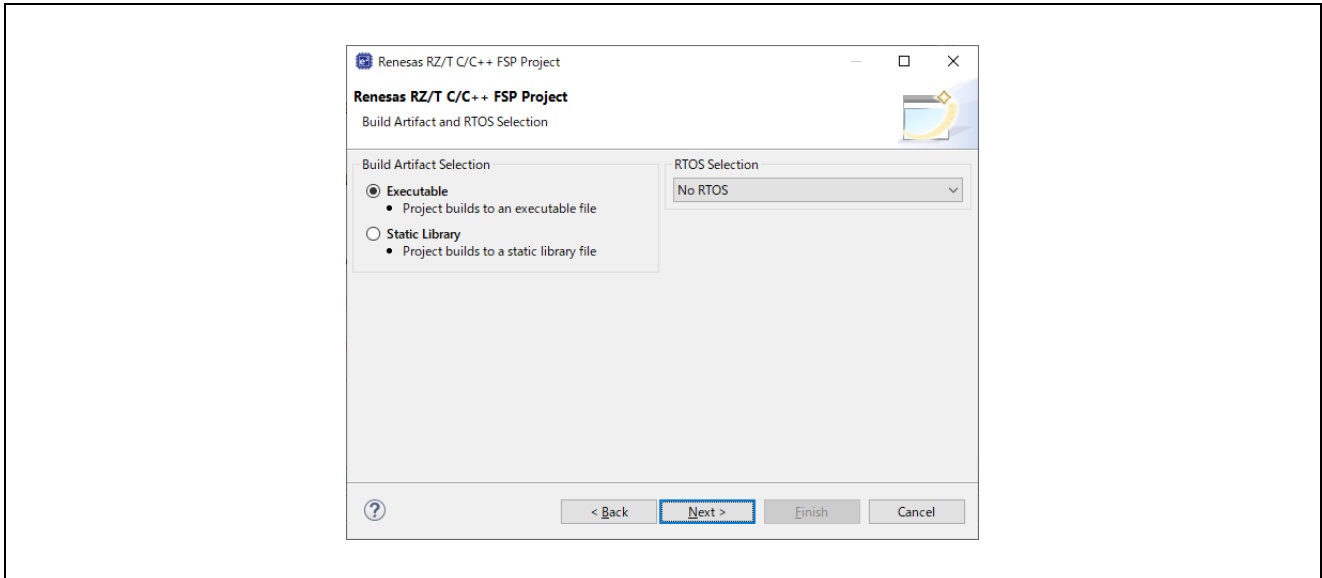


Figure 75 : RZ/T2, RZ/N2 MPU Project Generator (Part 3)

In the next window, select a project template from the list of available templates. By default, this screen shows the templates that are included in your current RZ/T2, RZ/N2 MPU Pack. Once you have selected the appropriate template, click **Finish**.

Note:

If you want to develop your own application, select the basic template for your board, **Bare Metal – Minimal**.

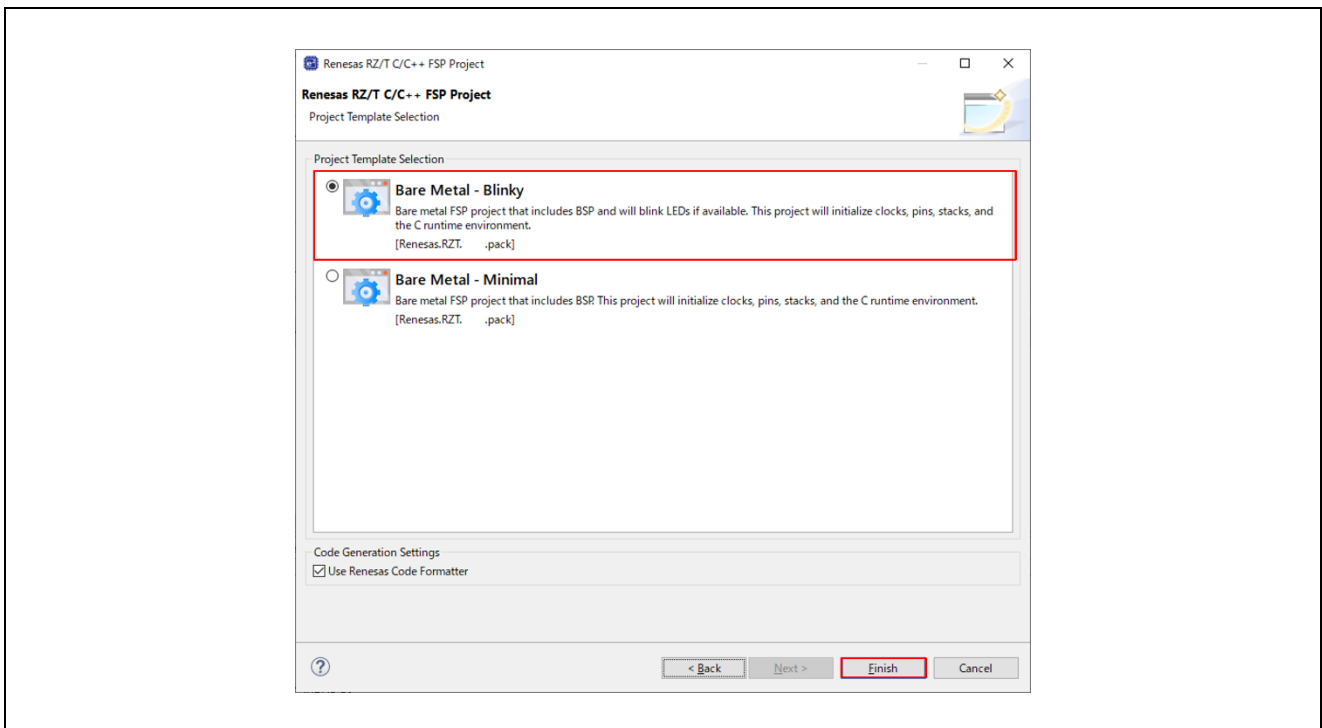


Figure 76 : RZ/T2, RZ/N2 MPU Project Generator (Part 4)

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When the project is created, e² studio displays a summary of the current project configuration in the RZ/T2, RZ/N2 MPU Project Editor.

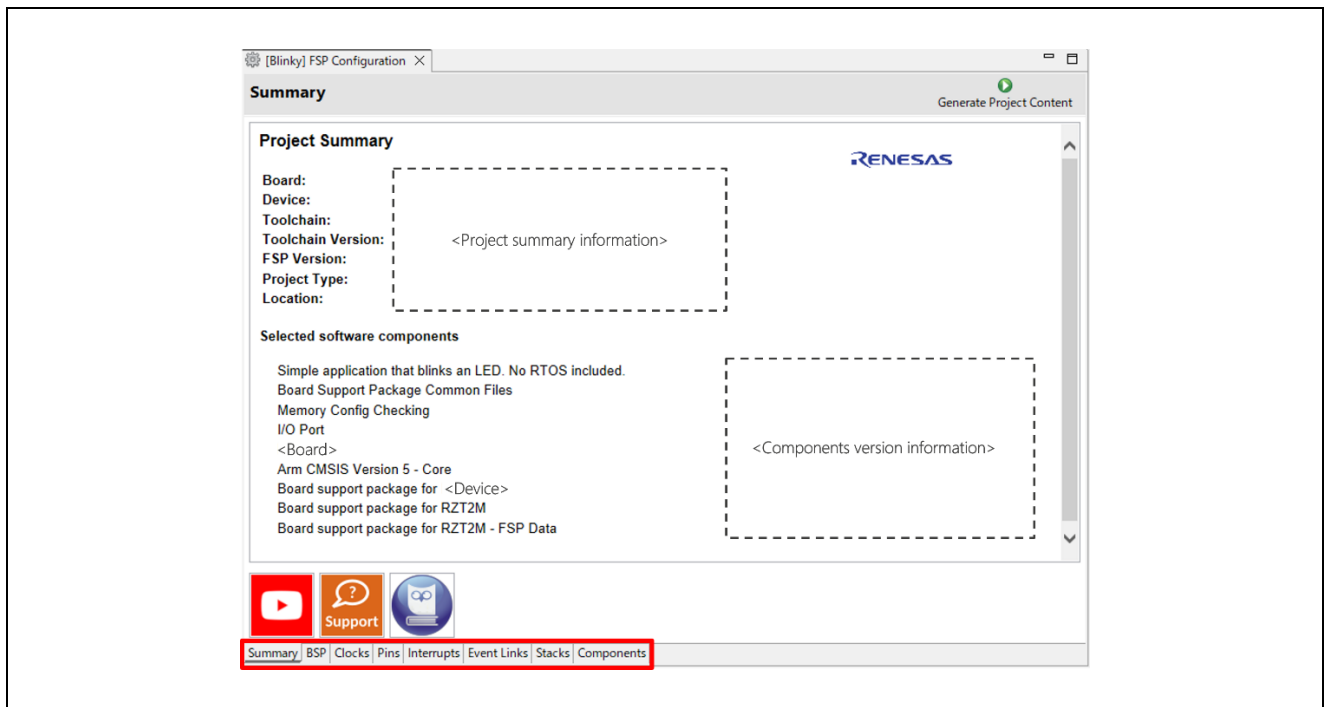


Figure 77 : RZ/T2, RZ/N2 MPU Project Editor and Available Editor Tabs

On the bottom of the RZ/T2, RZ/N2 MPU Project Editor view, you can find the tabs for configuring multiple aspects of your project:

- With the **Summary** tab, you can see all they key characteristics of the project: board, device, toolchain, and more.
- With the **BSP** tab, you can change board specific parameters from the initial project selection.
- With the **Clocks** tab, you can configure the MPU clock settings for your project.
- With the **Pins** tab, you can configure the electrical characteristics and functions of each port pin.
- With the **Interrupts** tab, you can add new user events/interrupts.
- With the **Event Links** tab, you can configure events used by the Event Link Controller.
- With the **Stacks** tab, you can add and configure FSP modules. For each module selected in this tab, the **Properties** window provides access to the configuration parameters, interrupt selections.
- The **Components** tab provides an overview of the selected modules. Although you can also add drivers for specific FSP releases and application sample code here, this tab is normally only used for reference.

6.3 Configuring a Project

Each of the configurable elements in an FSP project can be edited using the appropriate tab in the RZ/T2, RZ/N2 Configuration editor window. Importantly, the initial configuration of the MPU after reset and before any user code is executed is set by the configuration settings in the **BSP** tab. When you select a project template during project creation, e² studio configures default values that are appropriate for the associated board. You can change those default values as needed. The following sections detail the process of configuring each of the project elements for each of the associated tabs.

6.3.1 Summary Tab

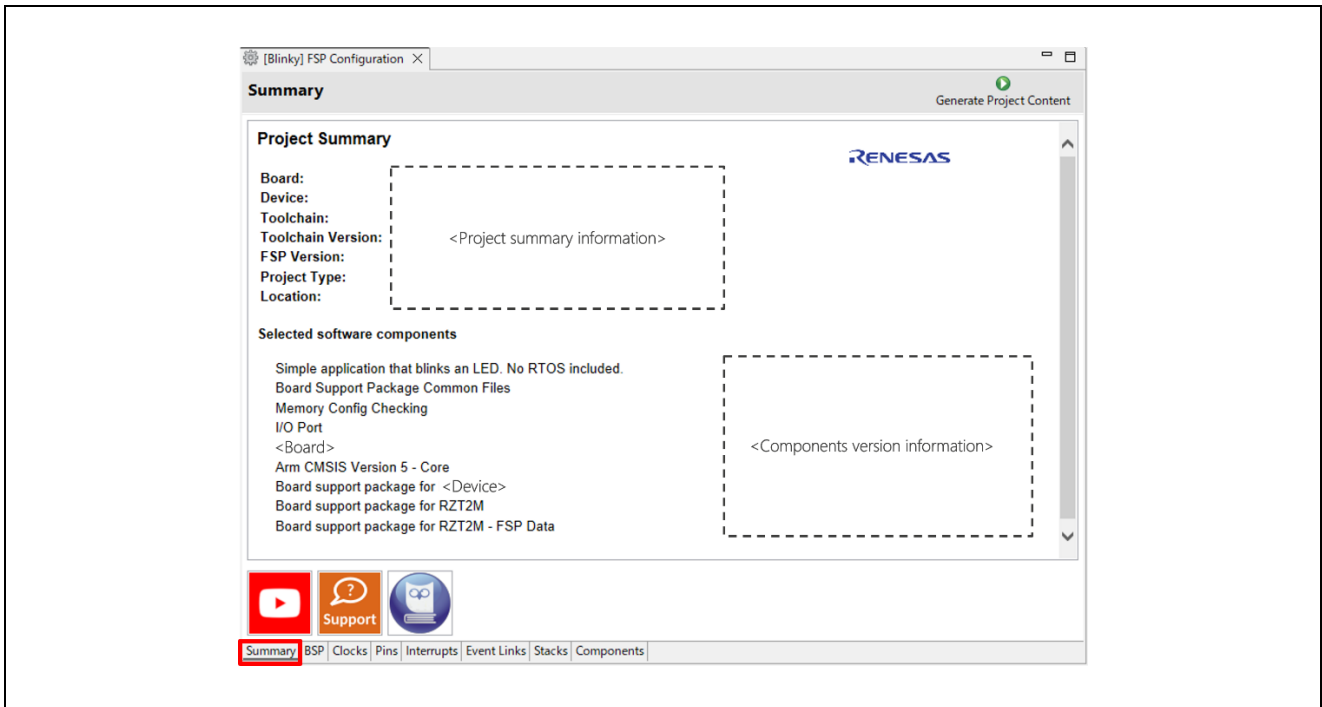


Figure 78 : Configuration Summary Tab

The **Summary** tab, seen in the above figure, identifies all the key elements and components of a project. It shows the target board, the device, toolchain and FSP version. Additionally, it provides a list of all the selected software components and modules used by the project. This is a more convenient summary view when compared to the **Components** tab.

6.3.2 Configuring the BSP

The **BSP** tab shows the currently selected board (if any) and device. The Properties view is located in the lower left of the Project Configurations view as shown below.

Note:

If the Properties view is not visible, click **Window > Show View > Properties** in the top menu bar.

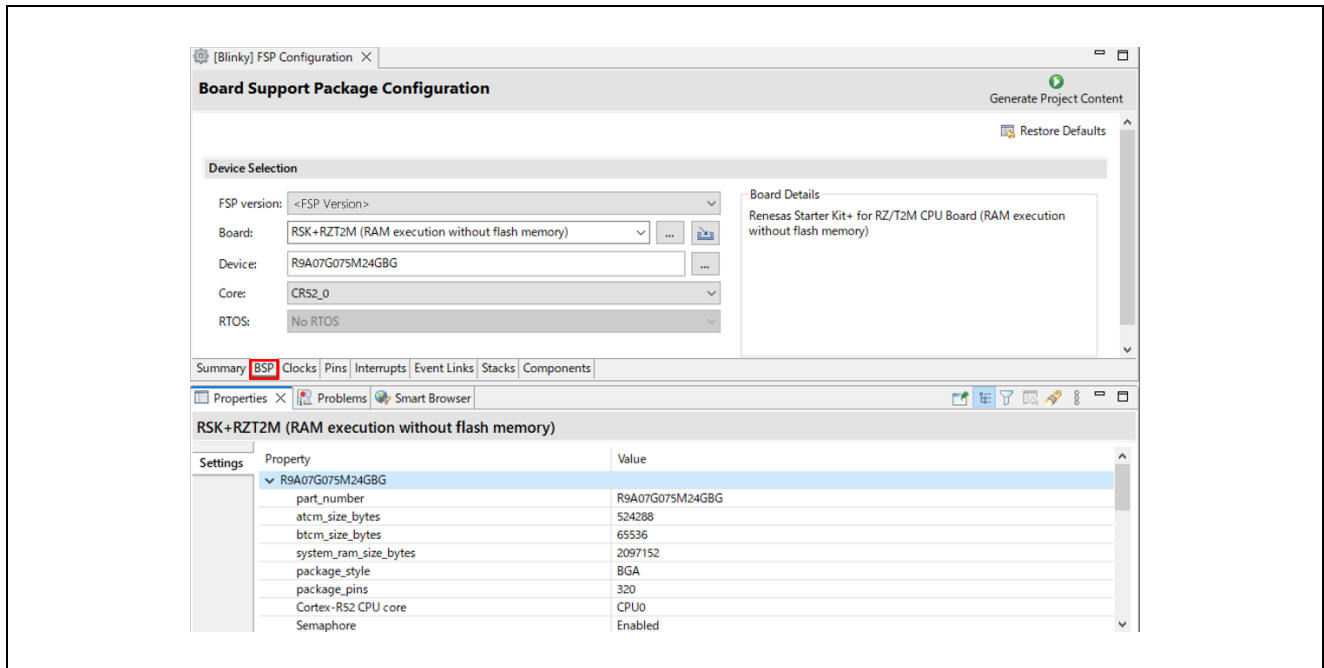


Figure 79 : Configuration BSP Tab

The **Properties** view shows the configurable options available for the BSP. These can be changed as required. The BSP is the FSP layer above the MPU hardware. e² studio checks the entry fields to flag invalid entries. For example, only valid numeric values can be entered for the stack size.

When you click the **Generate Project Content** button, the BSP configuration contents are written to:

- rzt_cfg/fsp_cfg/bsp/bsp_cfg.h, or
- rzn_cfg/fsp_cfg/bsp/bsp_cfg.h

This file is created if it does not already exist.

Warning:

Do not edit this file as it is overwritten whenever the Generate Project Content button is clicked.

6.3.3 Configuring Clocks

The Clocks tab presents a graphical view of the MPU's clock tree, allowing the various clock dividers and sources to be modified.

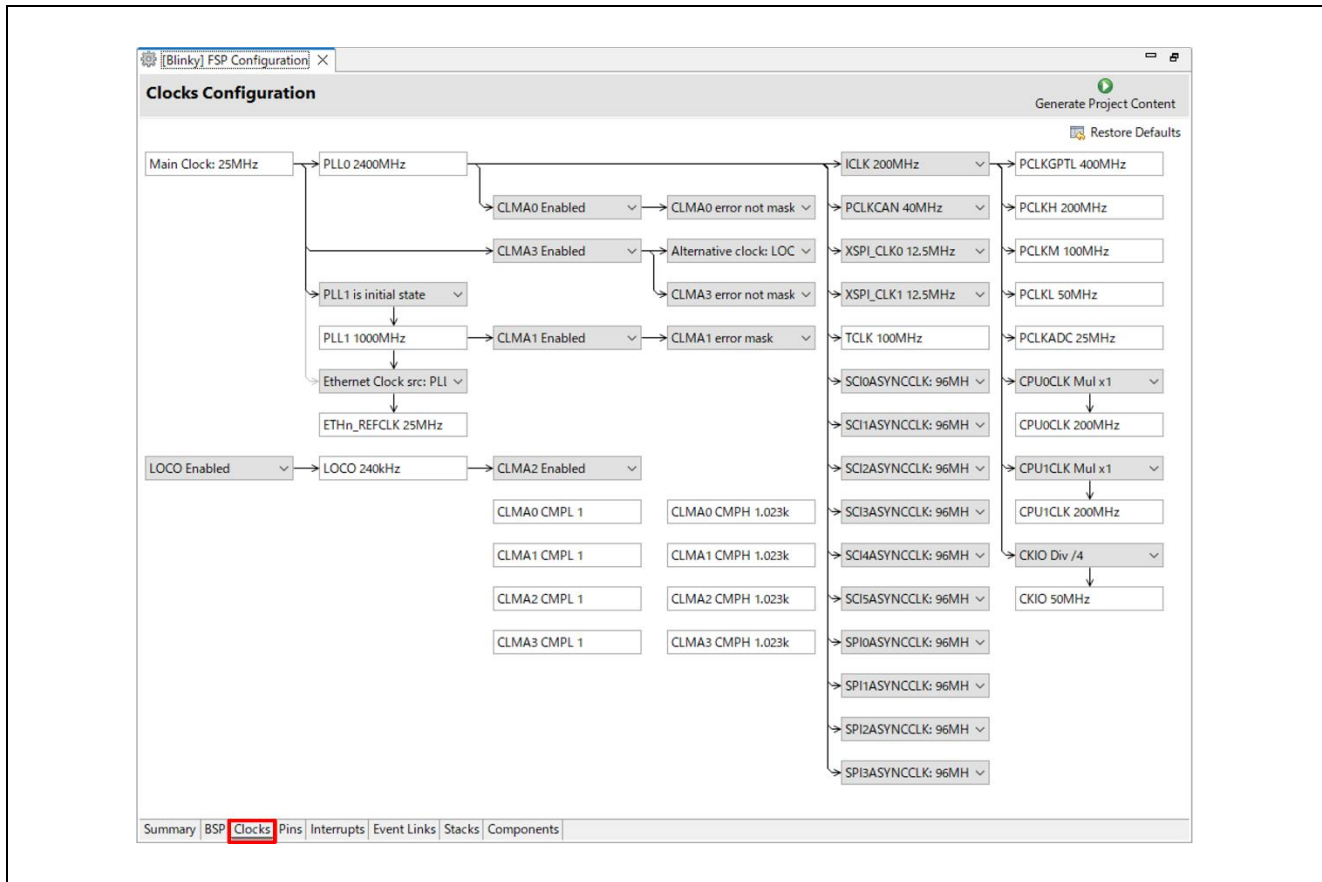


Figure 80 : Configuration Clocks Tab

When you click the Generate Project Content button, the clock configuration contents are written to:

- `rzt_gen/bsp_clock_cfg.h`, or
- `rzn_gen/bsp_clock_cfg.h`

This file will be created if it does not already exist.

Warning:

Do not edit this file as it is overwritten whenever the **Generate Project Content** button is clicked.

6.3.4 Configuring Pins

The **Pins** tab provides flexible configuration of the MPU's pins. As many pins are able to provide multiple functions, they can be configured on a peripheral basis. For example, selecting a serial channel via the SCI peripheral offers multiple options for the location of the receive and transmit pins for that module and channel. Once a pin is configured, it is shown as green in the **Package** view.

Note:

If the **Package** view window is not open in e² studio, select **Window > Show View > Pin Configurator > Package** from the top menu bar to open it.

The **Pins** tab simplifies the configuration of large packages with highly multiplexed pins by highlighting errors and presenting the options for each pin or for each peripheral. If you selected a project template for a specific board such as RSK+RZT2M, some peripherals connected on the board are preselected.

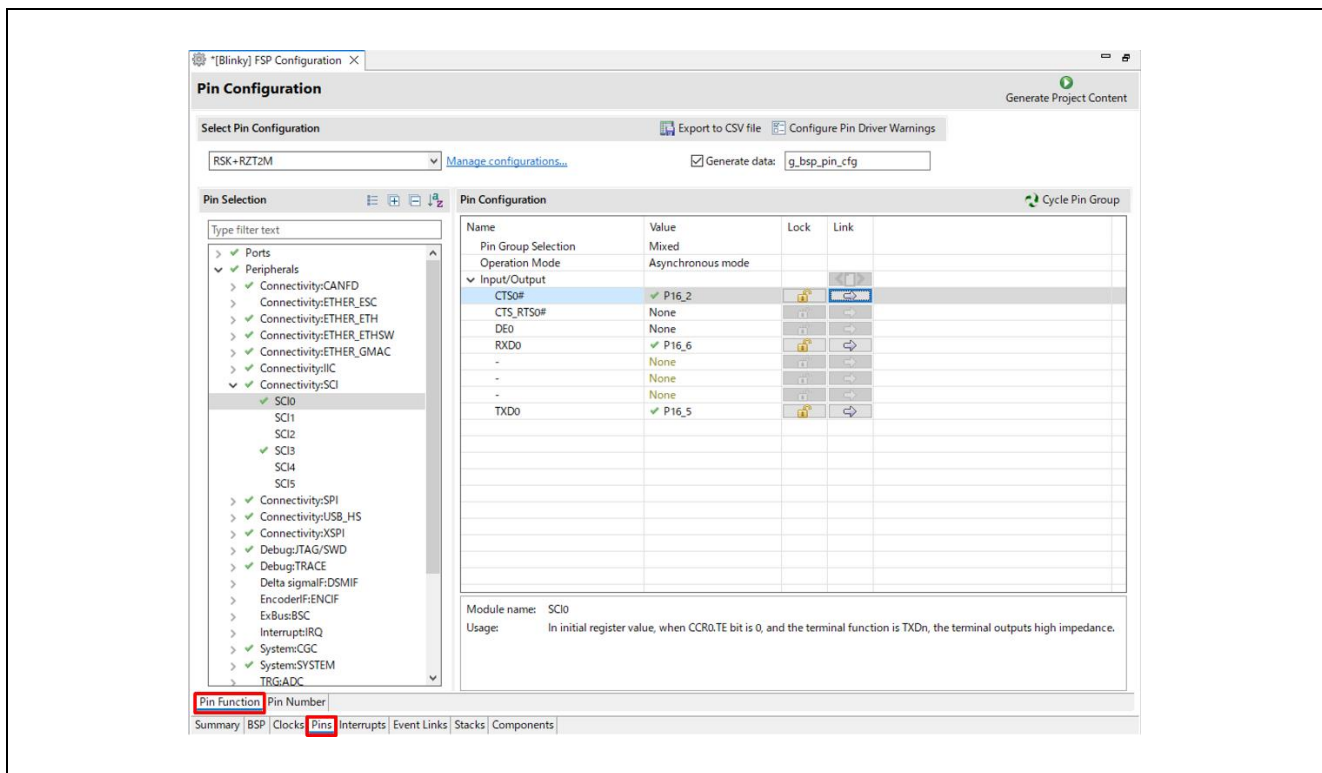


Figure 81: Pin Configuration

(Continued on next page)

The pin configurator includes a built-in conflict checker, so if the same pin is allocated to another peripheral or I/O function the pin will be shown as red in the package view and also with white cross in a red square in the **Pin Selection** pane and **Pin Configuration** pane in the main **Pins** tab. The **Pin Conflicts** view provides a list of conflicts, so conflicts can be quickly identified and fixed.

In the example shown below, port P162 is already used by the GPIO, and the attempt to connect this port to the Serial Communications Interface (SCI) results in a dangling connection error. To fix this error, select another port from the pin drop-down list or disable the GPIO in the **Pin Selection** pane on the left side of the tab.

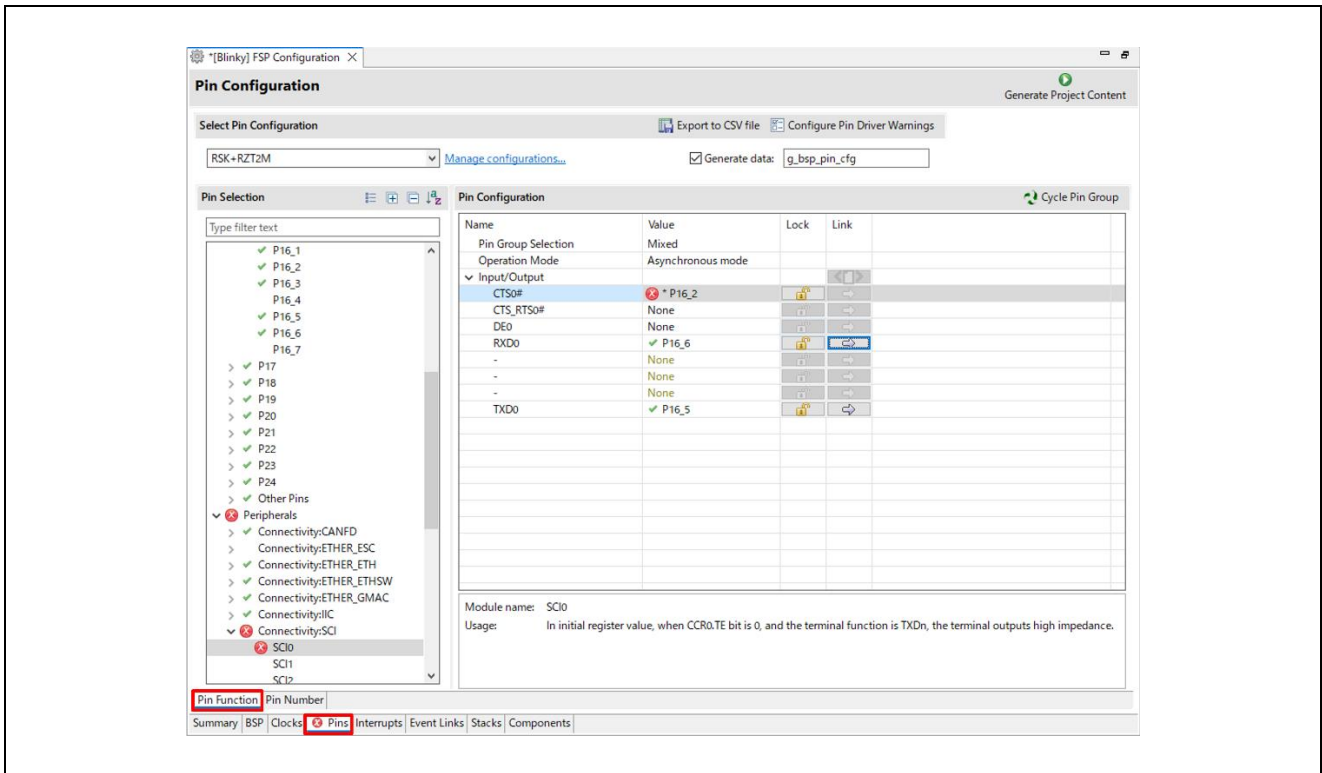


Figure 82: Conflict Checker in Pin Configuration

(Continued on next page)

The pin configurator also shows a package view and the selected electrical or functional characteristics of each pin.

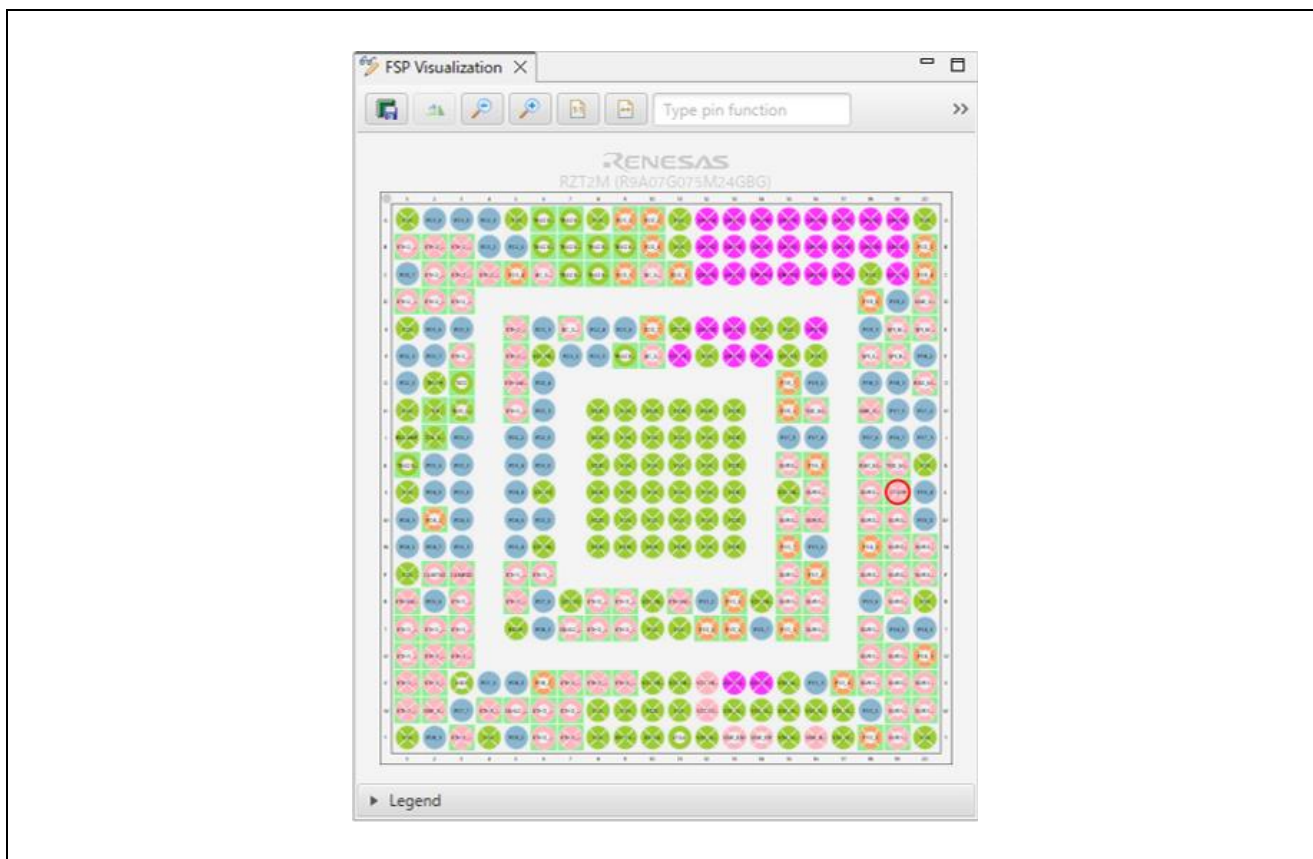


Figure 83: Pin Configurator Package View

When you click the **Generate Project Content** button, the pin configuration contents are written to:

- rzt_gen\bsp_pin_cfg.h, or
- rzn_gen\bsp_pin_cfg.h

This file will be created if it does not already exist.

Warning:

Do not edit this file as it is overwritten whenever the **Generate Project Content** button is clicked.

6.4 Configuring Interrupts from the Stacks Tab

You can use the **Properties** view in the **Stacks** tab to enable interrupts by setting the interrupt priority. Select the driver in the **Stacks** pane to view and edit its properties.

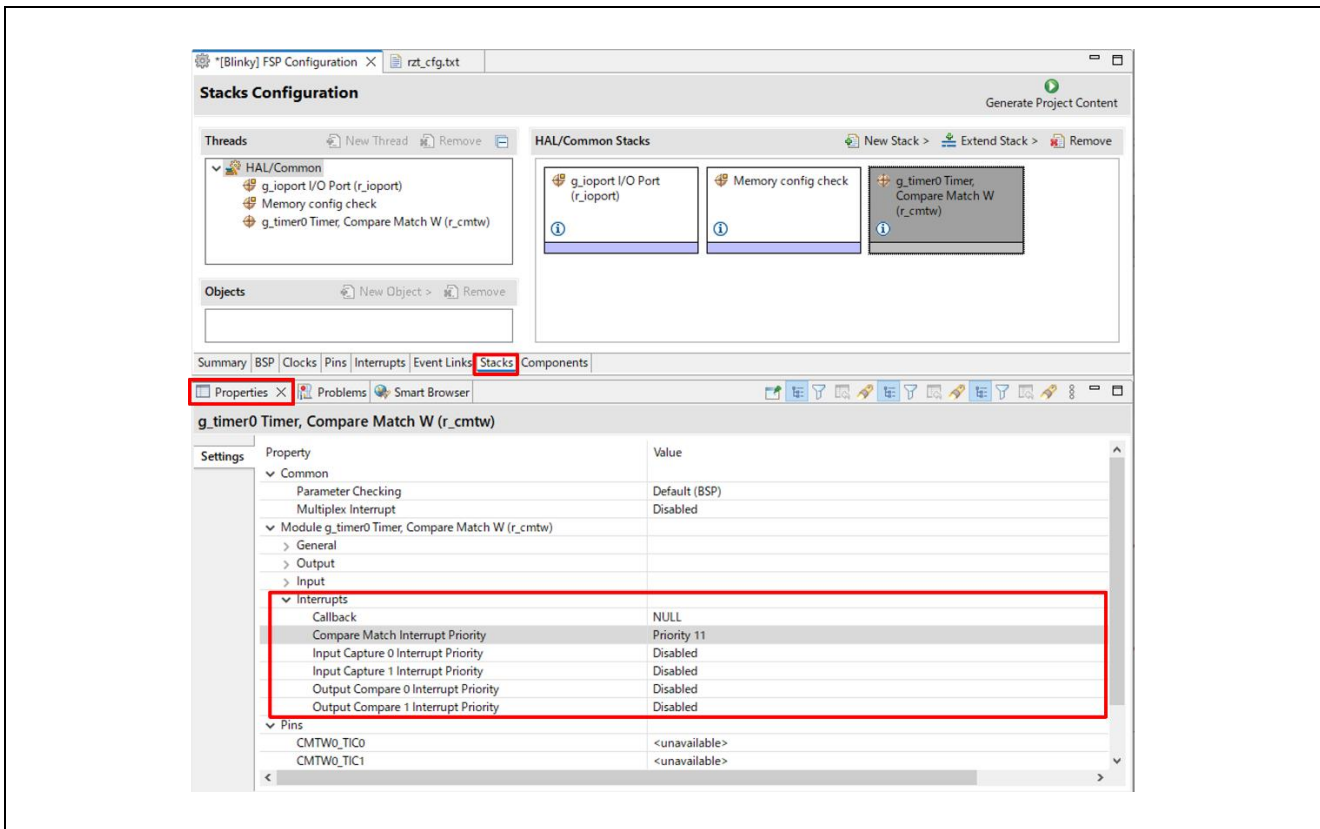


Figure 84 : Configuring Interrupts in the Stacks Tab

6.4.1 Creating Interrupts from the Interrupts Tab

On the **Interrupts** tab, the interrupt of the driver selected in the **Stacks** tab is registered.

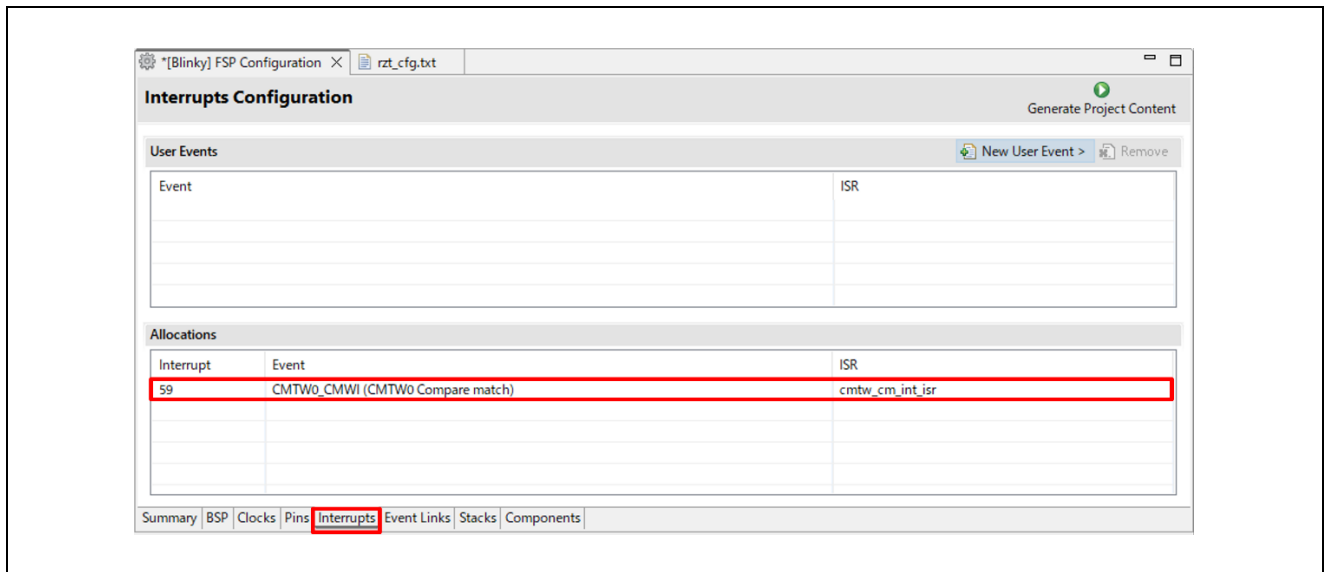


Figure 85 : Configuring Interrupt in Interrupt Tab

And the user can add a peripheral interrupt created by the user's own. This can be done by adding a new event via the **New User Event** button.

6.4.2 Viewing Event Links

The Event Links tab can be used to view the Event Link Controller events. The events are sorted by peripheral to make it easy to find and verify them.

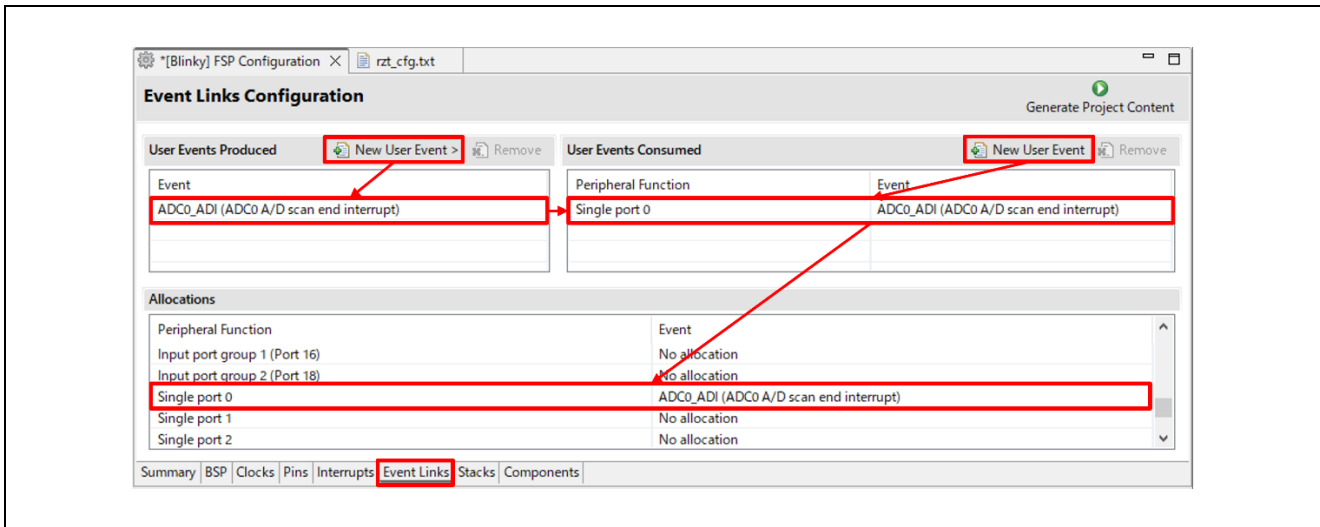


Figure 86 : Viewing Event Links

Like the Interrupts tab, user-defined event sources and destinations (producers and consumers) can be defined by clicking the relevant **New User Event** button. Once a consumer is linked to a producer the link will appear in the **Allocations** section at the bottom.

Note:

When selecting an ELC event to receive for a module (or when manually defining an event link), only the events that are made available by the modules configured in the project will be shown.

6.5 Adding and Configuring HAL Drivers

For applications that run outside or without the RTOS, you can add additional HAL drivers to your application using the HAL/Common thread. To add drivers, follow these steps:

1. Click on the HAL/Common icon in the **Stacks** pane. The Modules pane changes to **HAL/Common Stacks**.
2. Click New Stack to see a drop-down list of HAL level drivers available in the FSP.
3. Select a driver from the menu **New Stack > Driver**.

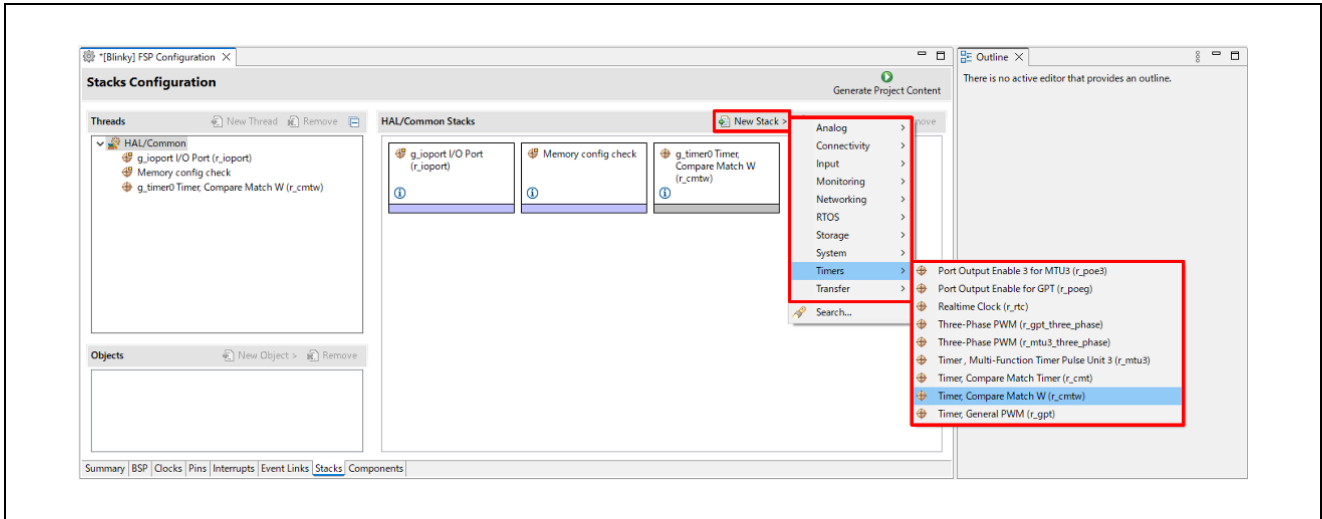


Figure 87 : e² studio Project Configurator – Adding Drivers

4. Select the driver module in the **HAL/Common Modules** pane and configure the driver properties in the **Properties** view.

e² studio adds the following files when you click the **Generate Project Content** button:

- The selected driver module and its files to the rzt/fsp or rzn/fsp directory
- The main() function and configuration structures and header files for your application as shown in the table below.

Table 5 Generate Contents on Smart Configurator

File	Contents	Overwritten by Generate Project Content?
rzt_gen/main.c or rzn_gen/main.c	Contains main() calling generated and user code. When called, the BSP already has Initialized the MPU.	Yes
rzt_gen/hal_data.c or rzn_gen/had_data.c	Configuration structures for HAL Driver only modules.	Yes
rzt_gen/hal_data.h or rzn_gen/hal_data.h	Header file for HAL driver only modules.	Yes
src/hal_entry.c	User entry point for HAL Driver only code. Add your code here.	No

The configuration header files for all included modules are created or overwritten in this folder:

- rzt_cfg/fsp_cfg or
- rzn_cfg/fsp_cfg

6.6 Reviewing and Adding Components

The **Components** tab enables the individual modules required by the application to be included or excluded. Modules common to all RZ MPU projects are preselected. All modules that are necessary for the modules selected in the **Stacks** tab are included automatically. You can include or exclude additional modules by ticking the box next to the required component.

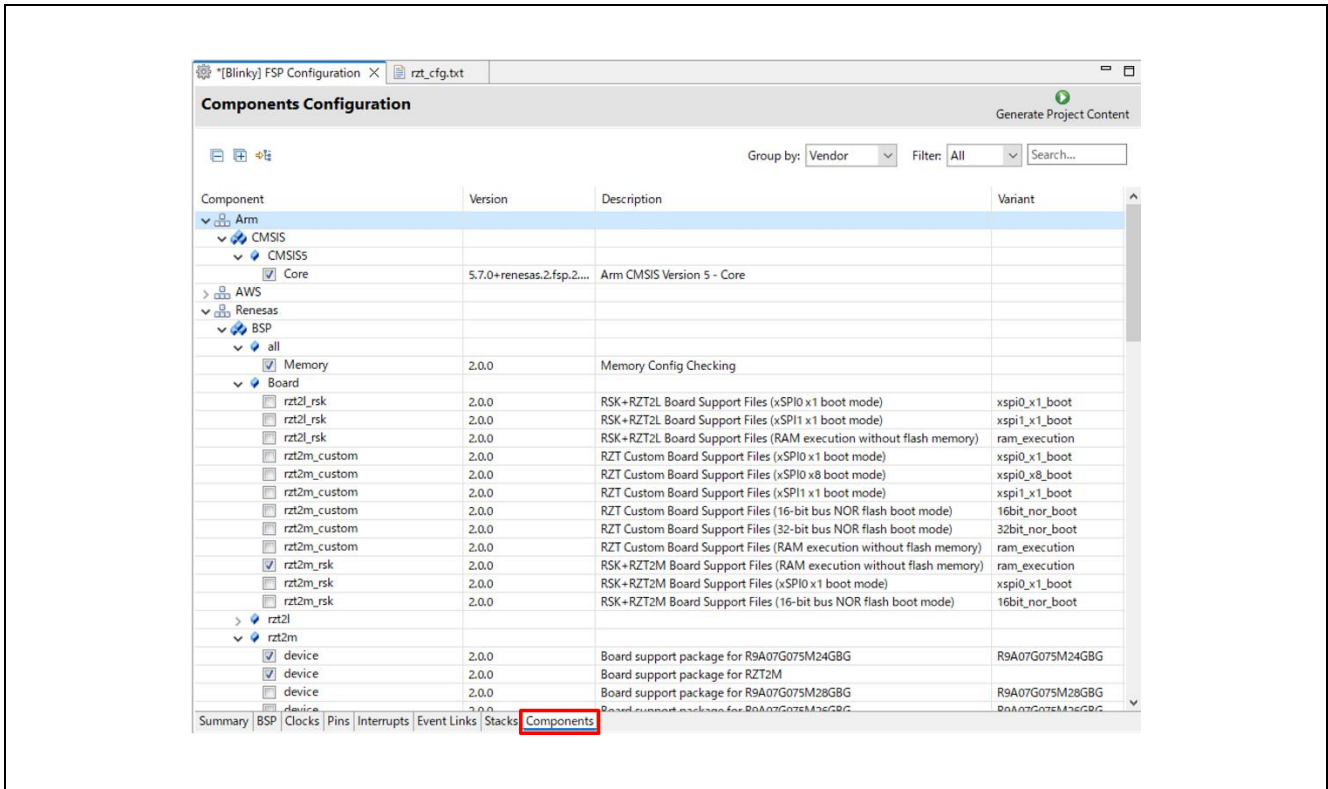


Figure 88 : Components Tab

Clicking the **Generate Project Content** button copies the .c and .h for each selected component into the following folders:

- rzt/fsp/inc/api
- rzt/fsp/inc/instances
- rzt/fsp/src/bsp
- rzt/fsp/src/<Driver_Name>

or

- rzn/fsp/inc/api
- rzn/fsp/inc/instances
- rzn/fsp/src/bsp
- rzn/fsp/src/<Driver_Name>

e² studio also creates configuration files in the following folder with configuration options set in the **Stacks** tab.

- rzt_cfg/fsp_cfg
- rzn_cfg/fsp_cfg

Appendix. Known Issues

This chapter describes the known issues regarding the current version of FSP and related platform software.

Most of the issues may require users to follow some manual operations to resolve the issues or to avoid the problems caused by the issues. Please follow the operations in the description of the issues if you use the features related to the issues. The grayed-out items have been resolved.

The known issues are categorized into two main groups, FSP Configuration and FSP Modules.

- FSP Configuration

e² studio and FSP SC have various configuration features worked on GUI with FSP.

Regarding the overview of each configuration feature (GUI tab) provided as a part of FSP configuration in e² studio and FSP SC, please see the chapter 6. “FSP Configuration Users Guide”.

- FSP Modules

The FSP provides HAL drivers and BSP configured by FSP Configuration on e² studio and FSP SC.

Regarding their features, usage notes and API references, please see the related file “FSP Documentation”.

Table 6 List of Known Issues

No.	Title	Target Device				Category
		T2M	T2L	T2ME	N2L	
1	“r_gmac” may be showed as “r_ether” incorrectly.	✓			✓	FSP Configuration, Stacks
2	“Edge” can be selected as Transfer End Interrupt Detect Type in “r_dmac”, but it cannot be used.	✓	✓		✓	FSP Configuration, Stacks
3	When the “Device” or “Board” selection in BSP tab is changed, the BSP properties are sometimes configured to incorrect configuration.	✓	✓	✓	✓	FSP Configuration, BSP
4	(FSP SC ONLY) Device name is not output correctly depending on the selected device.	✓		✓		FSP Configuration, BSP
5	Errors occur when changing board settings.		✓		✓	FSP Configuration, BSP
6	Pin configuration error occurs in MPX-IO 16bit operating mode of “r_bsc”.	✓	✓		✓	FSP Configuration, Pins
7	Build error when using definition name of input/output external pins for module.	✓	✓		✓	FSP Configuration, Pins
8	“R_SCI_UART BaudCalculate()” of “r_sci_uart” module properly works ONLY when its clock source is SCInASYNCCLK and its frequency is 96MHz.	✓	✓		✓	FSP Modules, SCI UART
9	“R_SPI_CalculateBitrate()” of “r_spi” module properly works ONLY when its clock source is SPInASYNCCLK and its frequency is 96MHz.	✓	✓		✓	FSP Modules, SPI
10	A warning occurs when building “r_gmac” module with the gcc compiler.	✓	✓			FSP Modules, Ethernet
11	In FSP Documentation, there is incorrect description in. “API Reference > Modules > Ethernet PHY” page.	✓			✓	FSP Modules, Ethernet PHY

No.	Title	Target Device				Category
		T2M	T2L	T2ME	N2L	
12	The interrupt number cannot be successfully acquired by the R_FSP_CurrentIrqGet() when multiple interrupt occurs.				✓	FSP Modules, FreeRTOS
13	Block Media Custom Implementation can be selected as Memory Implementation for “rm_freertos_plus_fat” module, but it cannot be used.	✓	✓	✓	✓	FSP Configuration, Stacks
14	The second argument of “r_mtu3” APIs do not match with common API.	✓	✓	✓	✓	FSP Modules, MTU3
15	In multiprocessing, a configuration error occurs when “r_gp” module is used for both projects for CPU0 and CPU1.	✓		✓		FSP Configuration, Stacks
16	Project build error occur when 32-bit bus NOR flash and xSPI0 x8 boot modes are selected on RZT Custom User Board.	✓				FSP Configuration, BSP
17	The secondary project for multiprocessing cannot be created when xSPI1 x1 boot modes are selected on RZT Custom User Board.	✓				FSP Configuration, BSP
18	An incorrect value is set to a pin select value for MTU0-B/MTU6/MTU7 as MTU3 output pin.		✓			FSP Modules, POE3
19	Build error when using DSMIFn_ERR as an additional trigger for “r_poe3” module.		✓			FSP Modules, POE3
20	Control setting values for MTU3 output pins in Stacks tab of FSP Configuration are set to the incorrect pin.	✓	✓	✓		FSP Configuration, Stacks
21	A bug that prevented the setup of PLL1.				✓	FSP Configuration, Clocks
22	A section cannot be copied successfully when its size is not a multiple of the alignment size.				✓	FSP Modules, BSP
23	Initial values of data placed in some sections were overwritten with 0.				✓	FSP Modules, BSP
24	Some sections were not initialized in the flash boot project.				✓	FSP Modules, BSP

No. 1 Resolved

Title	“r_gmac” may be showed as “r_ether” incorrectly.
Target	RZ/T2M, RZ/N2L
Category	FSP Configuration, Stacks
Description	In Stacks tab, “r_gmac” may be showed as “r_ether” incorrectly.
Workaround	Please read the “r_ether” as “r_gmac”.

No. 2 Resolved

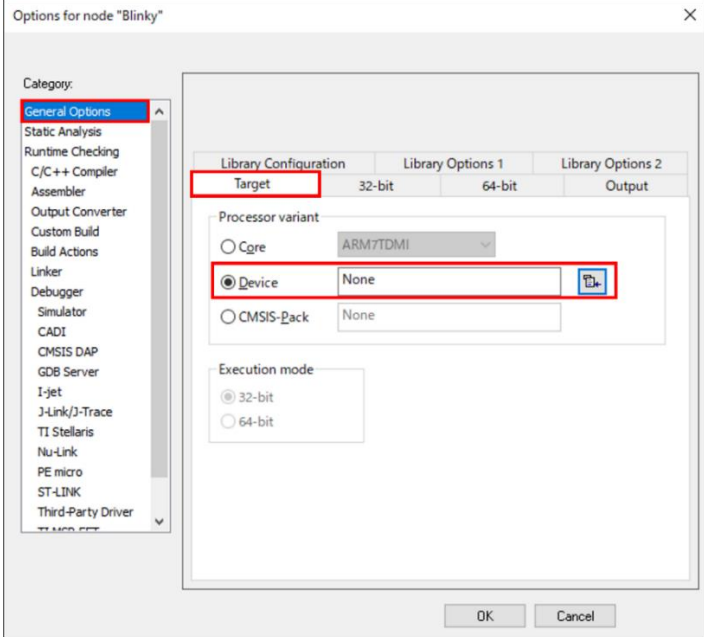
Title	“Edge” can be selected as Transfer End Interrupt Detect Type in “r_dmac”, but it cannot be used.
Target	RZ/T2M, RZ/T2L, RZ/N2L
Category	FSP Configuration, Stacks
Description	“Edge” of interrupt detect type is not available due to a change in hardware specifications.
Workaround	Please don't set Edge to Transfer End Interrupt Detect Type

No. 3

Title	When the “Device” or “Board” selection in BSP tab is changed, the BSP properties are sometimes configured to incorrect configuration.
Target	RZ/T2M, RZ/T2L, RZ/T2ME, RZ/N2L
Category	FSP Configuration, BSP
Description	When the “Device” or “Board” selection in BSP tab is changed, the BSP properties are sometimes configured for incorrect configuration. Once this issue occurs, the project cannot be fixed to correct configuration.
Workaround	If changing the “Device” or “Board”, please reselect “FSP Version” from the drop-down list. If you want to change only the boot mode on the same board, please refer to Appendix. How to Change Boot Mode of FSP Project

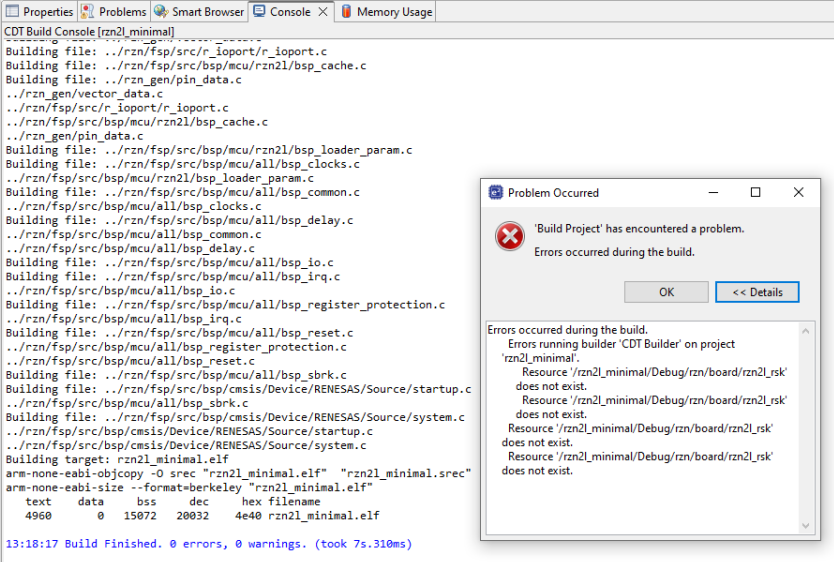
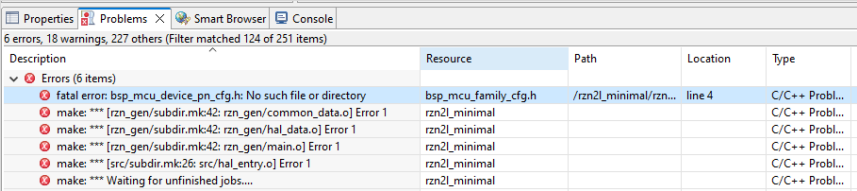
(Continued on next page)

No. 4

Title	(FSP SC ONLY) Device name is not output correctly depending on the selected device.
Target	RZ/T2M, RZ/T2ME
Category	FSP Configuration, BSP
Description	If you create a project by selecting a single core device (R9A07G075M01xxx, R9A07G075M05xxx), the device setting will be “None” when you open the project in IAR EWARM.
Workaround	<p>Please reselect device name from the device list in IAR EWARM project options. Options > General Options > Target > Processor variant > Device</p> 

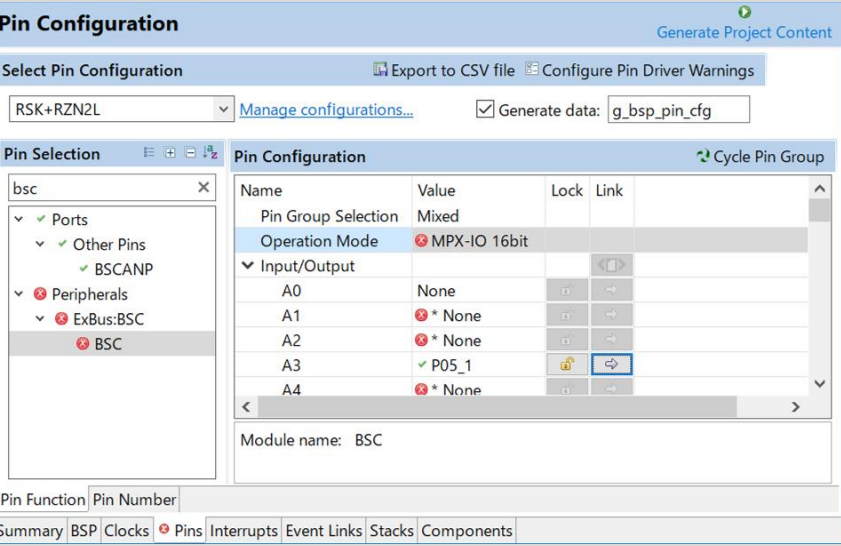
(Continued on next page)

No. 5 Deleted due to one of the issues with Known Issues No. 3

Title	Errors occur when changing board settings.
Target	RZ/T2L, RZ/N2L
Category	FSP Configuration, BSP
Description	<p>Errors occur when changing board settings from RSK+RZN2L (RAM execution without flash memory) to RZN2L Custom User Board (RAM execution without flash memory) and from RSK+RZN2L (RAM execution without flash memory) to RZN2L Custom User Board (xSPI0 x1 boot mode).</p> <ol style="list-style-type: none"> 1. Changed from RSK+RZN2L (RAM execution without flash memory) to RZN2L Custom User Board (RAM execution without flash memory) <p>In this case, the build is successful. But the following screen is displayed after the build.</p>  <ol style="list-style-type: none"> 2. Changed from RSK+RZN2L (RAM execution without flash memory) to RZN2L Custom User Board (xSPI0 x1 boot mode) <p>bsp_mcu_device_pn_cfg.h is not generated and builds error occurs.</p> 
Workaround	Please create a new project to change the board setting to RZN2L Custom User Board.

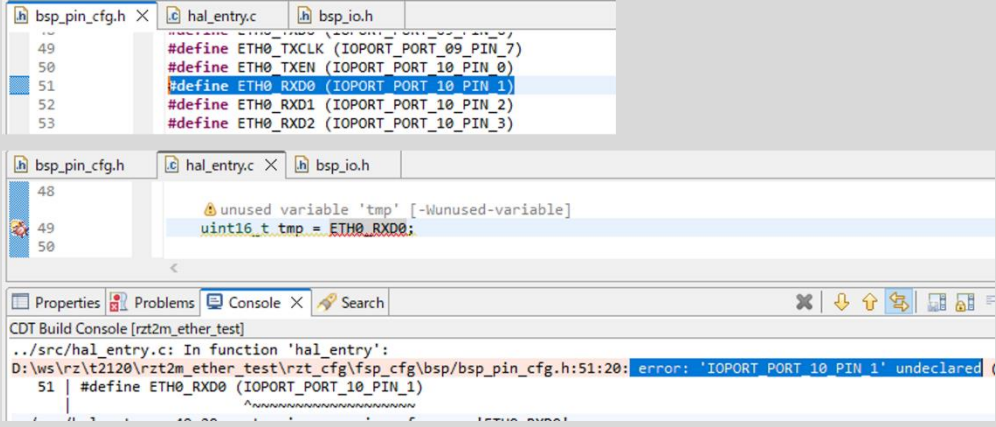
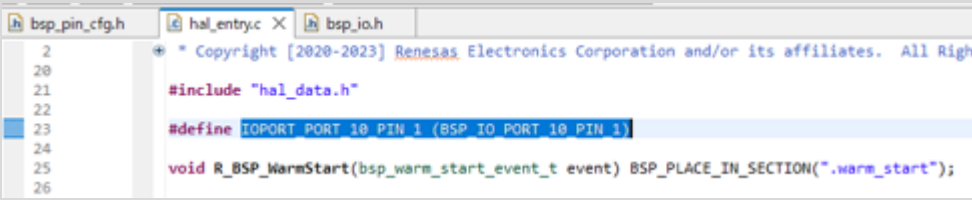
(Continued on next page)

No. 6 Resolved

Title	Pin configuration error occurs in MPX-IO 16bit operating mode of “r_bsc”.
Target	RZ/T2M, RZ/T2L, RZ/N2L
Category	FSP Configuration, Pins
Description	<p>Pin assignment is an optional specification in MPX-IO 16bit operation mode of “r_bsc”, but an error will occur if Input/Output A1-A13 is not set.</p>  <p>The screenshot shows the 'Pin Configuration' tool interface. On the left, the 'Pin Selection' pane shows a tree view with 'Ports', 'Other Pins', 'Peripherals', and 'ExBus:BSC'. Under 'Peripherals', 'BSC' is selected. The main 'Pin Configuration' pane shows a table with columns: Name, Value, Lock, and Link. The 'Operation Mode' is set to 'MPX-IO 16bit'. Under 'Input/Output', pins A0, A1, A2, A3, and A4 are listed. A0 is set to 'None', A1, A2, and A4 are set to '* None' (indicated by a red error icon), and A3 is set to 'P05_1'. The 'Module name' is 'BSC'. At the bottom, there are tabs for 'Summary', 'BSP', 'Clocks', 'Pins', 'Interrupts', 'Event Links', 'Stacks', and 'Components', with 'Pins' currently selected.</p>
Workaround	Please set “Custom” to “Operation Mode” of “r_bsc” in Pins tab when you use MPX-IO 16bit operation mode of “r_bsc”.

(Continued on next page)

No. 7 Resolved

Title	Build error when using definition name of input/output external pins for module.
Target	RZ/T2M, RZ/T2L, RZ/N2L
Category	FSP Configuration, Pins
Description	<p>After code generation, the definition of input/output external pins for the module is generated in fsp_cfg/bsp/bsp_pin_cfg.h, but the defined values are not defined in FSP. When using the defined name in a user application, a build error occurs.</p> 
Workaround	<p>Please add definition to read IOPORT_PORT_mm_PIN_n as BSP_IO_PORT_mm_PIN_n in hal_entry. Do NOT edit file fsp_cfg/bsp/bsp_pin_cfg.h because its contents will be overwritten.</p> <p>An example of a setting: When using ETH0_RXD0 (IOPORT_PORT_10_PIN_1), add definition of #define IOPORT_PORT_10_PIN_1 (BSP_IO_PORT_10_PIN_1) in hal_entry.c.</p> 

No. 8 Resolved

Issue	“R_SCI_UART_BaudCalculate()” of “r_sci_uart” module properly works ONLY when its clock source is SCInASYNCCLK and its frequency is 96MHz.
Target	RZ/T2M, RZ/T2L, RZ/N2L
Category	FSP Modules, Serial Communication Interface (SCI) UART
Description	The “R_SCI_UART_BaudCalculate()” of “r_sci_uart” module works ONLY when its clock source is “SCInASYNCCLK” and its frequency is “96MHz”; therefore, when the module uses “PCLKM” as its clock source or the frequency is not 96MHz, the API function will be not work properly.
Workaround	The clock source and frequency are limited in Clocks and Stacks tab; therefore, you can NOT use the PCLKM clock and can NOT change the clock frequency.

(Continued on next page)

No. 9 Resolved

Issue	“R_SPI_CalculateBitrate()” of “r_spi” module properly works ONLY when its clock source is SPInASYNCCLK and its frequency is 96MHz.
Target	RZ/T2M, RZ/T2L, RZ/N2L
Category	FSP Modules, Serial Peripheral Interface
Description	The “R_SPI_BaudCalculate()” of “r_spi” module works ONLY when its clock source is “SPInASYNCCLK” and its frequency is “96MHz”; therefore, when the module uses “PCLKM” as its clock source or the frequency is not 96MHz, the API function will be not work properly.
Workaround	The clock source and frequency are limited in Clocks and Stacks tab; therefore, you can NOT use the PCLKM clock and can NOT change the clock frequency.

No. 10 Resolved

Issue	A warning occurs when building “r_gmac” module with the gcc compiler.
Target	RZ/T2M, RZ/T2L
Category	FSP Modules, Ethernet
Description	The following warning occurs when building “r_gmac” module with the gcc compiler. <pre>../rzt/fsp/src/r_gmac/r_gmac.c:2173:14: warning: the comparison will always evaluate as 'false' for the pointer operand in 'pp_phy_instance + (sizetype)(port * 12)' must not be NULL [-Waddress] 2173 if (NULL == pp_phy_instance[port]) ^~</pre>
Workaround	Please ignore this warning.

No. 11 Resolved

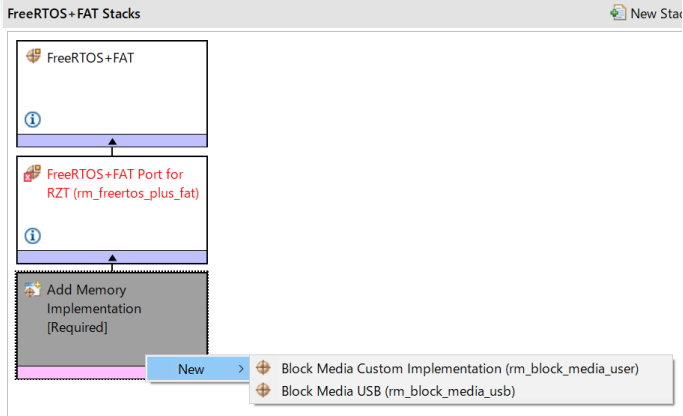
Issue	In FSP Documentation, there is incorrect description in. “API Reference > Modules > Ethernet PHY” page.
Target	RZ/T2M, RZ/N2L
Category	FSP Modules, Ethernet PHY
Description	In the “API Reference > Modules > Ethernet PHY” page in FSP Documentation, the default column description of “Select PHYs to use” configuration is incorrect.
Workaround	When reading the incorrect description, please replace the reading of it with follows. [Error] <ul style="list-style-type: none"> ➤ config.driver.ether_phy.phy_lsi.default,config.driver.ether_phy.phy_lsi.0,config.driver.ether_phy.phy_lsi.1,config.driver.ether_phy.phy_lsi.2,config.driver.ether_phy.phy_lsi.3,config.driver.ether_phy.phy_lsi. [Correction] <ul style="list-style-type: none"> ➤ All check boxes are enabled.

(Continued on next page)

No. 12 Resolved

Issue	The interrupt number cannot be successfully acquired by the R_FSP_CurrentIrqGet() when multiple interrupt occurs.
Target	RZ/N2L
Category	FSP Modules, FreeRTOS
Description	The interrupt number cannot be successfully acquired by the R_FSP_CurrentIrqGet() when using multiple interrupt handlers with different priority levels in FreeRTOS.
Workaround	<p>Please modify the followings for the countermeasure against nested interrupts.</p> <p>Target File: port.c</p> <pre> void vApplicationIRQHandler (uint32_t ulICCIAR) { #if 0 /* Re-enable interrupts. */ __asm("cpsie i"); #endif bsp_common_interrupt_handler(ulICCIAR); } </pre> <p>Target File: bsp_irq.c</p> <pre> void bsp_common_interrupt_handler (uint32_t id) { uint16_t gic_intid; /* Get interrupt ID (GIC INTID). */ gic_intid = (uint16_t) (id & BSP_PRV_ID_MASK); #if VECTOR_DATA_IRQ_COUNT > 0 if (BSP_CORTEX_VECTOR_TABLE_ENTRIES <= gic_intid) { /* Remain the interrupt number */ g_current_interrupt_num[g_current_interrupt_pointer++] = (uint16_t) (gic_intid-- BSP_CORTEX_VECTOR_TABLE_ENTRIES); __asm volatile ("dmb"); #if 1 /* Enable nested interrupt. */ __asm volatile ("cpsie i"); __asm volatile ("isb"); #endif /* Branch to an interrupt handler. */ g_vector_table[(gic_intid-- BSP_CORTEX_VECTOR_TABLE_ENTRIES)](); } else #endif { /* Remain the interrupt number */ g_current_interrupt_num[g_current_interrupt_pointer++] = gic_intid; __asm volatile ("dmb"); #if 1 /* Enable nested interrupt. */ __asm volatile ("cpsie i"); __asm volatile ("isb"); #endif /* Branch to an interrupt handler. */ g_sgi_ppi_vector_table[gic_intid](); } #if 1 /* Disable nested interrupt. */ __asm volatile ("cpsid i"); __asm volatile ("isb"); #endif g_current_interrupt_pointer--; } </pre>

No. 13

Issue	Block Media Custom Implementation can be selected as Memory Implementation for “rm_freertos_plus_fat” module, but it cannot be used.
Target	RZ/T2M, RZ/T2L, RZ/T2ME, RZ/N2L
Category	FSP Configuration, Stacks
Description	<p>In Stacks tab of Configuration, Block Media Custom Implementation can be selected as Memory Implementation for “rm_freertos_plus_fat” module, but it is unsupported and causes build errors.</p> 
Workaround	Please select Block Media USB as Memory Implementation for “rm_freertos_plus_fat” module.

No. 14

Issue	The second argument of “r_mtu3” APIs do not match with common API.
Target	RZ/T2M, RZ/T2L, RZ/T2ME, RZ/N2L
Category	FSP Modules, MTU3
Description	The second argument of these three APIs "R_MTU3_PeriodSet()", "R_MTU3_InfoGet()", and "R_MTU3_StatusGet()" of the "r_mtu3" module, do not match with the API in “r_timer api.h” header file
Workaround	<p>You cannot call these API by using function pointer</p> <pre>g_timer0.p_api->periodSet() g_timer0.p_api-> InfoGet() g_timer0.p_api-> StatusGet()</pre> <p>Please use API by calling them directly</p> <pre>R_MTU3_PeriodSet() R_MTU3_InfoGet() R_MTU3_StatusGet()</pre> <p>For reference how to use these APIs, please refer to MTU3 Examples in FSP documentation.</p>

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No. 15

Issue	In multiprocessing, a configuration error occurs when “r_gpt” module is used for both projects for CPU0 and CPU1.
Target	RZ/T2M, RZ/T2ME
Category	FSP Configuration, Stacks
Description	When using “r_gpt” module in Stacks tab of both projects for CPU0 and CPU1, a configuration error occurs. “r_gpt” module can only be used with either CPU0 or CPU1 in multiprocessing, regardless of the Unit or Channel number used.
Workaround	Please use “r_gpt” module ONLY with either CPU0 or CPU1 in multiprocessing.

No. 16 Resolved

Issue	Project build error occur when 32-bit bus NOR flash and xSPI0 x8 boot modes are selected on RZT Custom User Board.
Target	RZ/T2M
Category	FSP Configuration, BSP
Description	When the following boards (boot mode) are selected, the required definitions are not generated and a build error occurs. <ul style="list-style-type: none"> • RZT Custom User Board (32-bit bus NOR flash boot mode) • RZT Custom User Board (xSPI0 x8 boot mode)
Workaround	Please don't select 32-bit bus NOR flash and xSPI0 x8 boot modes on RZT Custom User Board.

No. 17 Resolved

Issue	The secondary project for multiprocessing cannot be created when xSPI1 x1 boot modes are selected on RZT Custom User Board.
Target	RZ/T2M
Category	FSP Configuration, BSP
Description	When the following boards (boot mode) are selected for the primary project of multiprocessing, a variable required for multiprocessing is not defined and the secondary project cannot be created. <ul style="list-style-type: none"> • RZT Custom User Board (xSPI1 x1 boot mode)
Workaround	Please don't select xSPI1 x1 boot modes on RZT Custom User Board when multiprocessing.

(Continued on next page)

No. 18

Issue	An incorrect value is set to a pin select value for MTU0-B/MTU6/MTU7 as MTU3 output pin.
Target	RZ/T2L
Category	FSP Modules, POE3
Description	Pin select value of MTU3 output pins used in FSP do not match with User’s Manual: Hardware. Therefore, what you want to set up is not correctly described in the generated file of FSP Configuration.
Workaround	<p>When using “r_poe3” and MTU0-B/MTU6/MTU7 as MTU3 output pin, please follow these four steps:</p> <ol style="list-style-type: none"> 1. Add “Port Output Enable 3 for MTU3 (r_poe3)” on Stacks tab of FSP Configuration. 2. Click Generate Project Content button and “r_poe3” code is generated. 3. Disable code generating function. After this setting, the code cannot be generated. [For e² studio Smart Configurator] Use the following settings to suppress the code generating operation. If this setting is missed, code generating operation is automatically executed at clean build, and the changes made in step 4 revert to the original. <ol style="list-style-type: none"> a. Uncheck “Project Properties > Builders > DDSC Builder” <div data-bbox="395 851 1061 1265" data-label="Image"> </div> <ol style="list-style-type: none"> b. When unchecking it, the following message appears: click OK. <div data-bbox="395 1339 1061 1500" data-label="Image"> </div> <p>[For FSP Smart Configurator (IAR EWARM)] No need setting since code generation is not executed automatically.</p> 4. Modify definitions in rzt_gen/hal_data.c Change the value of [module name]_pwm_pin_setting[] or [module name]_complementary_pwm_setting[1].pin_setting[X](X=0,1,2) according to the MTU3 output pins used. The tables below show the replacements required for each MTU3 output pins. <p>File to be modified: rzt_gen/hal_data.c</p> <pre> /* Setting structure for pwm pin. */ static const poe3_pwm_pin_setting_t g_poe30_pwm_pin_setting[] = { { .pwm_pin_select = POE3_PIN_SELECT_0, .hiz_output_enable = false }, { .pwm_pin_select = POE3_PIN_SELECT_0, .hiz_output_enable = false }, { .pwm_pin_select = POE3_PIN_SELECT_0, .hiz_output_enable = false }, { .pwm_pin_select = POE3_PIN_SELECT_0, .hiz_output_enable = false }, }; /* Setting structure for complementary pwm pin. */ static const poe3_complementary_pwm_setting_t g_poe30_complementary_pwm_setting[] = { { .pin_setting[0] = </pre>

```
{ .positive_pwm_pin_select = POE3_PIN_SELECT_0,
.....
.pin_setting[X] =
{ .positive_pwm_pin_select = POE3_PIN_SELECT_0,
.negative_pwm_pin_select = POE3_PIN_SELECT_0,
.positive_pwm_pin_active_level = POE3_ACTIVE_LEVEL_SETTING_NONE,
.negative_pwm_pin_active_level = POE3_ACTIVE_LEVEL_SETTING_NONE,
.hiz_output_enable = false },
.....
```

For MTU0-B

MTU3 output pin	Port	Location (Struct [module name]_pwm_pin_setting[])	Replace with
mtioc0b	P14_4	the second pwm_pin_select	.pwm_pin_select = POE3_PIN_SELECT_1
mtioc0b	P24_0	the second pwm_pin_select	.pwm_pin_select = POE3_PIN_SELECT_2
mtioc0b	P13_3	the second pwm_pin_select	.pwm_pin_select = POE3_PIN_SELECT_3

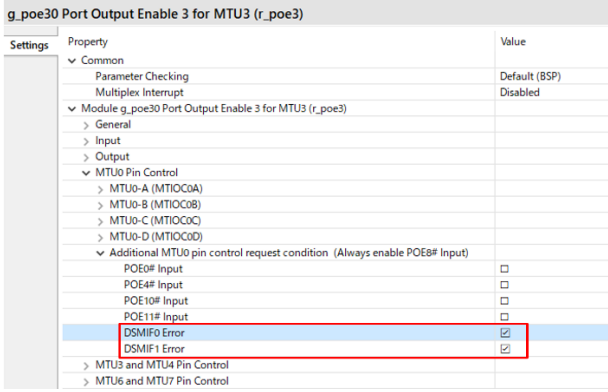
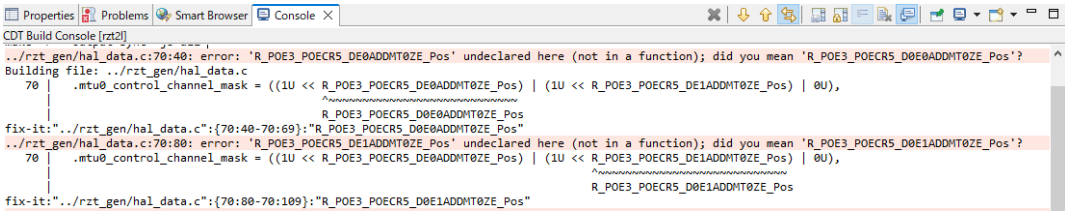
For MTU6/MTU7

MTU3 output pin	Port	Location (Struct [module name]_complementary_pwm_setting[])	Replace with
mtioc6b	P21_2	the second pin_setting[0]	.positive_pwm_pin_select = POE3_PIN_SELECT_1,
mtioc6b	P08_5	the second pin_setting[0]	.positive_pwm_pin_select = POE3_PIN_SELECT_2,
mtioc6d	P21_4	the second pin_setting[0]	.negative_pwm_pin_select = POE3_PIN_SELECT_1,
mtioc6d	P08_7	the second pin_setting[0]	.negative_pwm_pin_select = POE3_PIN_SELECT_2,
mtioc7a	P21_5	the second pin_setting[1]	.positive_pwm_pin_select = POE3_PIN_SELECT_1,
mtioc7a	P09_0	the second pin_setting[1]	.positive_pwm_pin_select = POE3_PIN_SELECT_2,
mtioc7c	P21_7	the second pin_setting[1]	.negative_pwm_pin_select = POE3_PIN_SELECT_1,
mtioc7c	P09_2	the second pin_setting[1]	.negative_pwm_pin_select = POE3_PIN_SELECT_2,
mtioc7b	P21_6	the second pin_setting[2]	.positive_pwm_pin_select = POE3_PIN_SELECT_1,
mtioc7b	P09_1	the second pin_setting[2]	.positive_pwm_pin_select = POE3_PIN_SELECT_2,
mtioc7d	P22_0	the second pin_setting[2]	.negative_pwm_pin_select = POE3_PIN_SELECT_1,
mtioc7d	P09_3	the second pin_setting[2]	.negative_pwm_pin_select = POE3_PIN_SELECT_2,

Note: There are two pin_setting[X] 's with the same number(X); modify the second one, not the first.

(Continued on next page)

No. 19

Issue	Build error when using DSMIFn_ERR as an additional trigger for “r_poe3” module.
Target	RZ/T2L
Category	FSP Modules, POE3
Description	<p>When using DSMIFn_ERR as an additional trigger in FSP Configuration, after code generation, values of DSMIFn_ERR additional trigger for the module are generated in rzt_gen/hal_data.c. But the defined values are not defined in FSP, so a build error occurs.</p> <ul style="list-style-type: none"> Property of r_poe3 stack  <ul style="list-style-type: none"> Build error log 
Workaround	<p>When using “r_poe3” and DSMIFn_ERR(n=0,1) as an additional trigger, please follow these four steps:</p> <ol style="list-style-type: none"> 1-3. Refer to the workaround of No. 18. 4. Modify definitions in rzt_gen/hal_data.c <p>When using DSMIF 0 ERROR, DSMIF 1 ERROR for MTU0 additional trigger, modify:</p> <ul style="list-style-type: none"> • R_POE3_POECR5_DE0ADDMT0ZE_Pos to R_POE3_POECR5_D0E0ADDMT0ZE_Pos • R_POE3_POECR5_DE1ADDMT0ZE_Pos to R_POE3_POECR5_D0E1ADDMT0ZE_Pos <p>When using DSMIF 0 ERROR, DSMIF 1 ERROR for MTU3/4 additional trigger, modify:</p> <ul style="list-style-type: none"> • R_POE3_POECR4_DE0ADDMT34ZE_Pos to R_POE3_POECR4_D0E0ADDMT34ZE_Pos • R_POE3_POECR4_DE1ADDMT34ZE_Pos to R_POE3_POECR4_D0E1ADDMT34ZE_Pos <p>When using DSMIF 0 ERROR, DSMIF 1 ERROR for MTU6/7 additional trigger, modify:</p> <ul style="list-style-type: none"> • R_POE3_POECR4_DE0ADDMT67ZE_Pos to R_POE3_POECR4_D0E0ADDMT67ZE_Pos • R_POE3_POECR4_DE1ADDMT67ZE_Pos to R_POE3_POECR4_D0E1ADDMT67ZE_Pos

(Continued on next page)

No. 20

Issue	Control setting values for MTU3 output pins in Stacks tab of FSP Configuration are set to the incorrect pin.		
Target	RZ/T2M, RZ/T2L, RZ/T2ME		
Category	FSP Configuration, Stacks		
Description	Settings for MTU4-B(MTIOC4B) and MTU4-D(MTIOC4D) in the Stacks tab property would be treated as settings for MTU4-A(MTIOC4A) and MTU4-C(MTIOC4C) in the generated file by Smart Configurator. All MTU3 output pins for MTU4 and MTU7, are the same as above.		
	Module [module name] Port Output Enable 3 for MTU3 (r_poe3) of Stacks property		
	Second Category	Third Category	Used for
	MTU3 and MTU4 Pin Control	MTU4-B(MTIOC4B) and MTU4-D(MTIOC4D)	MTU4-A(MTIOC4A) and MTU4-C(MTIOC4C)
	MTU3 and MTU4 Pin Control	MTU4-A(MTIOC4A) and MTU4-C(MTIOC4C)	MTU4-B(MTIOC4B) and MTU4-D(MTIOC4D)
	MTU6 and MTU7 Pin Control	MTU7-B(MTIOC7B) and MTU7-D(MTIOC7D)	MTU7-A(MTIOC7A) and MTU7-C(MTIOC7C)
	MTU6 and MTU7 Pin Control	MTU7-A(MTIOC7A) and MTU7-C(MTIOC7C)	MTU7-B(MTIOC7B) and MTU7-D(MTIOC7D)
Workaround	In configuration of MTU4 and MTU7, please replace B/D and A/C. <ul style="list-style-type: none"> ▼ MTU3 and MTU4 Pin Control <ul style="list-style-type: none"> > MTU3-B (MTIOC3B) and MTU3-D (MTIOC3D) > MTU4-B (MTIOC4B) and MTU4-D (MTIOC4D) Use this field to configure for MTU4-A and MTU4-C > MTU4-A (MTIOC4A) and MTU4-C (MTIOC4C) Use this field to configure for MTU4-B and MTU4-D > Additional MTU3/4 pin control request condition (Always enable POE0# Input) ▼ MTU6 and MTU7 Pin Control <ul style="list-style-type: none"> > MTU6-B (MTIOC6B) and MTU6-D (MTIOC6D) > MTU7-B (MTIOC7B) and MTU7-D (MTIOC7D) Use this field to configure for MTU7-A and MTU7-C > MTU7-A (MTIOC7A) and MTU7-C (MTIOC7C) Use this field to configure for MTU7-B and MTU7-D > Additional MTU6/7 pin control request condition (Always enable POE4# Input) 		

No. 21

Issue	A bug that prevented the setup of PLL1.
Target	RZ/N2L
Category	FSP Configuration, Clocks
Description	The PLL1 state setting in Clocks tab is invalid.
Workaround	Please don't use PLL1 state setting.

(Continued on next page)

No. 22

Issue	A section may not be copied correctly when it is not aligned and the section size is not a multiple of the alignment width.
Target	RZ/N2L
Category	FSP Modules, BSP
Description	<p>Depending on a combination of section size and placement address, when the section is copied, some data from the following section may also be copied with it.</p> <p>A case that cannot be copied correctly: The address of .data_noncache section is 0x30190005 and its size is 0x23 bytes. (Alignment size is 4 bytes.)</p> <pre>.data_noncache 0x30190005 0x23 ./src/hal_entry.o</pre>
Workaround	<p>All section sizes must be aligned by 4 bytes and the data size should be a multiple of the number of bytes in the alignment. Section sizes can be found in the following files:</p> <ul style="list-style-type: none"> gcc: [project name]/Debug/[project name].map icarm: [project name]/Debug/List/[project name].map

No. 23

Issue	Initial values of data placed in some sections were overwritten with 0.
Target	RZ/N2L
Category	FSP Modules, BSP
Description	<p>When selecting XXXXX (RAM execution without flash memory) as “Board” in BSP tab of FSP Configuration, variables placed in the following sections are always cleared to zero.</p> <ul style="list-style-type: none"> .dmac_link_mode .shared_noncache_buffer .noncache_buffer
Workaround	Do NOT place data with initial values in the above sections.

(Continued on next page)

No. 24

Issue	Some sections were not initialized in the flash boot project.
Target	RZ/N2L
Category	FSP Modules, BSP
Description	<p>When selecting a flash boot mode as “Board” in BSP tab of FSP Configuration, variables placed in the following sections are NOT initialized.</p> <p>Boards for flash boot mode</p> <ul style="list-style-type: none"> • XXXXXX (xSPI0 x1 boot mode) • XXXXXX (16-bit bus NOR flash boot mode) • RZN2L Custom User Board (xSPI0 x8 boot mode) • RZN2L Custom User Board (xSPI1 x1 boot mode) • <p>Sections</p> <ul style="list-style-type: none"> • .dmac_link_mode • .shared_noncache_buffer • .noncache_buffer
Workaround	Please initialize the variables placed in the above sections in the user application.

Appendix. Tool Software Limitations

This section describes the limitations regarding the tool software (e² studio, FSP SC) to create and debug FSP projects.

Table 7 List of Tool Software Limitations

No.	Title	Target Device				Category
		T2M	T2L	T2ME	N2L	
1	When installing, please install into the default installation folder specified by installer.	✓	✓	✓	✓	SC, FSP SC
2	Before pressing the reset button on the board, disconnect the e ² studio connection first.	✓	✓		✓	e ² studio
3	An error has occurred because the program download to the NOR flash area has failed. The download is successful on the second connection.	✓			✓	e ² studio
4	The user program cannot be stopped immediately after the device boot process.	✓	✓	✓	✓	e ² studio
5	When using e ² studio installer, if checking the multiple check boxes such as “View Release Notes” and so on to show information on browser, the ONLY head item of checked items is shown.	✓	✓		✓	e ² studio
6	The Memory Region Usage of ATCM displayed in the Memory Usage window of e ² studio is smaller than the actual size by memory region usage of DUMMY.				✓	e ² studio
7	When debugging RAM execution without flash memory project with program written to flash memory, erase flash memory before debugging.	✓	✓	✓	✓	e ² studio
8	Applying RZ/T2 FSP v.1.2.0 pack to a project that is already working with RZ/T2M FSP v.1.1.0 causes an error when connecting the debugger.	✓				IAR EWARM
9	The Device Memory Usage of CPU1 in the Memory Usage window does not work properly.	✓		✓		e ² studio
10	When adding the CallbackSet function using the Developer Assistance feature, the second argument needs to be changed.	✓	✓	✓	✓	e ² studio, SC
11	In IAR EWARM 9.60.1, an error occurs when starting to debug multiprocessing projects of RAM execution without flash memory.	✓		✓		IAR EWARM

No. 1

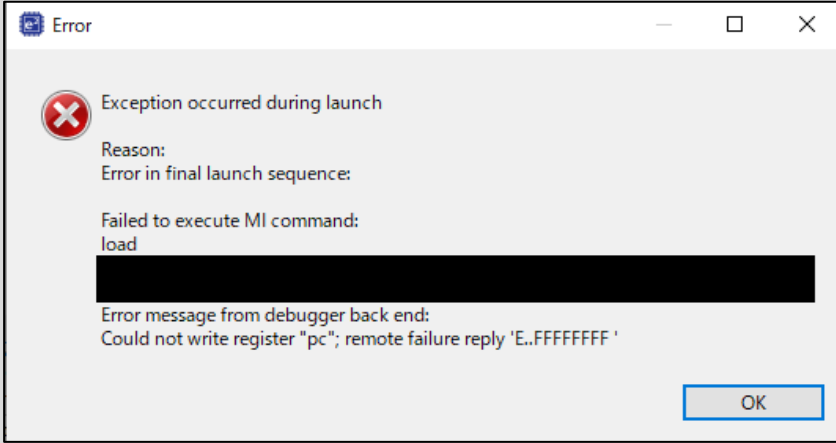
Limitation	When installing, please install into the default installation folder specified by installer.
Target Device	RZ/T2M, RZ/T2L, RZ/T2ME, RZ/N2L
Category	Smart Configurator, FSP Smart Configurator
Description	When sharing a project between different PCs, build errors will occur if the installation folders are different.

(Continued on next page)

No. 2 Resolved

Limitation	Before pressing the reset button on the board, disconnect the e² studio connection first.
Target	RZ/T2M, RZ/T2L, RZ/N2L
Category	e² studio
Description	If the reset button is pressed on the board while connected with e ² studio, debugging will not be able to continue.

No. 3 Resolved

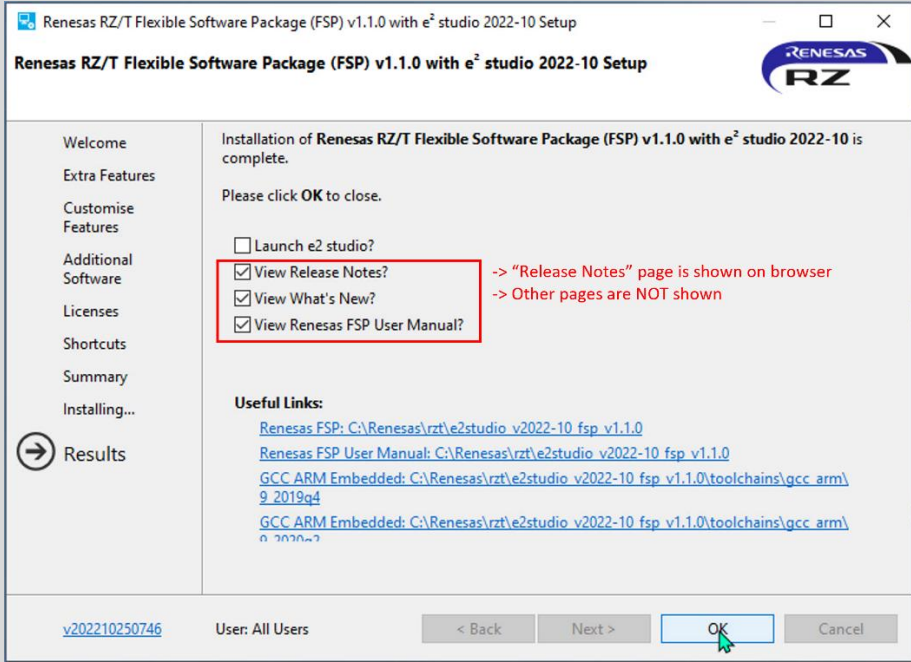
Limitation	An error has occurred because the program download to the NOR flash area has failed. The download is successful on the second connection.
Target	RZ/T2M, RZ/N2L
Category	e² studio
Description	<p>If the following error is displayed when connecting the debugger or when downloading the program, click the [OK] button to close the dialog and try connecting again.</p> 

No. 4

Limitation	The user program cannot be stopped immediately after the device boot process.
Target	RZ/T2M, RZ/T2L, RZ/T2ME, RZ/N2L
Category	e² studio
Description	<p>Immediately after the device boot process (boot code), the program cannot be stopped at the beginning of the user program (loader program).</p> <p>When debugging, please follows the guide in</p> <p>Appendix. How to Debug FSP Project with Flash Boot Mode.</p>

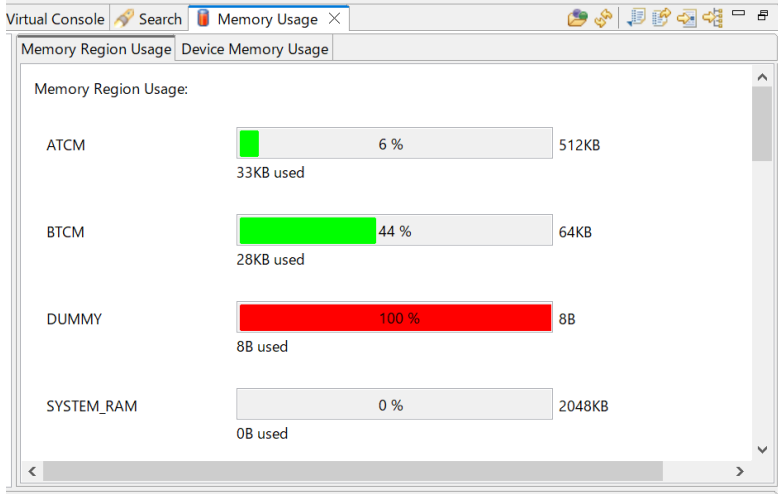
(Continued on next page)

No. 5 Invalid

Limitation	When using e ² studio installer, if checking the multiple check boxes such as “View Release Notes” and so on to show information on browser, the ONLY head item of checked items is shown.
Target	RZ/T2M, RZ/T2L, RZ/N2L
Category	e ² studio
Description	<p>For example, if checking “View Release Notes” check box and other check boxes on the following window, the ONLY “Release Notes” is shown, and the other contents are NOT shown.</p> 

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No. 6 Resolved in RZ/T2 FSP v2.1.0 for RZ/T2M and RZ/T2L

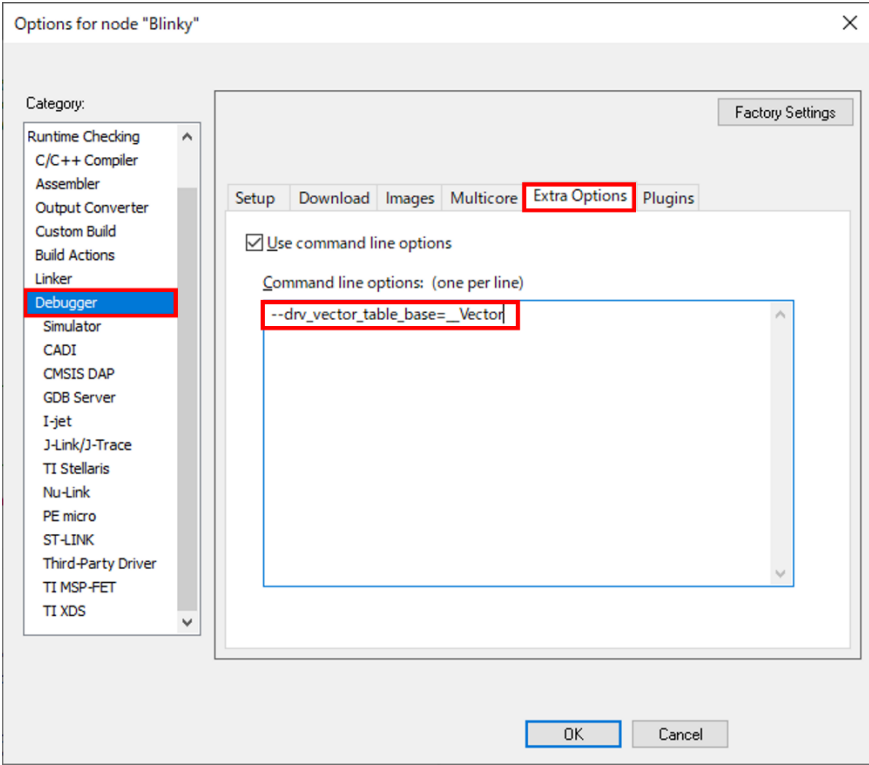
Limitation	The Memory Region Usage of ATCM displayed in the Memory Usage window of e² studio is smaller than the actual size by Memory Region Usage of DUMMY.
Target	RZ/N2L
Category	e² studio
Description	<p>The Memory Region Usage of DUMMY shown in the Memory Usage window is the region used by the system. The DUMMY is placed in ATCM, however Memory Region Usage of ATCM does NOT include its size.</p> <p>Therefore, please note that the Memory Region Usage of ATCM displayed is smaller than the actual size by the Memory Region Usage of DUMMY.</p> 

No. 7

Limitation	When debugging RAM execution without flash memory project with program written to flash memory, erase flash memory before debugging.
Target	RZ/T2M, RZ/T2L, RZ/T2ME, RZ/N2L
Category	e² studio
Description	<p>If you run a RAM execution without flash memory project with a program written in flash memory, it may be impossible to debug the project.</p> <p>When erasing flash memory, please follows the guide in</p> <p>Appendix. How to Erase Flash Memory</p>

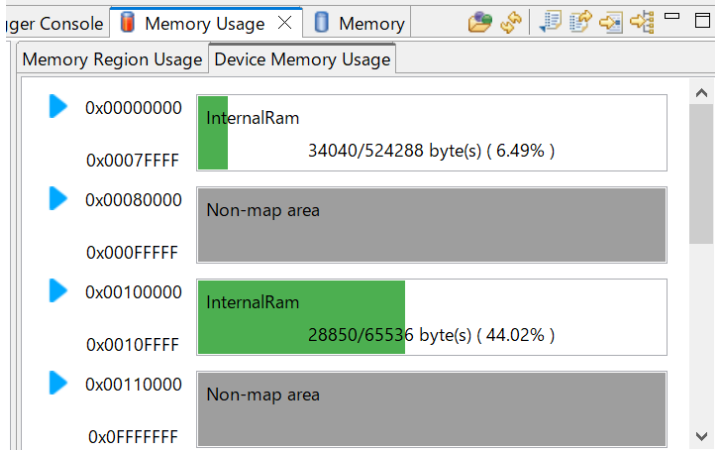
(Continued on next page)

No. 8

Limitation	Applying RZ/T2 FSP v.1.2.0 pack to a project that is already working with RZ/T2M FSP v.1.1.0 causes an error when connecting the debugger.
Target	RZ/T2M
Category	IAR EWARM
Description	<p>An error occurs when connecting to the debugger because the function name of vector table was changed in RZ/T2 FSP v.1.2.0.</p> <p>Change the following command in the “command line options (one per line)” to</p> <ul style="list-style-type: none"> • (Before change) <code>--drv_vector_table_base=vector_table</code> • (After change) <code>--drv_vector_table_base=__Vector</code> 

(Continued on next page)

No. 9

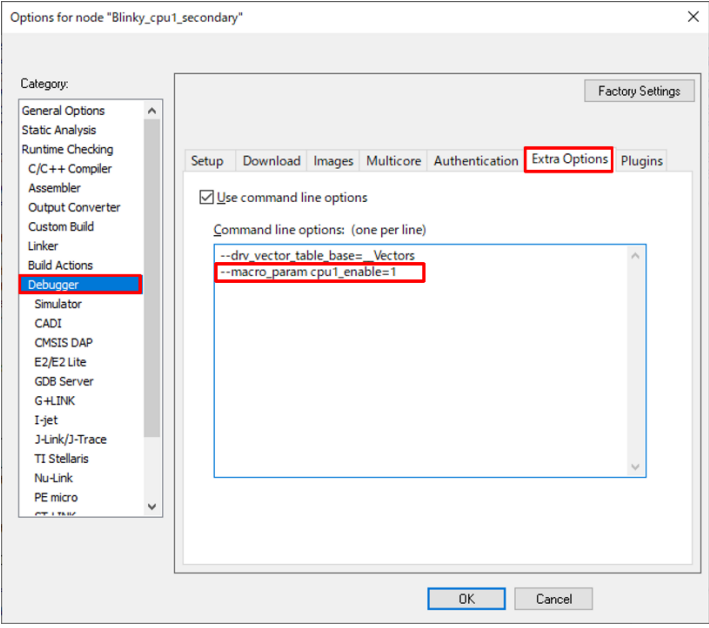
Limitation	The Device Memory Usage of CPU1 in the Memory Usage window does not work properly.
Target	RZ/T2M, RZ/T2ME
Category	e² studio
Description	<p>The Device Memory Usage in the Memory Usage window, it cannot distinguish between CPU0 and CPU1.</p> <p>When debugging CPU1, the memory area available for CPU1 should be displayed, but the memory area available for CPU0 is incorrectly displayed.</p> 

No. 10

Limitation	When adding the CallbackSet function using the Developer Assistance feature, the second argument needs to be changed.
Target	RZ/T2M, RZ/T2L, RZ/T2ME, RZ/N2L
Category	e² studio, Smart Configurator
Description	<p>When adding the R_XXX_CallbackSet() function (XXX means any module name) using the Developer Assistance feature, the second argument does not have the correct value. Please replace the second argument with "p_callback".</p> <p>An example of SCI_SPI module, adding CallbackSet() using the Developer Assistance results in the following.</p> <pre>status = R_SCI_SPI_CallbackSet(&g_spi0_ctrl, spi_callback_args_t, p_context, p_callback_memory);</pre> <p>It needs to replace the second argument with "p_callback".</p> <pre>status = R_SCI_SPI_CallbackSet(&g_spi0_ctrl, p_callback, p_context, p_callback_memory);</pre>

(Continued on next page)

No. 11

Limitation	In IAR EWARM 9.60.1, an error occurs when starting to debug multiprocessing projects of RAM execution without flash memory.
Target	RZ/T2M, RZ/T2ME
Category	IAR EWARM
Description	<p>When IAR EWARM 9.60.1 is used, there is no defined value required for debugging CPU1 project, and an error occurs when debugging begins.</p> <p>In EWARM 9.60.1, when debugging projects of multiprocessing, it is necessary to add "--macro_param cpu1_enable=1" in the "command line options (one per line)" of CPU1 project.</p> 

Appendix. How to Debug FSP Project with Flash Boot Mode

When debugging FSP project with flash boot mode (xSPI0 boot, NOR flash boot), the program cannot be stopped at the beginning of the user program (loader program). Another note on the use of flash debug boot mode is also included in this section.

Please note the following point depending on your IDE (e² studio or IAR EWARM) to debug the user program from its beginning.

1. (Both e² studio and IAR EWARM) Insert the loop part in startup.c.

When debugging is started, the debugger stops the user program (loader program) about 100ms after the device boot process (boot code). If using e² studio 2022-10 or later, the PC (program counter) is replaced at the entry point (first line in `system_init()` function) after the debugger stops, otherwise, the PC points the address of somewhere in the user program.

When debugging the program immediately after the boot process (boot code), insert the loop part in

- /rzt/fsp/src/bsp/cmsis/Device/RENESAS/Source/cr/startup_core.c, or
- /rzn/fsp/src/bsp/cmsis/Device/RENESAS/Source/startup.c

The detailed position, at which the loop part should be inserted, depends on the IDE(Debugger) and Boot mode.

IDE	Boot Mode	Position at which the loop part should be inserted.
e ² studio 2022-04 2022-07	xSPI0 boot	Line after <code>static_constructor_init</code> in <code>mpu_cache_init()</code> function. <pre>#if BSP_CFG_C_RUNTIME_INIT /* Initialize static constructors */ __asm volatile ("static_constructor_init: \n" " ldr r0, =bsp_static_constructor_init \n" " blx r0 \n" "); #endifif #if 1 // Software loops are only needed when debugging. __asm volatile (" mov r0, #0 \n" " movw r1, #0xf07f \n" " movt r1, #0x2fa \n" "software_loop: \n" " adds r0, #1 \n" " cmp r0, r1 \n" " bne software_loop \n" ":: "memory"); #endifif</pre>
	NOR flash boot	First line in <code>system_init()</code> function. <pre>BSP_TARGET_ARM BSP_ATTRIBUTE_STACKLESS void system_init (void) { #if 1 // Software loops are only needed when debugging. __asm volatile (" mov r0, #0 \n" " movw r1, #0xf07f \n" " movt r1, #0x2fa \n" "software_loop: \n" " adds r0, #1 \n" " cmp r0, r1 \n" " bne software_loop \n" ":: "memory"); #endifif __asm volatile ("set_hactlr: \n" " MOVW r0, %[bsp_hactlr_bit_l] \n" /* Set HACTLR bits(L) */ " MOVT r0, #0 \n" " MCR p15, #4, r0, c1, c0, #1 \n" /* Write r0 to HACTLR */ "::[bsp_hactlr_bit_l] "i" (BSP_HACTLR_BIT_L) : "memory");</pre>
e ² studio 2022-10 or later	xSPI0 boot	First line in <code>system_init()</code> function. <pre>BSP_TARGET_ARM BSP_ATTRIBUTE_STACKLESS void system_init (void) { #if 1 // Software loops are only needed when debugging. __asm volatile (" mov r0, #0 \n" " movw r1, #0xf07f \n" " movt r1, #0x2fa \n" "software_loop: \n" " adds r0, #1 \n" " cmp r0, r1 \n" " bne software_loop \n" ":: "memory"); #endifif __asm volatile ("set_hactlr: \n" " MOVW r0, %[bsp_hactlr_bit_l] \n" /* Set HACTLR bits(L) */ " MOVT r0, #0 \n" " MCR p15, #4, r0, c1, c0, #1 \n" /* Write r0 to HACTLR */ "::[bsp_hactlr_bit_l] "i" (BSP_HACTLR_BIT_L) : "memory");</pre>
	NOR flash boot	
IAR EWARM		

Appendix. How to Erase Flash Memory

If you run a RAM execution without flash memory project with a program written in flash memory, it may be impossible to debug the project.

Please erase flash memory by following steps depending on your IDE (e² studio or IAR EWARM) before running the project.

1. e² studio

If you would like to erase the flash memory on RSK using J-Link Commander, execute the following steps.

- i) Set the switch for boot mode on RSK to correspond to the area to be erased.
- ii) Open the J-Link Commander.

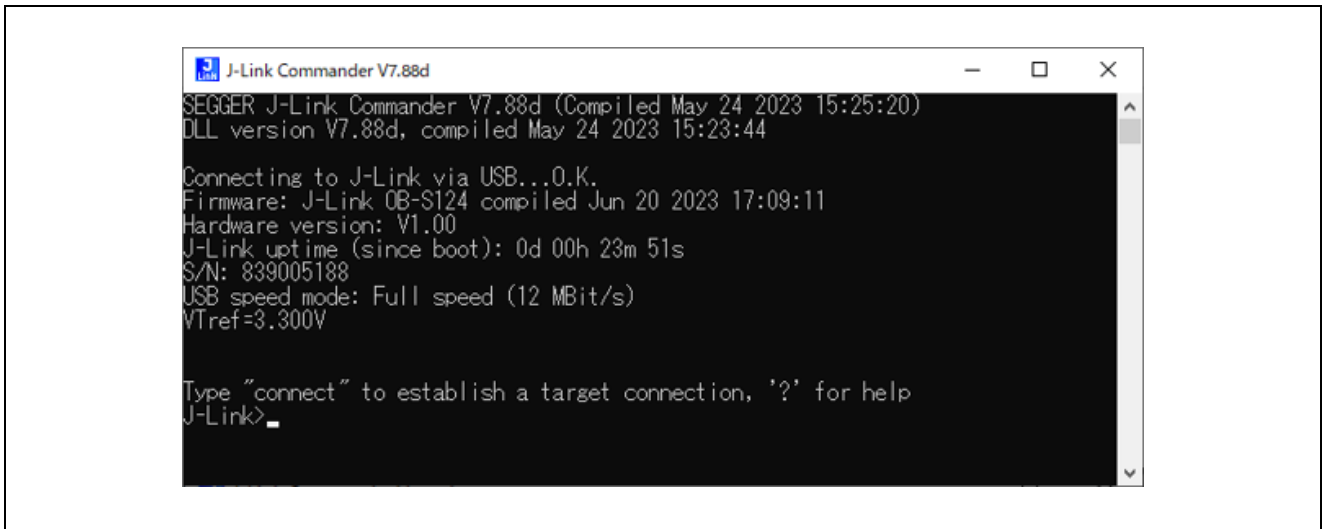


Figure 89 : Launch J-Link Commander

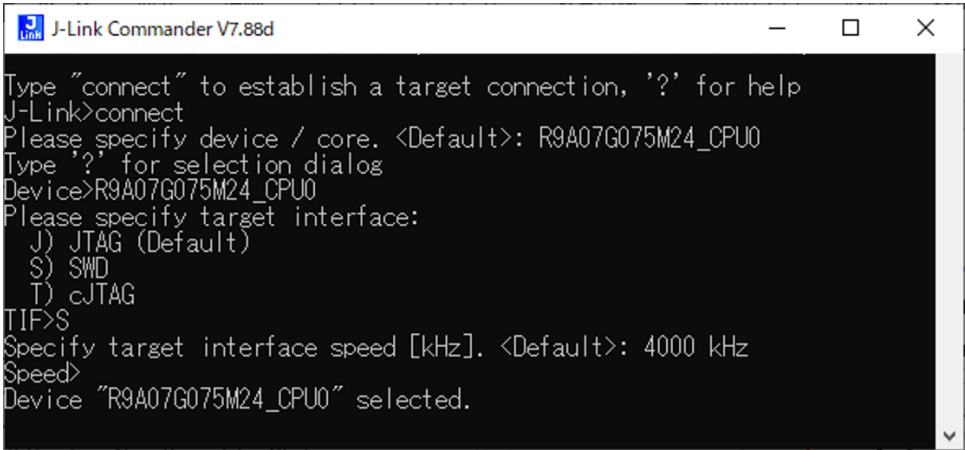
- iii) First, type “connect” to establish a target connection and press enter. Next, specify the connection conditions as follows.
 - Device> (Device type name)

Table 8 Device type name on Renesas Starter Kit+

RSK	Device type name
RSK + RZ/T2M	R9A07G075M24_CPU0
RSK + RZ/T2L	R9A07G074M04
RSK + RZ/T2ME	R9A07G075M29_CPU0
RSK + RZ/N2L	R9A07G084M04

- TIF>S
- Speed> (Default: press enter without inputting any data)

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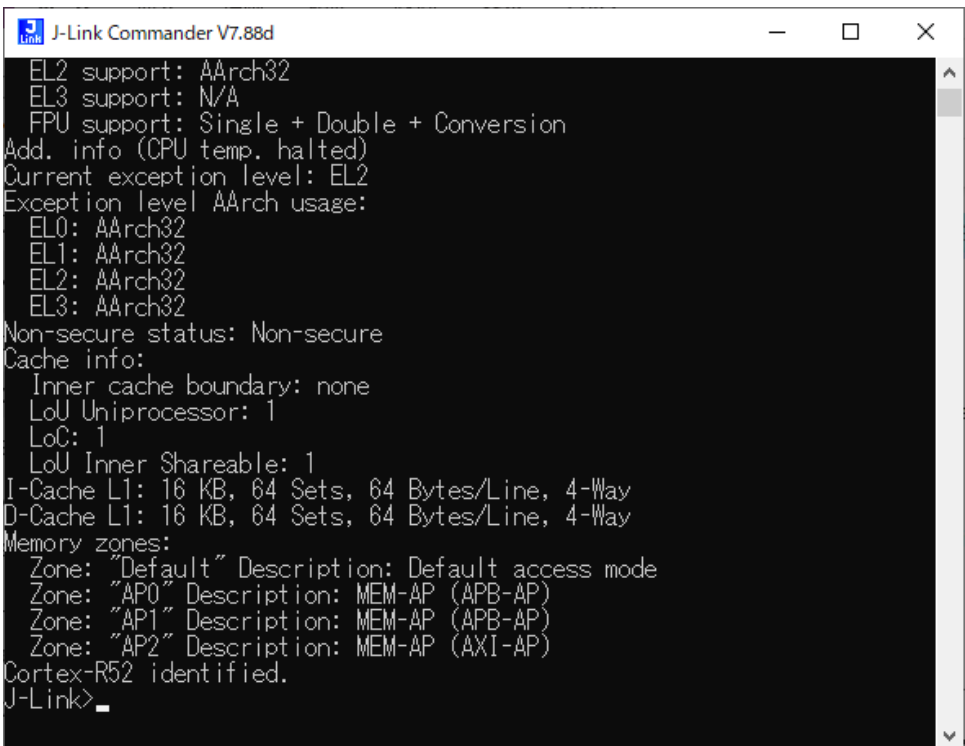
```

J-Link Commander V7.88d
Type "connect" to establish a target connection, '?' for help
J-Link>connect
Please specify device / core. <Default>: R9A07G075M24_CPU0
Type '?' for selection dialog
Device>R9A07G075M24_CPU0
Please specify target interface:
  J) JTAG (Default)
  S) SWD
  T) cJTAG
TIF>S
Specify target interface speed [kHz]. <Default>: 4000 kHz
Speed>
Device "R9A07G075M24_CPU0" selected.

```

Figure 90 : Initial setup for connecting to the device

After that, confirm the message "Cortex-R52 identified." Is displayed.



```

J-Link Commander V7.88d
EL2 support: AArch32
EL3 support: N/A
FPU support: Single + Double + Conversion
Add. info (CPU temp. halted)
Current exception level: EL2
Exception level AArch usage:
  EL0: AArch32
  EL1: AArch32
  EL2: AArch32
  EL3: AArch32
Non-secure status: Non-secure
Cache info:
  Inner cache boundary: none
  LoU Uniprocessor: 1
  LoC: 1
  LoU Inner Shareable: 1
I-Cache L1: 16 KB, 64 Sets, 64 Bytes/Line, 4-Way
D-Cache L1: 16 KB, 64 Sets, 64 Bytes/Line, 4-Way
Memory zones:
  Zone: "Default" Description: Default access mode
  Zone: "AP0" Description: MEM-AP (APB-AP)
  Zone: "AP1" Description: MEM-AP (APB-AP)
  Zone: "AP2" Description: MEM-AP (AXI-AP)
Cortex-R52 identified.
J-Link>_

```

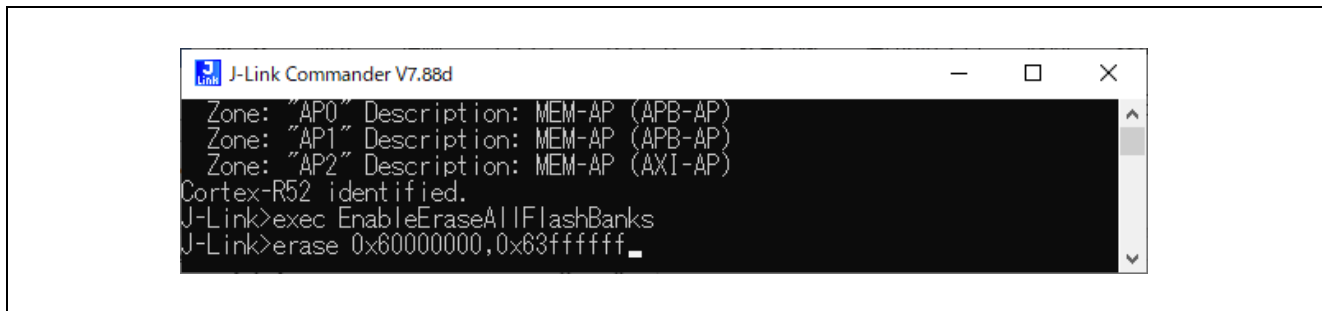
Figure 91 : Message of device core identification

- iv) Use the commands below to enable flash erase and erase the flash memory.
- J-Link>exec EnableEraseAllFlashBanks
 - J-Link>erase (Start address), (Endaddress)

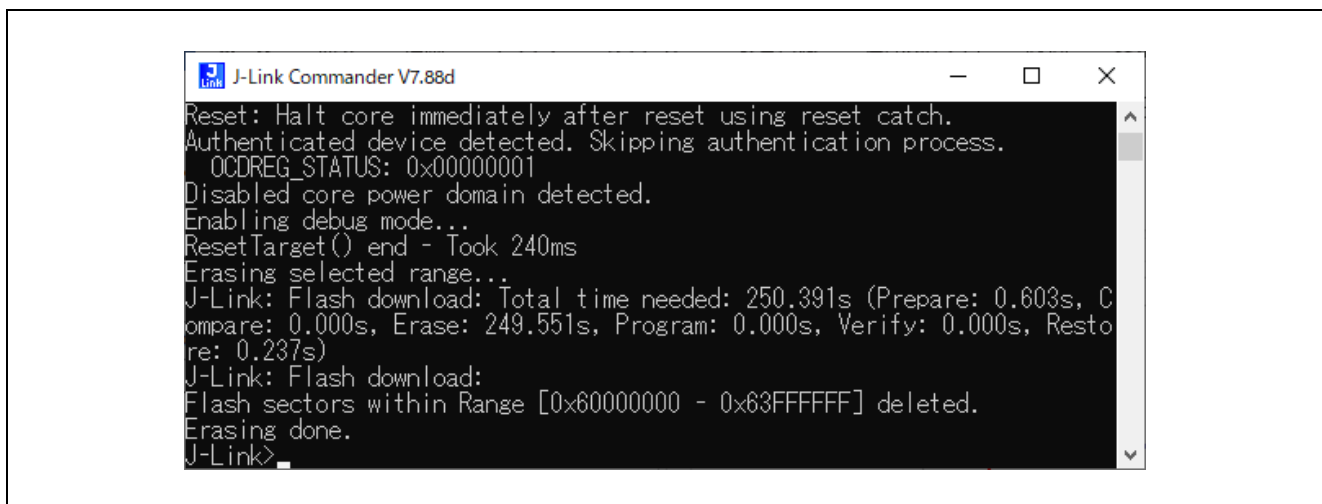
(Continued on next page)

Table 9 External address space to be used in each boot mode

RSK	Boot mode	External address space to be used	Start address	End address
RSK + RZ/T2M, RSK + RZ/T2ME	xSPI0 x1	xSPI0 CS0	0x60000000	0x63FFFFFF
	16-bit bus	CS0	0x70000000	0x71FFFFFF
RSK + RZ/T2L	xSPI0 x1	xSPI0 CS0	0x60000000	0x63FFFFFF
	xSPI1 x1	xSPI1 CS0	0x68000000	0x68FFFFFF
RSK + RZ/N2L	xSPI0 x1	xSPI0 CS0	0x60000000	0x63FFFFFF
	16-bit bus	CS0	0x70000000	0x71FFFFFF

**Figure 92 : Specify erase range**

After that, confirm the message “Erasing done.” Is displayed.

**Figure 93: Message of flash memory erase complete**

- v) Enter “q” to exit J-Link Commander.

(Continued on next page)

2. IAR EWARM

If you want to erase the flash memory on RSK using IAR EWARM, execute the following steps.

- i) Set the switch for boot mode on RSK to correspond to the area to be erased.
- ii) Open the workspace of a project.

xxx.eww

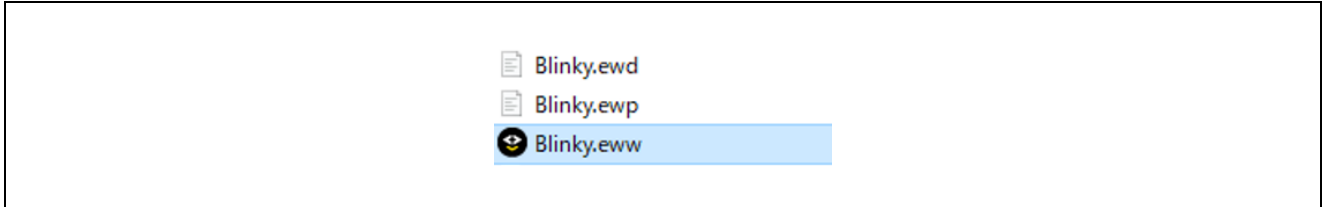


Figure 94 : Open workspace for IAR EWARM

- iii) Select “Project” -> “Download” -> “Erase memory”.

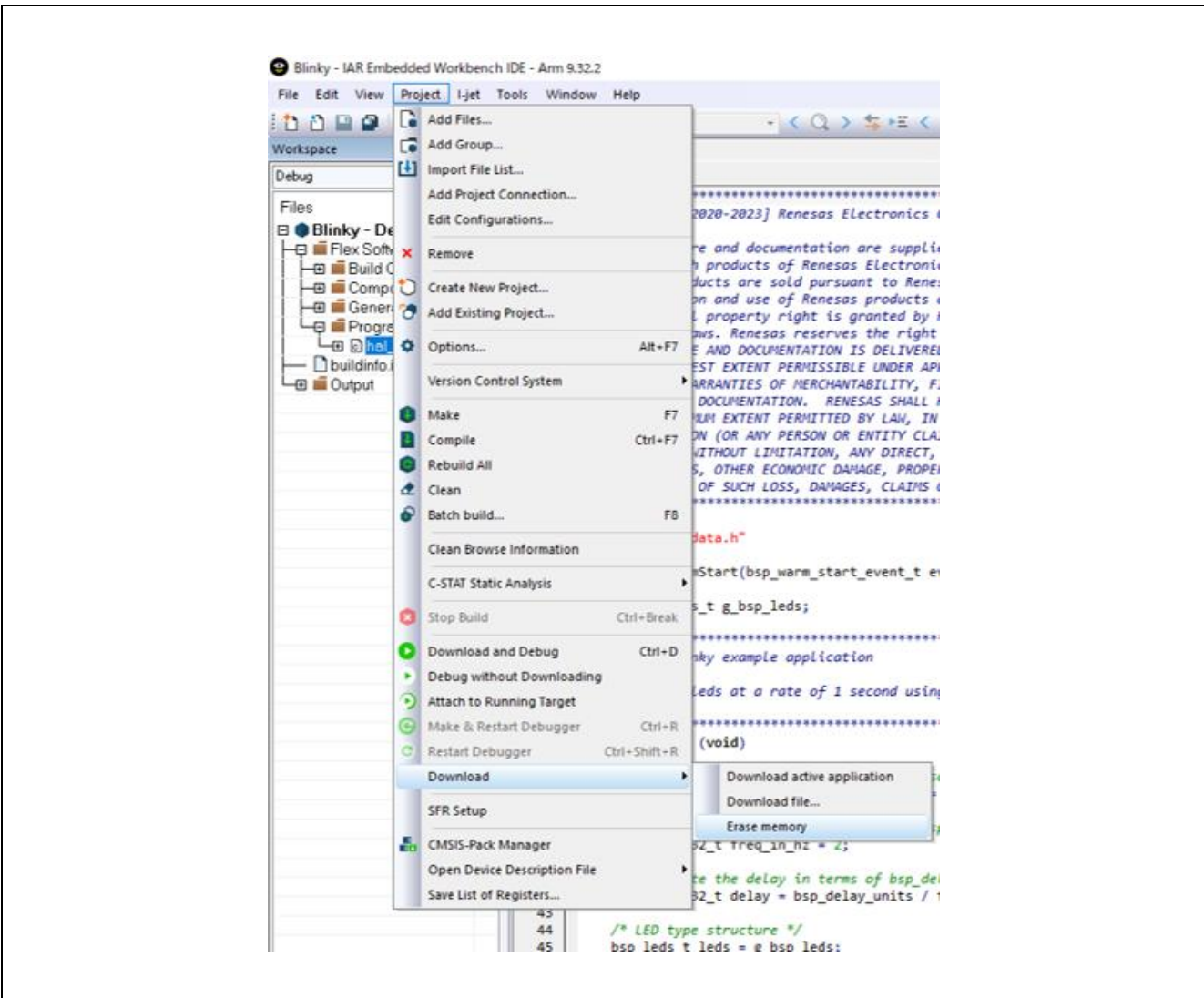


Figure 95 : Select erase memory command

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- iv) Select erase memory space.

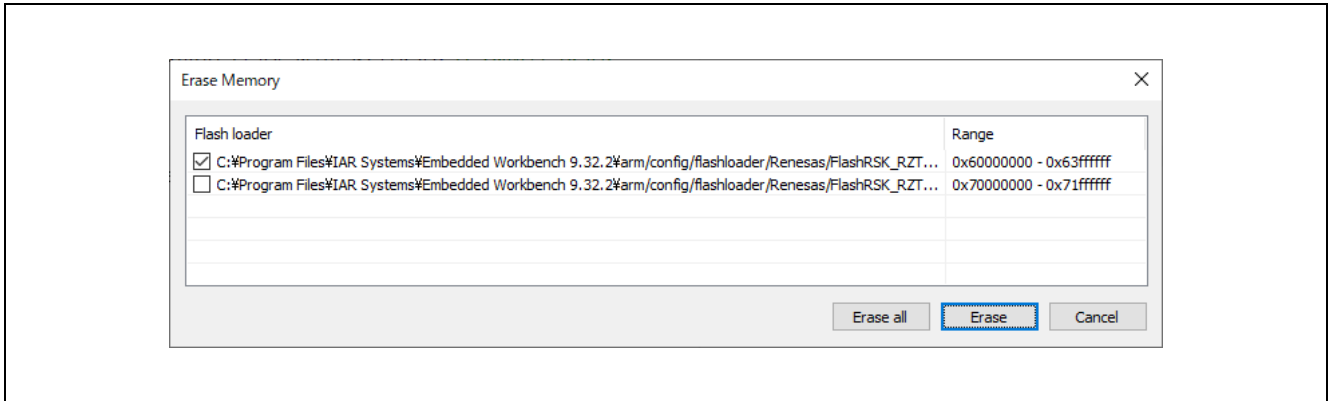


Figure 96 : Select erase memory space

- v) After the following dialog appears, erasing of the flash is complete if no error occurs.

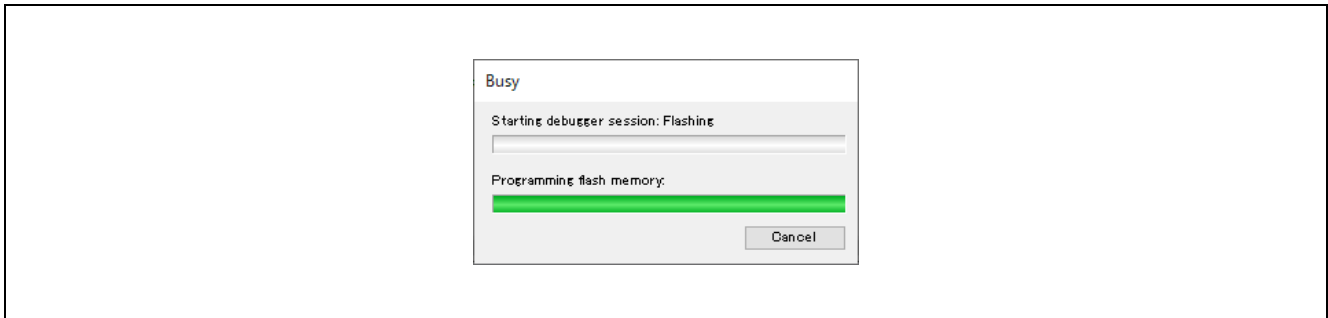


Figure 97 : Screen during erasing

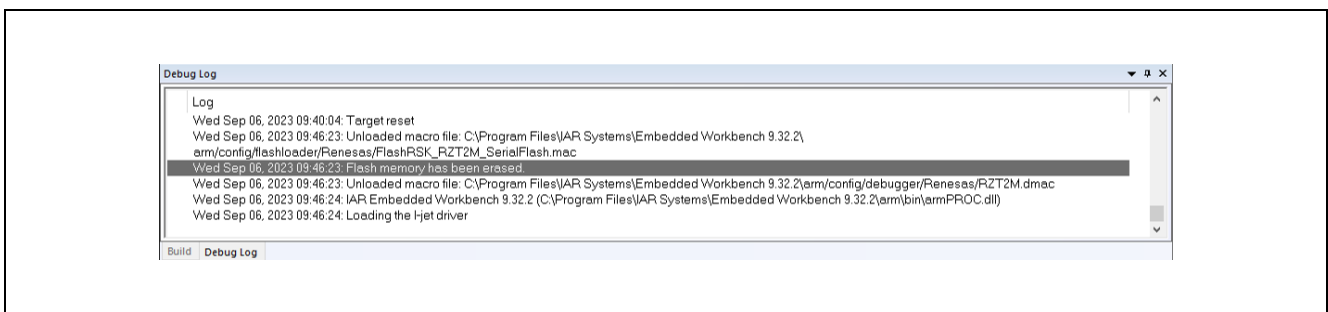


Figure 98 : Message of flash memory erase complete

Appendix. How to Change Boot Mode of FSP Project

When the boot mode of the project is changed, the Pin Configuration needs to be recreated.

It also needs to rename and save the pin configuration to retain the original one before changing the boot mode.

For example, one of specific cases in which re-configure is necessary is when a RAM execution without flash memory project is changed to flash boot mode (xSPI0 x1 boot mode and others).

Please change the boot mode by following steps.

Note for FSP version earlier than v1.3.0:

If the FSP version of your project is earlier than FSP v1.3.0, change it to FSP v1.3.0 before doing the following steps.

1. Rename and save the current Pin Configuration in the **Pins** tab.
 - How to rename Pin Configuration: Click “Manage Configurations...”

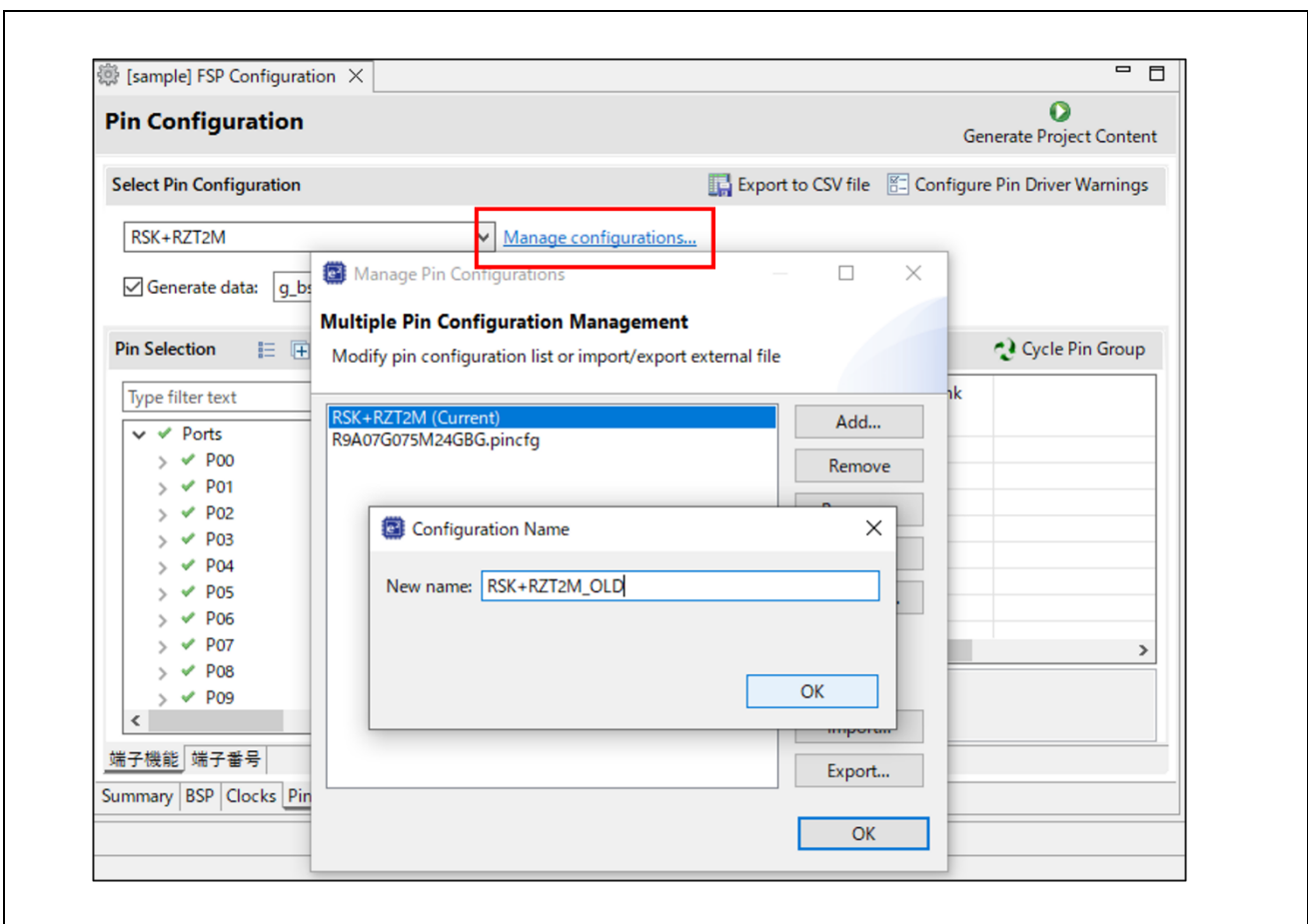


Figure 99: How to rename Pin Configuration

(Continued on next page)

2. Change the boot mode in the **BSP** tab. (The board must be the same as before the change.)

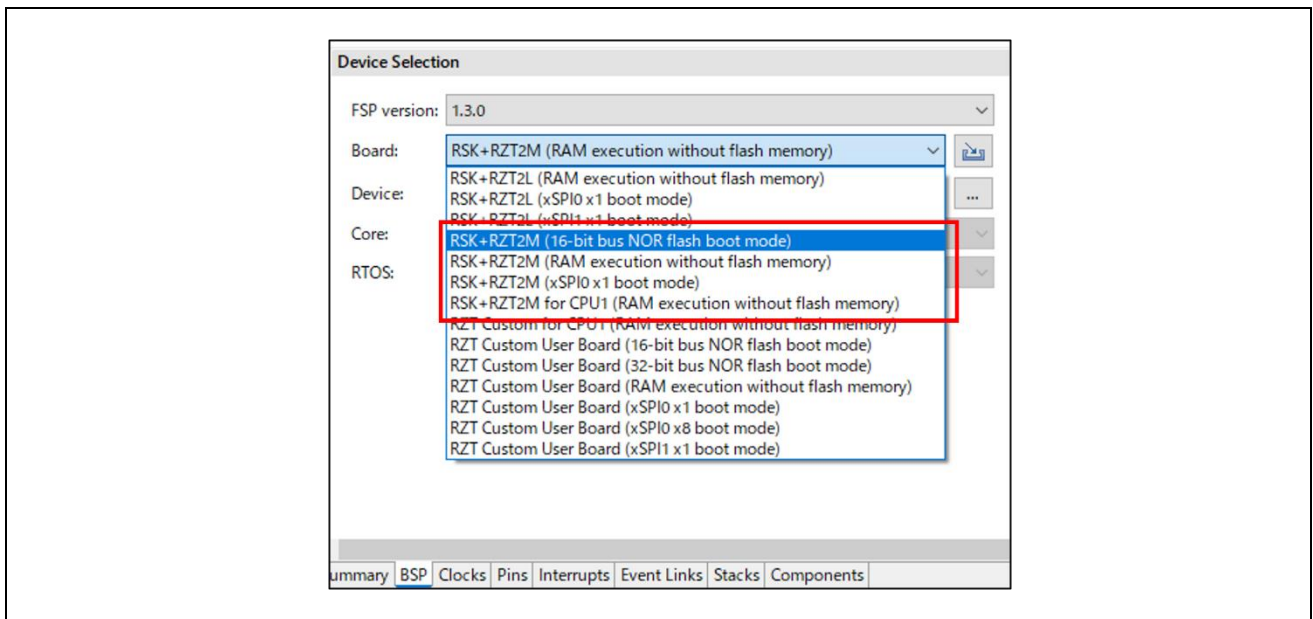


Figure 100: Change the boot mode in the BSP tab

3. Reselect “FSP Version” from the drop-down list.
(This operation is necessary even if there is only one version in the list.)

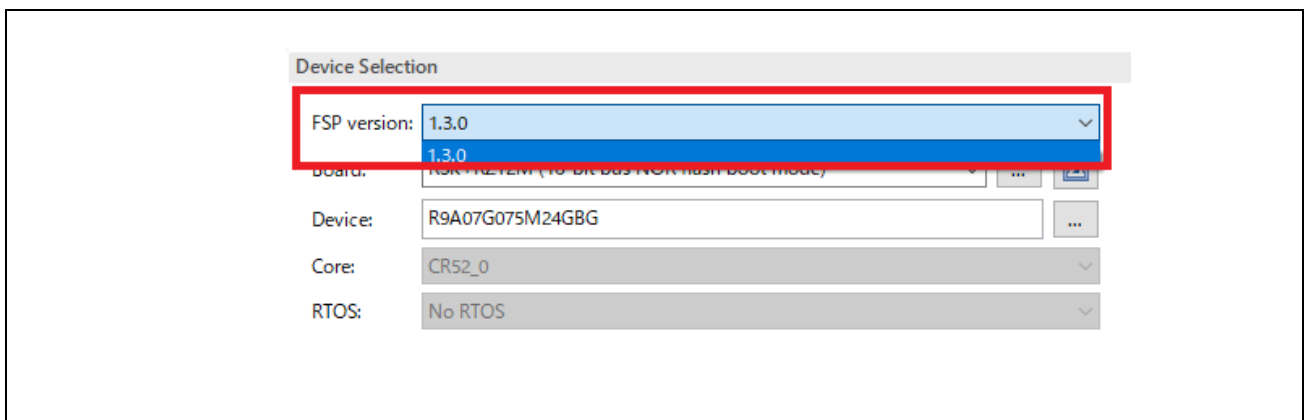


Figure 101: Reselect “FSP Version” from the drop-down list

(Continued on next page)

- 4. Uncheck "Generate data" in the **Pins** tab.

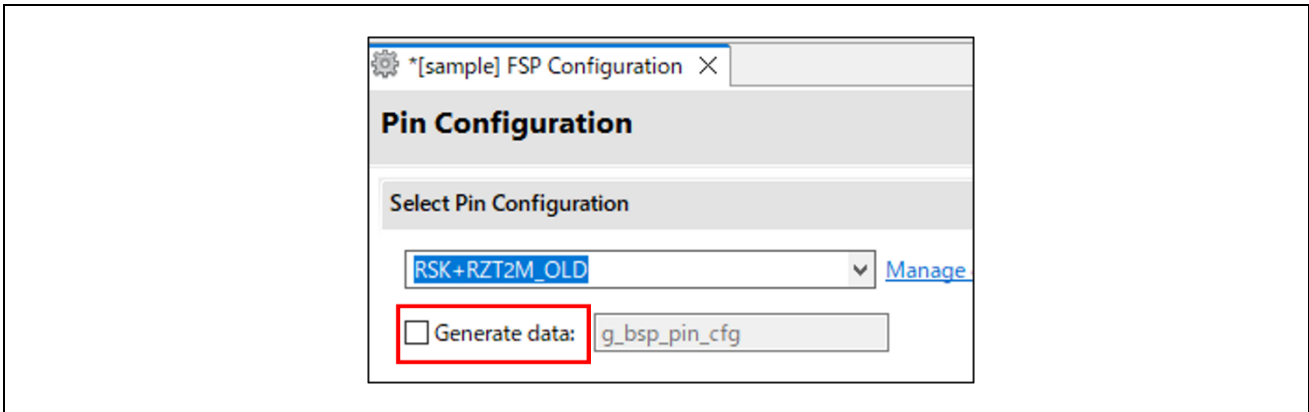


Figure 102: Uncheck Generate data in the Pins tab

- 5. Select the regenerated configuration for the board.

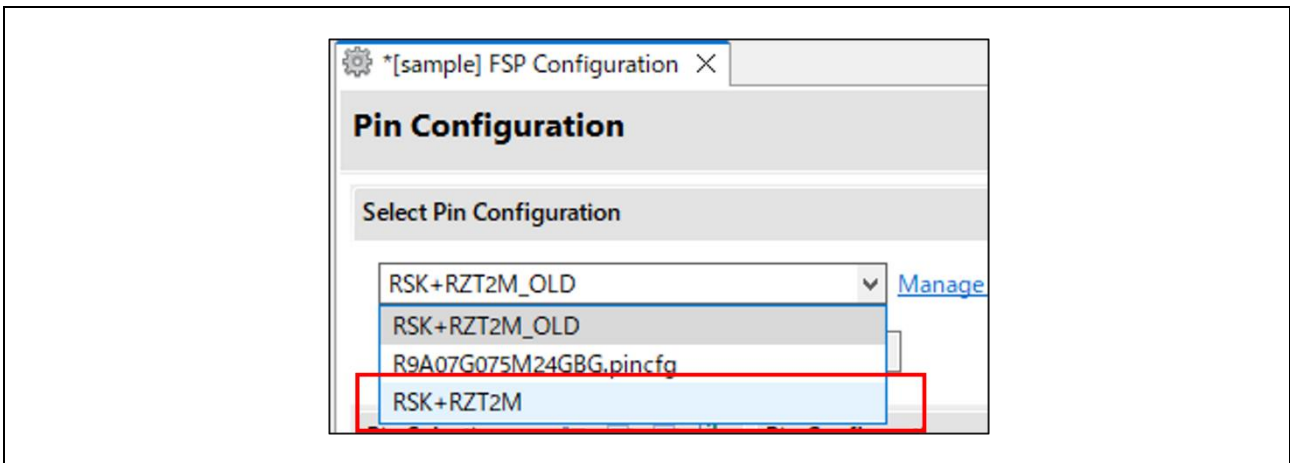


Figure 103: Select the regenerated configuration for the board

- 6. Check "Generate data" again and enter "g_bsp_pin_cfg" as the name.

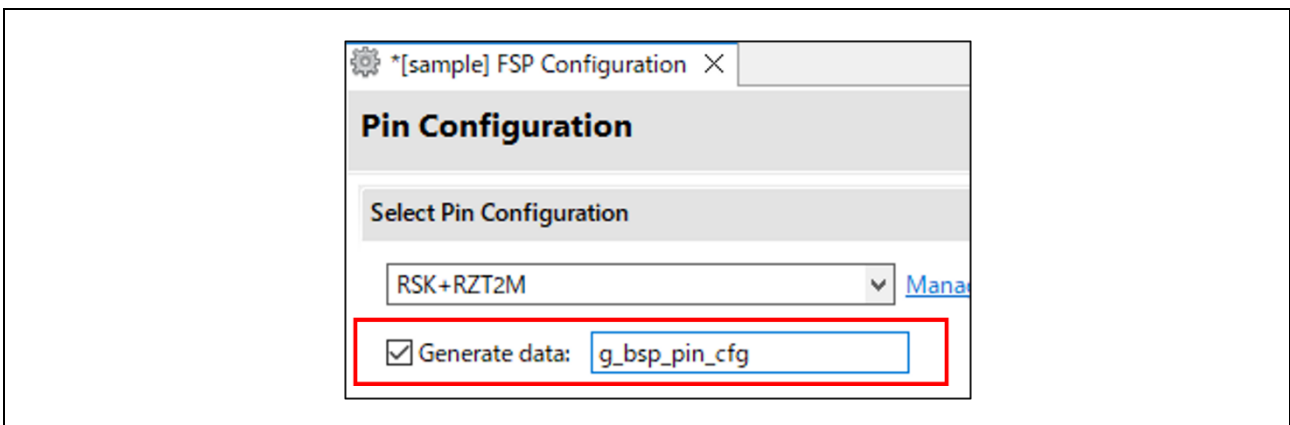


Figure 104: Check Generate data again

Appendix. How to Debug FSP multiprocessing projects with Flash Boot Mode

In the case of multi-processing with flash boot mode(xSPI0 boot, NOR flash boot), the debugging procedure is different from RAM execution without flash memory described in 4.7 Debug and Run for Multiprocessing and 5.3.5 Debug for Multiprocessing. Please create and debug FSP multiprocessing projects with flash boot mode by following steps.

1. e² studio

- i) Create projects according to the procedures in 4.3 Create a New Project for Blinky. However, select the flash boot mode to be used in the No. 6 procedure.
 - RZ/T series
 - **RSK+RZT2M (16-bit bus NOR flash boot mode)** or **RSK+RZT2M (xSPI0 x1 boot mode)**
 - **RSK+RZT2ME (16-bit bus NOR flash boot mode)** or **RSK+RZT2ME (xSPI0 x1 boot mode)**

Insert the loop part in startup_core.c with reference to Appendix. How to Debug FSP Project with Flash Boot Mode

- ii) Build the projects using the following steps.
 - a. Create and build the primary project. (1st build of the primary project)
No build setting is required, proceed to 4.4.1 Build.
 - b. Create the secondary project. Change the project property setting and build it.
Set the following before building:
 - b-1. Click **Project > Properties**.

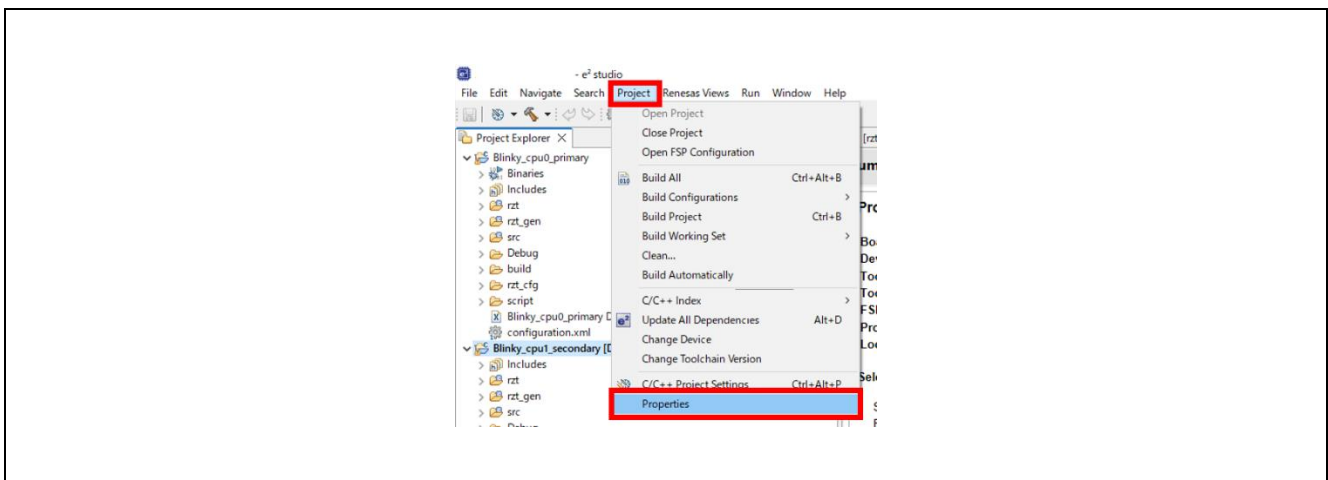


Figure 105 e² studio Project Properties

(Continued on next page)

b-2. Click **C/C++ Build > Settings > Build Steps**.

b-3. Add command at **Post-build steps**.

```
arm-none-eabi-objcopy -I elf32-littlearm -O binary ${ProjName}.elf secondary.bin && arm-none-eabi-objcopy -I binary -O elf32-littlearm -B arm --rename-section .data=.secondary,alloc,data,readonly,load,contents secondary.bin secondary.o
```

b-4. Proceed to 4.4.1 Build.

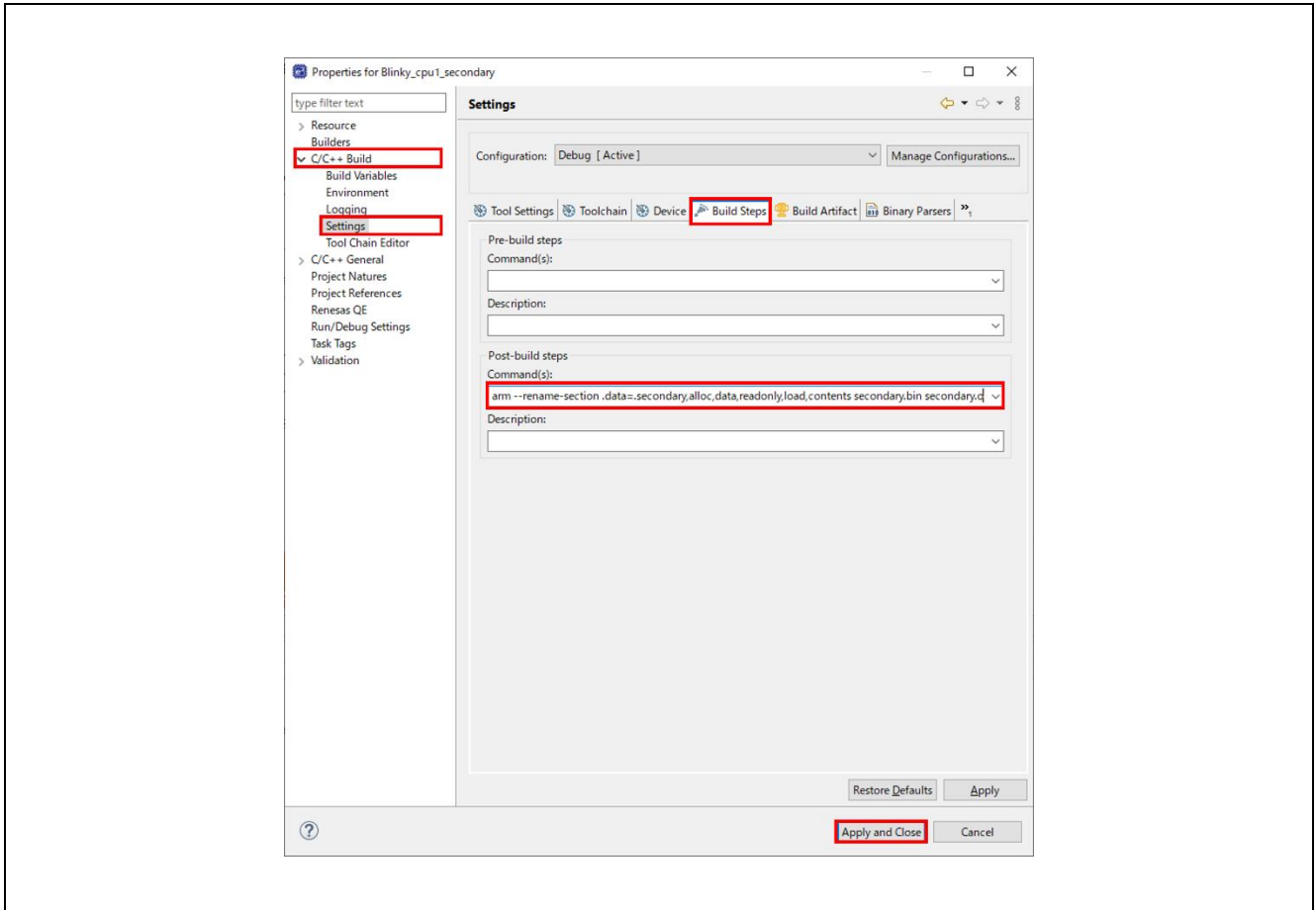


Figure 106 e² studio Build Setting for the Secondary Project

(Continued on next page)

- c. Change the project property setting of the primary project and build it. (2nd build of the primary project)
Set the following before building:
- c-1. Click **Project > Properties**.
 - c-2. Click **C/C++ Build > Settings > Tool Settings > Cross ARM C Linker > Miscellaneous**.
 - c-3. Set a file path of secondary.o in the secondary project to **Other objects**.
`$(workspace_loc:/Blinky_cpu1_secondary/Debug/secondary.o)`
 - c-4. Click **Apply and Close**.
- d. Proceed to 4.4.1 Build.

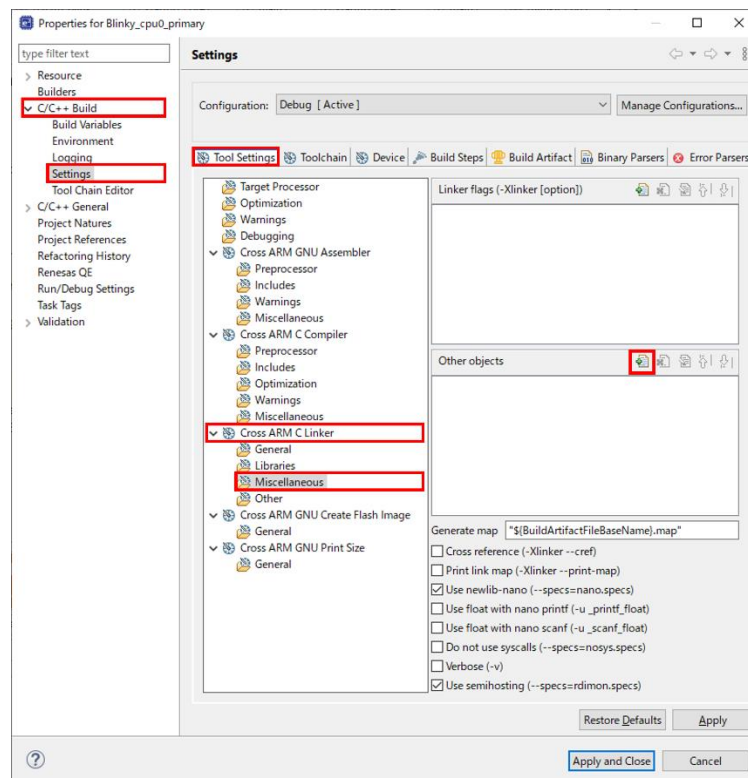


Figure 107 e² studio Build Setting for the Primary Project (Part 1)

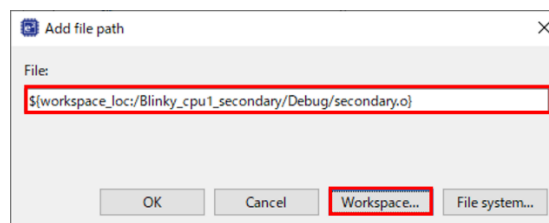


Figure 108 e² studio Build Setting for the Primary Project (Part 2)

iii) Debug the projects according to the procedures in 4.7 Debug and Run for Multiprocessing.

The flash boot mode differs from RAM execution without flash memory in two points.

- Both the primary and secondary project binaries are downloaded to the device when connecting debugger with the primary project.
- No need to change Debug Configuration from the default settings in the No. 3 procedure in 4.5.2 Debug Steps.
 - **Debugger > Connection Settings > Connection**
 - **Reset after download: Yes**
 - **Set CPSR(5bit) after download: No**

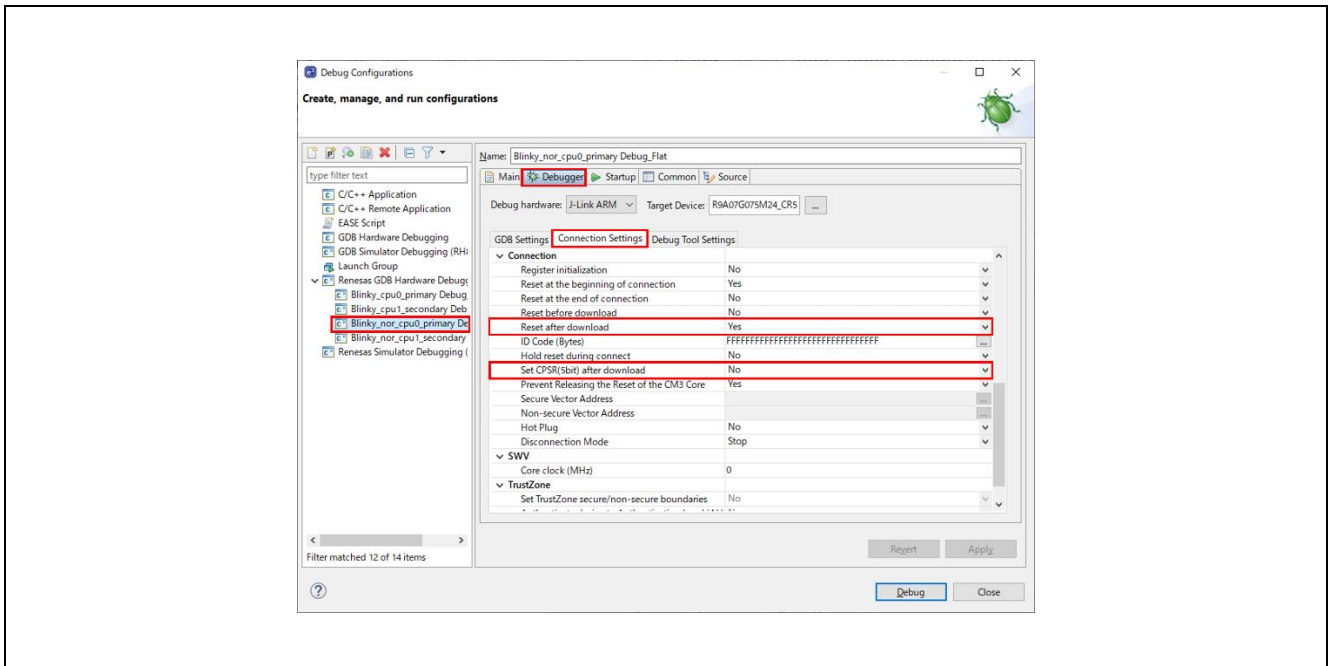


Figure 109 e² studio Debug Configuration Settings for the project in flash boot mode

iv) When changing the project and debugging it again, follow these steps.

- a. Build the primary project.
- b. Build the secondary project.
- c. Build the primary project again.
- d. Debug the projects as the procedure iii.

2. IAR EWARM

i) Create projects according to the procedures in 5.3.2 Create a New Project. However, select the flash boot mode to be used in the No. 4 procedure.

- RZ/T series
 - **RSK+RZT2M (16-bit bus NOR flash boot mode) or RSK+RZT2M (xSPI0 x1 boot mode)**
 - **RSK+RZT2ME (16-bit bus NOR flash boot mode) or RSK+RZT2ME (xSPI0 x1 boot mode)**

Insert the loop part in startup_core.c with reference to Appendix. How to Debug FSP Project with Flash Boot Mode

(Continued on next page)

- ii) Build the projects by the following order.
 - a. Create and build the primary project. (1st build of the primary project)
No setting is required, proceed to 5.3.3.2 Build.
 - b. Create the secondary project. Change the project options setting and build it.
Set the following before building:
 - b-1. Click **Project** > **Options....**
 - b-2. Click **Debugger** > **Setup.**
 - b-3. Uncheck "Run to".
 - b-4. Click **Output Converter** > **Output.**
 - b-5. Set **Raw binary** to **Output format.**
 - b-6. proceed to 5.3.3.2 Build.
 - b-7. Close the secondary project.

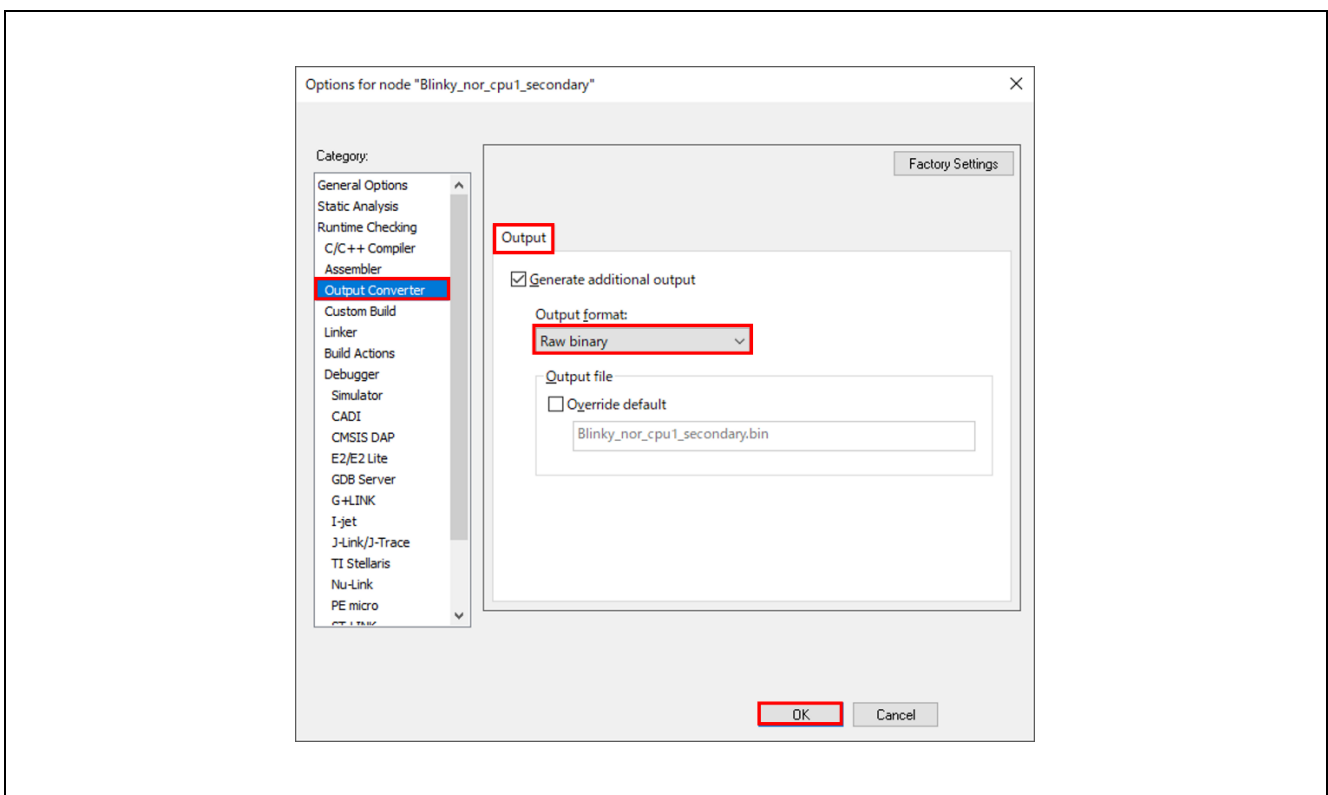


Figure 110 IAR EWARM project options for the secondary project in flash boot mode

(Continued on next page)

- c. Change the project options setting of the primary project and build it. (2nd build of the primary project)

Set the following before building:

c-1. Click **Project > Options....**

c-2. Click **Debugger > Setup.**

c-3. Uncheck "Run to".

c-4. Click **Linker > Input.**

c-5. Set the following contents:

- Keep symbols: (one per line)
 - SECONDARY
- Raw binary image
 - File: the path of binary file in the secondary project.
e.g.
\$PROJ_DIR\$\.Blinky_nor_cpu1_secondary\Debug\Exe\Blinky_nor_cpu1_secondary.bin
 - Symbol: SECONDARY
 - Section: SECONDARY
 - Align: 4

c-6. Proceed to 5.3.3.2 Build.

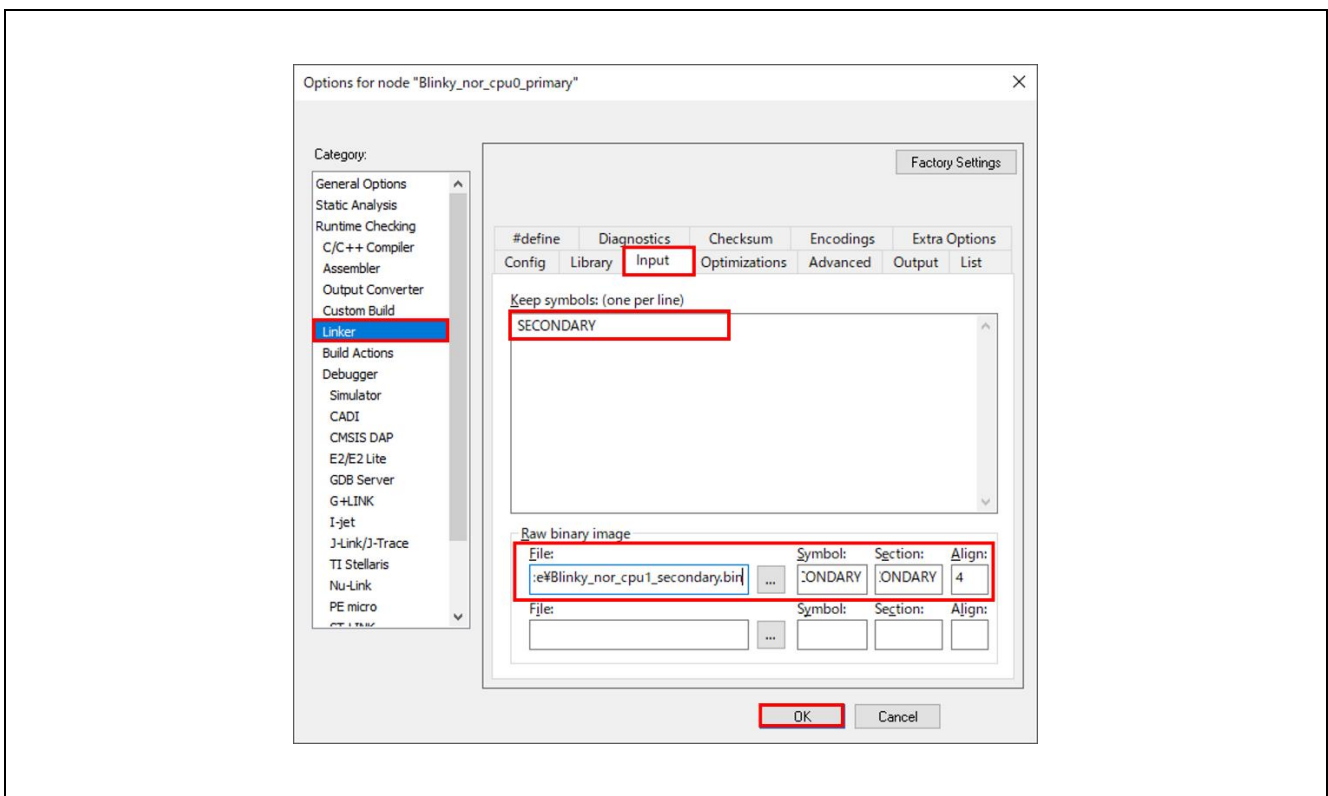


Figure 111 IAR EWARM project options for the primary project in flash boot mode

(Continued on next page)

- iii) Debug the projects by the following order.
 - a. Open the primary project and close the secondary project on IAR EWARM.
 - b. Click **Project > Download > Download file....**



Figure 112 IAR EWARM Download File

- c. Select out file of the primary project.
e.g. \$PROJ_DIR\$\..\Blinky_nor_cpu0_primary\Debug\Exe\Blinky_nor_cpu0_primary.out
- d. Change the project options setting of the primary project.
 - d-1. Click **Project > Options....**
 - d-2. Click **Debugger > Multicore.**
 - d-3. Set the following contents in Asymmetric multicore.
 - Simple
 - Partner workspace: the eww file path of the secondary project.
e.g. \$PROJ_DIR\$\..\Blinky_nor_cpu1_secondary\Blinky_nor_cpu1_secondary.eww
 - Partner project: Blinky_nor_cpu1_secondary
 - Partner configuration: Debug

(Continued on next page)

- e. Click **Project > Debug without Downloading** of the primary project.

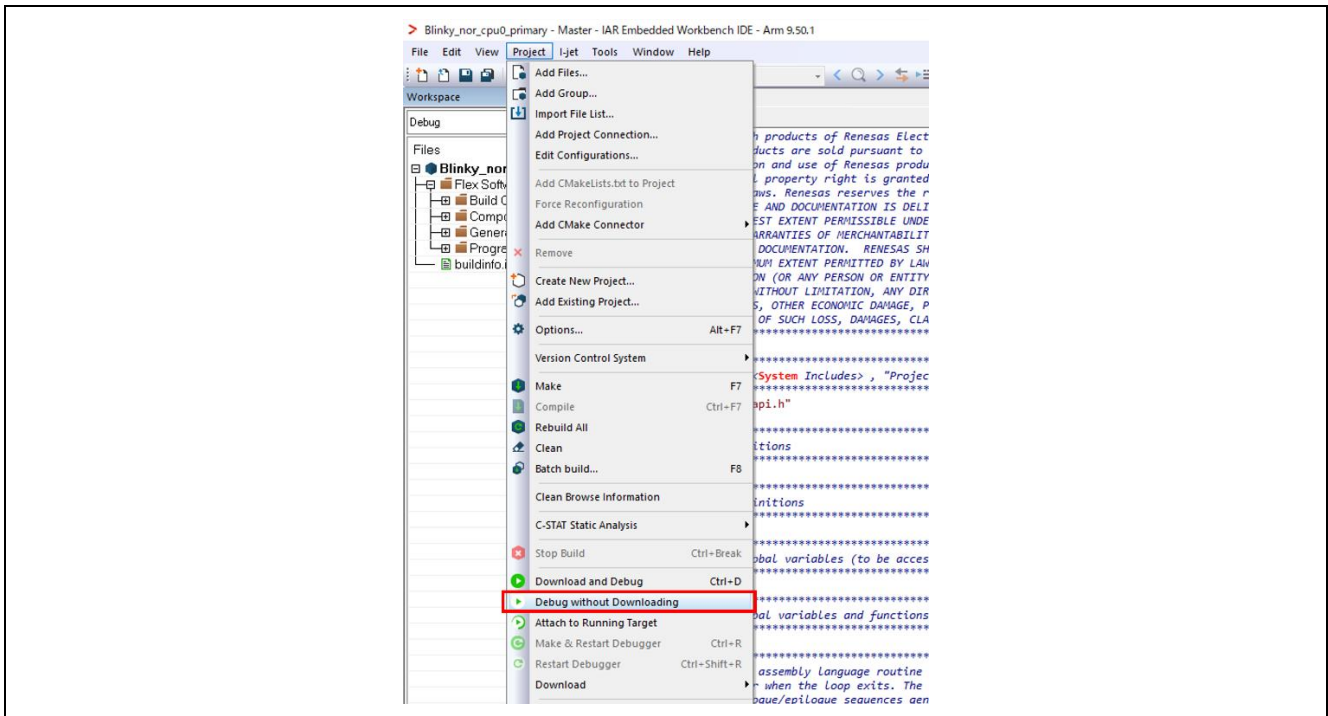


Figure 113 IAR EWARM Debug without Downloading

- f. The secondary project is automatically launched.
- g. Run the program of primary project. If the LED0 and LED1 are blinking, proceed to the next step.
- h. The primary project in operation, run the program of secondary project.
- i. When exiting Debug and disconnect from the debugger, if debugging is stopped in one of the projects, either the primary or the secondary, the other will automatically stop as well.
- iv) When changing the project and debugging it again, follow these steps.
- a. Disable asymmetric multicore setting.
 - a-1. Click **Project > Options...**
 - a-2. Click **Debugger > Multicore**.
 - a-3. Select **Disable** in Asymmetric multicore.
 - b. Build the primary project.
 - c. Build the secondary project.
 - d. Build the primary project again.
 - e. Debug the projects as the procedure iii.

Revision History

Rev.	Date	Description	
		Page	Summary
1.00	Jun.7.22	-	First Edition issued
1.01	Aug.9.22	-	Added the RZ/N2L device as target device.
		All	Unified some terminologies.
		p.9	Updated “SEGGER J-Link” section. <ul style="list-style-type: none"> Added the software environment on which FSP projects are verified.
		p.13	Added the “2.5.1 RSK+RZN2L” section.
		p.19	Updated “e ² studio Prerequisites” <ul style="list-style-type: none"> Updated the Windows PC requirements.
		p.37	Update “Prerequisites” section <ul style="list-style-type: none"> Added the note regarding the patch for debugging RZ/N2L FSP project on EWARM.
		p.38	Updated “Create a New Project” section. <ul style="list-style-type: none"> Added installation path of FSP SC. Added some steps for creating a EWARM project. Added Note subsection for debugging RZ/N2L EWARM project.
		p.58	Updated “Selecting a Board and Toolchain” section. <ul style="list-style-type: none"> Added the detailed explanation how to select Board and Device for creating a FSP project.
		p.72	Updated “Appendix. Known Issues” chapter.
		p.81	Updated “Appendix. Tool Software Limitations” section.
		-	Added “Appendix. How to update J-Link DLL files in e ² studio” chapter.
		p.93	Added “Appendix. How to Debug FSP Project with Flash Boot Mode”
1.02	Oct.31.22	-	Updated documentation for RZ/T2M FSP v1.1.0. <ul style="list-style-type: none"> Removed contents for RZ/T2M FSP v1.0.0
		All	Updated minor issues. <ul style="list-style-type: none"> Fixed minor typo. Adjusted page breaks.
		p.9	Updated “2.3.1 SEGGER J-Link” section. <ul style="list-style-type: none"> Updated the FSP version and J-Link version for RZ/T2M Added the notification that J-Link OB S124 requires the firmware update to debug RZ/T2M FSP project. Added the link to Renesas Knowledge Base which explains how to update J-Link DLL in e² studio.
		p.45	Added “5.3.2.2 NOTE: Configure IAR EWARM Project [RZ/T2M, RZ/T2L]” section.
		p.72	Updated “Appendix. Known Issues” chapter. <ul style="list-style-type: none"> Remove some limitations regarding RZ/T2M

Rev.	Date	Description	
		Page	Summary
		p.81	Updated “Appendix. Tool Software Limitations” section. <ul style="list-style-type: none"> Added new limitation of e² studio regarding J-Link OB S124 firmware version. Added the link to explain how to update J-Link DLL.
		-	Removed “Appendix. How to update J-Link DLL files in e ² studio” chapter.
1.03	Dec.23.22	-	Updated documentation for RZ/N2L FSP v1.1.0. <ul style="list-style-type: none"> Removed contents for RZ/N2L FSP v1.0.0
		All	Updated minor issues. <ul style="list-style-type: none"> Fixed minor typo.
		p.69	Updated “Appendix. Known Issues” chapter. <ul style="list-style-type: none"> Removed some limitations regarding RZ/N2L
		p.73	Updated “Appendix. Tool Software Limitations” section. Removed some limitations regarding RZ/N2L
		p.75	Updated “Appendix. How to Debug FSP Project with Flash Boot Mode” chapter. <ul style="list-style-type: none"> Added new procedure for RZ/N2L FSP v1.1.0.
1.04	Mar.23.23	All	Updated documentation for RZ/T2 FSP v1.2.0. <ul style="list-style-type: none"> Removed contents for RZ/T2M FSP v1.1.0. Added contents for RZ/T2L.
		p.1	Added video contents website link.
		p.9	Updated “2.3.1 SEGGER J-Link” section. <ul style="list-style-type: none"> Updated the FSP version and J-Link version for RZ/T2M and RZ/T2L. Removed the notification that J-Link OB S124 requires the firmware update to debug RZ/T2M FSP project.
		p.10-12	Updated “2.4.1 RSK+RZT2M” section. <ul style="list-style-type: none"> Added explanation that other boot mode board settings refer to the RSK User’s Manual. Modified figure names and added a table title.
		p.13-15	Added “2.4.2 RSK+RZT2L” section
		p.16-18	Updated “2.5.1 RSK+RZN2L” section. <ul style="list-style-type: none"> Corrected board name. Added explanation that other boot mode board settings refer to the RSK User’s Manual. Modified figure names and added a table title.
		p.23	Updated “4.3 Create a New Project for Blinky” section. <ul style="list-style-type: none"> Added RSK+RZT2L Board Setting.
		p.26	Updated “4.3.5 Where is main()?” section. <ul style="list-style-type: none"> Corrected product group name.

Rev.	Date	Description	
		Page	Summary
		p.32	Updated “4.5.4 Change CPSR Register Value” section. <ul style="list-style-type: none"> Revised description. Added description of how to automatically change CPSR register value.
		p.33	Updated “4.6 Run the Blinky Project” section. <ul style="list-style-type: none"> Removed LEDs working in CPU1 project.
		p.34	Updated “5.3.1 Prerequisites” section. <ul style="list-style-type: none"> Added note for RZ/T2L patch file.
		p.37	Updated “5.3.2 Create a New Project” section. <ul style="list-style-type: none"> Added RSK+RZT2L Board Setting.
		p.50	Updated “5.3.4 Download & Debug the Project” section. <ul style="list-style-type: none"> Removed LEDs working in CPU1 project.
		p.69	Updated “6.5 Adding and Configuring HAL Drivers” section. <ul style="list-style-type: none"> Added a table title.
		p.71-73	Updated “Appendix. Known Issues” section. <ul style="list-style-type: none"> Added a table “List of Known Issues” Numbered each issue. Removed issue of adding "r_dsmif" alone Updated issue contents that the BSP properties are sometimes configured to incorrect configuration Removed Ethernet SELECTOR issue.
		p.74-77	Updated “Appendix. Tool Software Limitations” section. <ul style="list-style-type: none"> Added a table “List of Tool Software Limitations” Numbered each limitation. Added new limitation of applying RZ/T2 FSP v.1.2.0 pack.
		p.78	Updated “Appendix. How to Debug FSP Project with Flash Boot Mode” section <ul style="list-style-type: none"> 1. (Both e² studio and EWARM) Insert the loop part in startup.c. Added e² studio 2023-01 to the table. 3. (e2 studio ONLY) Apply a macro file for RZ/N2L FSP v1.1.0 xSPI0 x1 boot mode. Added direct download URL of RZ/N2L patch file.
1.05	Jun.30.23	All	Updated documentation for RZ/N2L FSP v1.2.0. <ul style="list-style-type: none"> Removed contents for RZ/N2L FSP v1.1.0
		p.9	Updated “2.3.1 SEGGER J-Link” section. <ul style="list-style-type: none"> Updated the FSP version and e² studio version for RZ/N2L.
		p.30	Updated “4.5.2 Debug Steps” section. <ul style="list-style-type: none"> Added description of how to automatically change CPSR register value for RZ/N2L and e² studio 2023-04.
		p.33	Updated “4.5.4 NOTE: Change CPSR Register Value [RZ/T2M, RZ/T2L]” section. <ul style="list-style-type: none"> Changed section title to limit the target device

Rev.	Date	Description	
		Page	Summary
		p.35	Updated “5.3.1 Prerequisites” section. Removed EWARM Patch for RZ/N2L
		p.72-77	Updated “Appendix. Known Issues” chapter. <ul style="list-style-type: none"> Updated table “List of Known Issues” to add new issues and add N2L as target device for No.2 Added new issue related to BSP configuration when changing board setting. Added new issue related to FSP module FreeRTOS issue.
		p.78	Updated “Appendix. Tool Software Limitations” chapter. <ul style="list-style-type: none"> Removed some limitations regarding breakpoint
		p.82	Updated “Appendix. How to Debug FSP Project with Flash Boot Mode” <ul style="list-style-type: none"> Updated IDE version in the table for including e² studio 2023-04
1.06	Sep.8.23	All	Updated documentation for RZ/T2 FSP v1.3.0. <ul style="list-style-type: none"> Removed contents for RZ/T2 FSP v1.2.0 Changed GNU ARM Embedded Toolchain to version 12.2.1.arm-12-24.
		p.6	Updated “1.3.2 FSP Documentation” section. <ul style="list-style-type: none"> Added note for RZ/N2L FSP documentation.
		p.26	Updated “4.3.6 Blinky Example Code” section. <ul style="list-style-type: none"> Changed the processing of blinky template code.
		p.28	Updated “4.5.2 Debug Steps” section. <ul style="list-style-type: none"> Added reset setting of debug configuration for RAM execution without flash memory.
		p.43	Removed “5.3.2.2 NOTE: Configure IAR EWARM Project [RZ/T2M, RZ/T2L]” section.
		p.44	Updated “5.3.4 Download & Debug the Project” section. <ul style="list-style-type: none"> Changed the processing of blinky template code.
		p.68-73	Updated “Appendix. Known Issues” section. <ul style="list-style-type: none"> Updated table “List of Known Issues” to add new issues. Added new issues related to Pins configuration. Added new issue of warning message when building “r_gmac” with gcc compiler.
		p.75	Updated “Appendix. Tool Software Limitations” chapter. <ul style="list-style-type: none"> Added “Smart Configurator” section. Added new limitation of displaying memory region usage
		p.80	Updated “Appendix. How to Debug FSP Project with Flash Boot Mode” section. <ul style="list-style-type: none"> Removed limitation related to reset when using e² studio
		p.82-86	Added “Appendix. How to Erase Flash Memory” section.
1.07	Sep.29.23	All	Updated documentation for RZ/N2L FSP v1.3.0. <ul style="list-style-type: none"> Removed contents for RZ/N2L FSP v1.2.0

Rev.	Date	Description	
		Page	Summary
		p.9	Updated “2.3.1 SEGGER J-Link” section. Updated the FSP version and e ² studio version for RZ/N2L.
		p.80	Updated “Appendix. How to Debug FSP Project with Flash Boot Mode” section. <ul style="list-style-type: none"> Change the number of items. Removed limitation related to RZ/N2 FSP v1.2.0 and J-ink V7.80b only
1.08	Jan.22.24	p.6	Corrected document numbers of RSK+RZ/T2L and RSK+RZ/N2L User’s Manual
		p.68-75	Updated “Appendix. Known Issues” section. <ul style="list-style-type: none"> Moved the position of FSP Configurations and FSP Modules descriptions to the beginning of the chapter. Added column “Category” to the List Removed category headings (FSP Configurations, Stacks Configuration, FSP Module, BSP Configuration, ...) Added item “Category” to description of each Known Issues. Grayed out items where issues have been resolved. Added description to workaround of No. 3. Added RZ/T2L as target device to No. 5 Added RZ/T2M and RZ/T2L as target device to No. 6 Corrected instructions in the code of No. 14.
		p.76-80	Updated “Appendix. Tool Software Limitations” chapter. <ul style="list-style-type: none"> Added column “Category” to the List Removed category headings (Smart Configurator, FSP Smart Configurator, e² studio, ...) Added item “Category” to description of each Tool Software Limitations. Grayed out items where limitations have been resolved.
		p.87-89	Added “Appendix. How to Change Boot Mode of FSP Project” section.
1.09	Mar.29.24	All	Updated documentation for RZ/T2 FSP v2.0.0. <ul style="list-style-type: none"> Removed contents for RZ/T2 FSP v1.3.0
		p. 1	List Target Device separately for each series.
		p. 6	Updated “1.3 Related Documentation Files” section. <ul style="list-style-type: none"> List Target Device separately for each series.
		p. 9	Updated “2.3.1 SEGGER J-Link” section. <ul style="list-style-type: none"> List Target Device separately for each series in a table.
		p. 10-18	Updated “2.4 RZ/T Series Board Setup” section and added “2.5 RZ/N Series Board Setup” section. <ul style="list-style-type: none"> Each series was divided into separate explanatory chapters. Delete unnecessary figure descriptions
		p. 20	Updated “4.1 Tutorial Blinky” section. <ul style="list-style-type: none"> Added description of a multiprocessing.
		p. 21	Updated “4.3 Create a New Project for Blinky” section. <ul style="list-style-type: none"> Added description of a multiprocessing.
		p. 26	Updated “4.3.6 Blinky Example Code” section. <ul style="list-style-type: none"> Updated Blinky code.

Rev.	Date	Description	
		Page	Summary
		p. 27	Updated “4.4 Build the Blinky Project” section. <ul style="list-style-type: none"> Added description of a multiprocessing.
		p. 28	Updated “4.5.2 Debug Steps” section. <ul style="list-style-type: none"> Added description of a multiprocessing.
		p. 31	Updated “4.6 Run the Blinky Project” section. <ul style="list-style-type: none"> Added LED2-3 of RSK+RZ/T2M for CPU1 core. Added descriptions to suspend program execution and exit debug mode.
		p. 32	Added “4.7 Debug and Run for Multiprocessing” section.
		p. 33	Added “4.8 Import the Project” section.
		p. 37	Updated “5.2 Tutorial Blinky” section. <ul style="list-style-type: none"> Added description of a multiprocessing.
		p. 38	Updated “5.3.2 Create a New Project” section. <ul style="list-style-type: none"> Added description of a multiprocessing.
		p. 43	Added “5.3.2.1 NOTE: Configure IAR EWARM Project [Only RZ/N2L]” section.
		p. 43	Updated “5.3.3 Build the Project” section. <ul style="list-style-type: none"> Moved text to “5.3.3.2 Build” section.
		p. 43	Added “5.3.3.1 NOTE: Build settings [Only Multiprocessing]” section.
		p. 47	Added “5.3.3.2 Build” section.
		p. 48	Updated “5.3.4 Download & Debug the Project” section. <ul style="list-style-type: none"> Added description of a multiprocessing. Added LED2-3 of RSK+RZ/T2M for CPU1 core.
		p. 52	Added “5.3.5 Debug for Multiprocessing” section.
		p. 53	Added “5.5 Note when debugging in different workspaces” section.
		p. 72	Updated “Appendix. Known Issues” chapter. <ul style="list-style-type: none"> Resolved issues No. 2, No. 6, No. 8, No. 9, No. 10 and No. 11. Removed RZ/T2M and RZ/T2L as target device from No. 12 Added new issue No. 13, No. 14, and No. 15.
		p. 89	Updated “Appendix. Tool Software Limitations” chapter. <ul style="list-style-type: none"> Added new limitation No. 9 and No. 10.
		p. 105	Added “Appendix. How to Debug FSP multiprocessing projects with Flash Boot Mode” chapter.
1.10	May.30.24	All	Updated documentation for RZ/N2L FSP v2.0.0. <ul style="list-style-type: none"> Removed contents for RZ/N2L FSP v1.3.0
		p.9	Updated “2.3.1 SEGGER J-Link” section. <ul style="list-style-type: none"> List Target Device separately for each series in a table
		p.44	Removed “5.3.2.1 NOTE: Configure IAR EWARM Project [Only RZ/N2L]” section.

Rev.	Date	Description	
		Page	Summary
		p.44-46	Updated “5.3.3.1 NOTE: Build settings [Only Multiprocessing]” section. <ul style="list-style-type: none"> • Changed the program execution start position setting. • Corrected reset setting. Added images for the settings screen.
		P.73	Updated “Appendix. Known Issues” chapter. <ul style="list-style-type: none"> • Resolved issue No. 12 • Added RZ/N2L as target device from No.13 and No.14 • Added new issues No. 16 and No. 17.
		p.84	Updated “Appendix. Tool Software Limitations” chapter. <ul style="list-style-type: none"> • Added RZ/N2L as target device from No. 10.
		p.97	Updated “Appendix. How to Change Boot Mode of FSP Project” chapter. <ul style="list-style-type: none"> • Added new step 4
		p.99	Updated “Appendix. How to Debug FSP multiprocessing projects with Flash Boot Mode” section. <ul style="list-style-type: none"> • Changed the program execution start position setting. • Modified explanation of debugging sequence.
1.11	Jun.28.24	All	Updated documentation for RZ/T2 FSP v2.1.0. <ul style="list-style-type: none"> • Removed contents for RZ/T2 FSP v2.0.0
		All	Added the RZ/T2ME device as target device.
		p.1	Added video links of FSP Configuration.
		p.6	Updated “1.3.2 FSP Documentation” section. <ul style="list-style-type: none"> • Added explanation of notes when using FSP software modules.
		p.10	Updated “2.4.1.1 Boot Mode” section. <ul style="list-style-type: none"> • Added note for board setting.
		p.13	Updated “2.4.2.1 Boot Mode” section. <ul style="list-style-type: none"> • Added note for board setting.
		p.15	Added “2.4.3 RSK+RZT2ME” section.
		p.16	Updated “2.5.1.1 Boot Mode” section. <ul style="list-style-type: none"> • Added note for board setting.
		p.38	Updated “5.3.2 Create a New Project” section. <ul style="list-style-type: none"> • Added IDE Project Type setting for newer versions of FSP SC.
		p.43	Updated “5.3.3.1 NOTE: Build settings [Only Multiprocessing]” section. <ul style="list-style-type: none"> • Removed Build Actions setting. • Added Make before debugging setting.
		p.54	Updated “6 FSP Configuration Users Guide” section. <ul style="list-style-type: none"> • Updated figures with new tool screens.
		P.74	Updated “Appendix. Known Issues” chapter. <ul style="list-style-type: none"> • Resolved issues No. 16 and No. 17 • Added new issues No. 18 to No. 24.
		p.85	Updated “Appendix. Tool Software Limitations” chapter. <ul style="list-style-type: none"> • Removed RZ/T2M and RZ/T2L as target device from No. 6. • Added new issue No. 11.

Rev.	Date	Description	
		Page	Summary
		p.102	Updated “Appendix. How to Change Boot Mode of FSP Project” section. <ul style="list-style-type: none">• Added note on FSP version changes

General Precautions in the Handling of Microprocessing Unit and Microcontroller Unit Products

The following usage notes are applicable to all Microprocessing unit and Microcontroller unit products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

1. Precaution against Electrostatic Discharge (ESD)

A strong electrical field, when exposed to a CMOS device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop the generation of static electricity as much as possible, and quickly dissipate it when it occurs. Environmental control must be adequate. When it is dry, a humidifier should be used. This is recommended to avoid using insulators that can easily build up static electricity. Semiconductor devices must be stored and transported in an anti-static container, static shielding bag or conductive material. All test and measurement tools including work benches and floors must be grounded. The operator must also be grounded using a wrist strap. Semiconductor devices must not be touched with bare hands. Similar precautions must be taken for printed circuit boards with mounted semiconductor devices.

2. Processing at power-on

The state of the product is undefined at the time when power is supplied. The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the time when power is supplied. In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the time when power is supplied until the reset process is completed. In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the time when power is supplied until the power reaches the level at which resetting is specified.

3. Input of signal during power-off state

Do not input signals or an I/O pull-up power supply while the device is powered off. The current injection that results from input of such a signal or I/O pull-up power supply may cause malfunction and the abnormal current that passes in the device at this time may cause degradation of internal elements. Follow the guideline for input signal during power-off state as described in your product documentation.

4. Handling of unused pins

Handle unused pins in accordance with the directions given under handling of unused pins in the manual. The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of the LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible.

5. Clock signals

After applying a reset, only release the reset line after the operating clock signal becomes stable. When switching the clock signal during program execution, wait until the target clock signal is stabilized. When the clock signal is generated with an external resonator or from an external oscillator during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Additionally, when switching to a clock signal produced with an external resonator or by an external oscillator while program execution is in progress, wait until the target clock signal is stable.

6. Voltage application waveform at input pin

Waveform distortion due to input noise or a reflected wave may cause malfunction. If the input of the CMOS device stays in the area between V_{IL} (Max.) and V_{IH} (Min.) due to noise, for example, the device may malfunction. Take care to prevent chattering noise from entering the device when the input level is fixed, and also in the transition period when the input level passes through the area between V_{IL} (Max.) and V_{IH} (Min.).

7. Prohibition of access to reserved addresses

Access to reserved addresses is prohibited. The reserved addresses are provided for possible future expansion of functions. Do not access these addresses as the correct operation of the LSI is not guaranteed.

8. Differences between products

Before changing from one product to another, for example to a product with a different part number, confirm that the change will not lead to problems. The characteristics of a microprocessing unit or microcontroller unit products in the same group but having a different part number might differ in terms of internal memory capacity, layout pattern, and other factors, which can affect the ranges of electrical characteristics, such as characteristic values, operating margins, immunity to noise, and amount of radiated noise. When changing to a product with a different part number, implement a system-evaluation test for the given product.

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